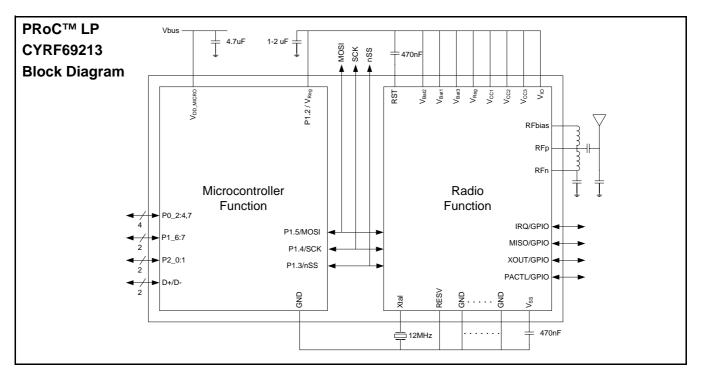


PRoC[™] LP Features

- Single Device, Two Functions
 - 8-bit, Flash based USB peripheral MCU function and 2.4 GHz radio transceiver function in a single device
- Flash-based Microcontroller Function
 - M8C based 8-bit CPU, optimized for Human Interface Devices (HID) applications
 - 256 Bytes of SRAM
- 8 Kbytes of Flash memory with EEPROM emulation
- In-System reprogrammable through D+/D- pins.
- 16-bit free running timer
- Low power wake up timer
- 12-bit Programmable Interval Timer with interrupts
- Watchdog timer
- Industry-Leading 2.4 GHz Radio Transceiver Function
 - Operates in the unlicensed worldwide Industrial, Scientific and Medical (ISM) band (2.4 GHz–2.483 GHz)
 - DSSS data rates of up to 250 Kbps
 - GFSK data rate of 1 Mbps
 - –97 dBm receive sensitivity
 - Programmable output power of up to +4 dBm
 - Auto Transaction Sequencer (ATS)
- Framing CRC and Auto ACK

Programmable Radio on Chip Low Power

- Received Signal Strength Indication (RSSI)
- Automatic Gain Control (AGC)
- Component Reduction
 - Integrated 3.3V regulator
 - Integrated pull up on D-
- GPIOs that require no external components
- Operates off a single crystal
- Flexible I/O
 - High current drive on GPIO pins. Configurable 8-mA or 50-mA/pin current sink on designated pins
 - Each GPIO pin supports high-impedance inputs, configurable pull up, open-drain output, CMOS/TTL inputs and CMOS output
- Maskable intrrupts on all I/O pins
- USB Specification Compliance
 - Conforms to USB Specification Version 2.0
 - Conforms to USB HID Specification Version 1.1
 - Supports one Low Speed USB device address
 - Supports one control endpoint and two data end points
 - Integrated USB Transceiver
- Operating voltage from 4.0V to 5.5V DC
- Operating temperature from 0 to 70°C
- Lead-free 40-lead QFN package
- Advanced development tools based on Cypress's $\mathsf{PSoC}^{\textcircled{R}}$ Tools



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San Jose, CA 95134-1709 • 408-943-2600 Revised February 20, 2007



Applications

The CYRF69213 PRoC LP Low Speed is targeted for the following applications:

- USB Bridge for Human Interface Devices (HID)
 - Wireless mice
 - Wireless keyboards
 - Remote controls
 - Gaming applications
- USB Bridge for General Purpose Applications
- Consumer electronics
- Industrial applications
- White goods
- Home automation
- Personal health

Functional Description

PRoC LP devices are integrated radio and microcontroller functions in the same package to provide a dual-role single-chip solution.

Communication between the microcontroller and the radio is via the SPI interface between both functions.

Functional Overview

The CYRF69213 is a complete Radio System-on-Chip device, providing a complete RF system solution with a single device and a few discrete components. The CYRF69213 is designed to implement low-cost wireless systems operating in the worldwide 2.4-GHz Industrial, Scientific, and Medical (ISM) frequency band (2.400 GHz–2.4835 GHz).

2.4 GHz Radio Function

The radio meets the following world-wide regulatory requirements:

- Europe
 - ETSI EN 301 489-1 V1.4.1
 - ETSI EN 300 328-1 V1.3.1
- North America
 - FCC CFR 47 Part 15
- Japan
 - ARIB STD-T66

Data Transmission Modes

The radio supports four different data transmission modes:

- In GFSK mode, data is transmitted at 1 Mbps without any DSSS
- In 8DR mode, 1 byte is encoded in each PN code symbol transmitted
- In DDR mode, 2 bits are encoded in each PN code symbol transmitted
- In SDR mode, a single bit is encoded in each PN code symbol transmitted

Both 64-chip and 32-chip data PN codes are supported. The four data transmission modes apply to the data after the Start of Packet (SOP). In particular, the packet length, data and CRC are all sent in the same mode.

USB Microcontroller Function

The microcontroller function is based on the powerful CYRF69213 microcontroller. It is an 8-bit Flash programmable microcontroller with integrated low speed USB interface.

The microcontroller has up to 14 GPIO pins to support USB, PS/2 and other applications. Each GPIO port supports high-impedance inputs, configurable pull up, open drain output, CMOS/TTL inputs and CMOS output. Up to two pins support programmable drive strength of up to 50 mA. Additionally each I/O pin can be used to generate a GPIO interrupt to the microcontroller. Each GPIO port has its own GPIO interrupt vector with the exception of GPIO Port 0.

The microcontroller features an internal oscillator. With the presence of USB traffic, the internal oscillator can be set to precisely tune to USB timing requirements (24 MHz \pm 1.5%).

The PRoC LP has up to 8 Kbytes of Flash for user's firmware code and up to 256 bytes of RAM for stack space and user variables.

The PRoC LP includes a Watchdog timer, a vectored interrupt controller, a 12-bit programmable interval timer with configurable 1-ms interrupt and a 16-bit free running timer with capture registers.





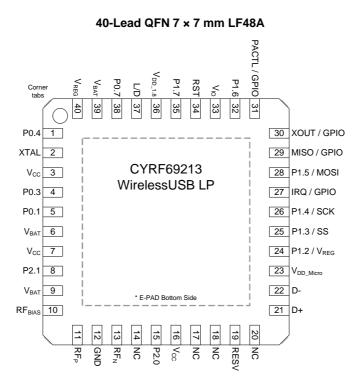
Pinout

Pin	Name	Function					
1	P0.4	Individually configured GPIO					
2	Xtal_in	12 MHz Crystal. External Clock in					
3, 7, 16	V _{CC}	Connected to pin 24 via 0.047-µF Capacitor.					
4	P0.3	Individually configured GPIO					
5	P0.1	Individually configured GPIO					
6, 9, 39	V _{bat}	Connected to pin 24 via 0.047-µFshunt capacitor					
8	P2.1	GPIO. Port 2 Bit 1					
10	RF Bias	RF pin voltage reference					
11	RF _p	Differential RF input to/from antenna					
12	GND	Ground					
13	RF _n	Differential RF to/from antenna					
14, 17, 18, 20, 36	NC						
15	P2.0	GPIO. Port 2 Bit 0					
19	RESV	Reserved. Must connect to GND					
21	D+	Low-speed USB IO					
22	D-	Low-speed USB IO					
23	V _{DD_micro}	4.0-5.5 for 12 MHz CPU/4.75-5.5 for 24 MHz CPU					
24	P1.2 / V _{REG}	Must be configured as 3.3V output. It must have a 1–2 μ F output capacitor					
25	P1.3 / nSS	Slave select SPI Pin					
26	P1.4 / SCK	Serial Clock Pin from MCU function to radio function					
27	IRQ	Interrupt output, configure high/low or GPIO					
28	P1.5 / MOSI	Master Out Slave In.					
29	MISO	Master In Slave Out, from radio function.Can be configured as GPIO					
30	XOUT	Bufferd CLK, PACTL_n or GPIO					
31	PACTL	Control for external PA or GPIO					
32	P1.6	GPIO. Port 1 Bit 6					
33	V _{IO}	I/O interface voltage. Connected to pin 24 via 0.047 μ F					
34	Reset	Radio Reset. Connected to V_{DD} via 0.47 μ F Capacitor or to microcontroller GPIO pin. Must have a RESET = HIGH event the very first time power is applied to the radio otherwise the state of the radio function control registers is unknown.					
35	P1.7	GPIO. Port 1 Bit 7					
36	V _{DD_1.8}	Regulated logic bypass. Connected via 0.47 µF to GND					
37	L/D	Connected to GND					
38	P0.7	GPIO. Port 0 Bit 7					
40	V _{reg}	Connected to pin 24					
41	E-pad	Connected to GND					



Pinout Diagram

Figure 1. Pinout



PRoC LP Functional Overview

The SoC is designed to implement wireless device links operating in the worldwide 2.4-GHz ISM frequency band. It is intended for systems compliant with world-wide regulations covered by ETSI EN 301 489-1 V1.41, ETSI EN 300 328-1 V1.3.1 (Europe), FCC CFR 47 Part 15 (USA and Industry Canada) and TELEC ARIB_T66_March, 2003 (Japan).

The SoC contains a 2.4-GHz 1-Mbps GFSK radio transceiver, packet data buffering, packet framer, DSSS baseband controller, Received Signal Strength Indication (RSSI), and SPI interface for data transfer and device configuration.

The radio supports 98 discrete 1-MHz channels (regulations may limit the use of some of these channels in certain jurisdictions). In DSSS modes the baseband performs DSSS spreading/despreading, while in GFSK Mode (1 Mb/s - GFSK) the baseband performs Start of Frame (SOF), End of Frame (EOF) detection and CRC16 generation and checking. The baseband may also be configured to automatically transmit Acknowledge (ACK) handshake packets whenever a valid packet is received.

When in receive mode, with packet framing enabled, the device is always ready to receive data transmitted at any of the supported bit rates, except SDR, enabling the implementation of mixed-rate systems in which different devices use different data rates. This also enables the implementation of dynamic data rate systems, which use high data rates at shorter distances and/or in a low-moderate interference environment,

and change to lower data rates at longer distances and/or in high interference environments.

The MCU function is an 8-bit Flash-programmable microcontroller with integrated low-speed USB interface. The instruction set has been optimized specifically for USB operations, although it can be used for a variety of other embedded applications.

The MCU function has up to eight Kbytes of Flash for user's code and up to 256 bytes of RAM for stack space and user variables.

In addition, the MCU function includes a Watchdog timer, a vectored interrupt controller, a 16-bit Free-Running Timer, and 12-bit Programmable Interrupt Timer.

The MCU function supports in-system programming by using the D+ and D– pins as the serial programming mode interface. The programming protocol is not USB.

Backward Compatibility

The CYRF69213 IC is fully interoperable with the main modes of other Cypress radios CYWUSB6934 and CYRF6936. The 62.5-kbps mode is supported by selecting 32-chip DATA_CODE_ADR codes, DDR mode, and disabling the SOP, length, and CRC16 fields. Similarly, the 15.675-kHz mode is supported by selecting 64-chip DATA_CODE_ADR codes and SDR mode.

In this way, a suitably configured CYRF69213 IC device may transmit data to and/or receive data from a first generation device.



Functional Block Overview

All the blocks that make up the PRoC LP are presented here.

2.4-GHz Radio

The radio transceiver is a dual conversion low IF architecture optimized for power and range/robustness. The radio employs channel-matched filters to achieve high performance in the presence of interference. An integrated Power Amplifier (PA) provides up to +4 dBm transmit power, with an output power control range of 34 dB in 7 steps. The supply current of the device is reduced as the RF output power is reduced.

Table 1. Internal PA Output Power Step Table

Typical Output Power (dBm)
+4
0
-5
-10
-15
-20
-25
-30

Frequency Synthesizer

Before transmission or reception may commence, it is necessary for the frequency synthesizer to settle. The settling time varies depending on channel; 25 fast channels are provided with a maximum settling time of $100 \ \mu s$.

The 'fast channels' (<100- μ s settling time) are every third frequency, starting at 2400 MHz up to and including 2472 MHz (for example, 0,3,6,9......69 & 72).

Baseband and Framer

The baseband and framer blocks provide the DSSS encoding and decoding, SOP generation and reception and CRC16 generation and checking, as well as EOP detection and length field.

Data Rates and Data Transmission Modes

The SoC supports four different data transmission modes:

- In GFSK mode, data is transmitted at 1 Mbps, without any DSSS.
- In 8DR mode, 8 bits are encoded in each DATA_CODE_ADR derived code symbol transmitted.
- In DDR mode, 2-bits are encoded in each DATA_CODE_ADR derived code symbol transmitted. (As in the CYWUSB6934 DDR mode).
- In SDR mode, 1 bit is encoded in each DATA_CODE_ADR derived code symbol transmitted. (As in the CYWUSB6934 standard modes.)

Both 64-chip and 32-chip DATA_CODE_ADR codes are supported. The four data transmission modes apply to the data after the SOP. In particular the length, data, and CRC16 are all

sent in the same mode. In general, lower data rates reduces packet error rate in any given environment.

By combining the DATA_CODE_ADR code lengths and data transmission modes described above, the CYRF69213 IC supports the following data rates:

- 1000-kbps (GFSK)
- 250-kbps (32-chip 8DR)
- 125-kbps (64-chip 8DR)
- 62.5-kbps (32-chip DDR)
- 31.25-kbps (64-chip DDR)
- 15.625-kbps (64-chip SDR)

Lower data rates typically provide longer range and/or a more robust link.

Link Layer Modes

The CYRF69213 IC device supports the following data packet framing features:

SOP – Packets begin with a 2-symbol Start of Packet (SOP) marker. This is required in GFSK and 8DR modes, but is optional in DDR mode and is not supported in SDR mode; if framing is disabled then an SOP event is inferred whenever two successive correlations are detected. The SOP_CODE_ADR code used for the SOP is different from that used for the 'body' of the packet, and if desired may be a different length. SOP must be configured to be the same length on both sides of the link.

EOP – There are two options for detecting the end of a packet. If SOP is enabled, then a packet length field may be enabled. GFSK and 8DR must enable the length field. This is the first 8 bits after the SOP symbol, and is transmitted at the payload data rate. If the length field is enabled, an End of Packet (EOP) condition is inferred after reception of the number of bytes defined in the length field, plus two bytes for the CRC16 (if enabled—see below). The alternative to using the length field is to infer an EOP condition from a configurable number of successive non-correlations; this option is not available in GFSK mode and is only recommended when using SDR mode.

CRC16 – The device may be configured to append a 16-bit CRC16 to each packet. The CRC16 uses the USB CRC polynomial with the added programmability of the seed. If enabled, the receiver will verify the calculated CRC16 for the payload data against the received value in the CRC16 field. The starting value for the CRC16 calculation is configurable, and the CRC16 transmitted may be calculated using either the loaded seed value or a zero seed; the received data CRC16 will be checked against both the configured and zero CRC16 seeds.

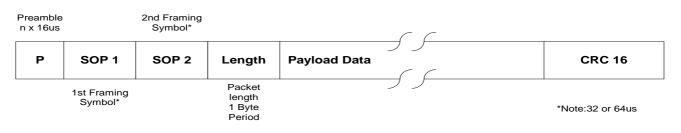
CRC16 detects the following errors:

- Any one bit in error
- Any two bits in error (no matter how far apart, which column, and so on)
- Any odd number of bits in error (no matter where they are)
- · An error burst as wide as the checksum itself

Figure 2 shows an example packet with SOP, CRC16 and lengths fields enabled.



Figure 2. Example Default Packet Format



Packet Buffers

Packet data and configuration registers are accessed through the SPI interface. All configuration registers are directly addressed through the address field in the SPI packet. Configuration registers are provided to allow configuration of DSSS PN codes, data rate, operating mode, interrupt masks, interrupt status, and others.

Packet Buffers

All data transmission and reception uses the 16-byte packet buffers—one for transmission and one for reception.

The transmit buffer allows a complete packet of up to 16 bytes of payload data to be loaded in one burst SPI transaction, and then transmitted with no further MCU intervention. Similarly, the receive buffer allows an entire packet of payload data up to 16 bytes to be received with no firmware intervention required until packet reception is complete.

The CYRF69213 IC supports packet length of up to 40 bytes; interrupts are provided to allow an MCU to use the transmit and receive buffers as FIFOs. When transmitting a packet longer than 16 bytes, the MCU can load 16 bytes initially, and add further bytes to the transmit buffer as transmission of data creates space in the buffer. Similarly, when receiving packets longer than 16 bytes, the MCU function must fetch received data from the FIFO periodically during packet reception to prevent it from overflowing.

Auto Transaction Sequencer (ATS)

The CYRF69213 IC provides automated support for transmission and reception of acknowledged data packets.

When transmitting a data packet, the device automatically starts the crystal and synthesizer, enters transmit mode, transmits the packet in the transmit buffer, and then automatically switches to receive mode and waits for a handshake packet—and then automatically reverts to sleep mode or idle mode when either an ACK packet is received, or a timeout period expires.

Similarly, when receiving in transaction mode, the device waits in receive mode for a valid packet to be received, then automatically transitions to transmit mode, transmits an ACK packet, and then switches back to receive mode to await the next packet. The contents of the packet buffers are not affected by the transmission or reception of ACK packets.

In each case, the entire packet transaction takes place without any need for MCU firmware action; to transmit data the MCU simply needs to load the data packet to be transmitted, set the length, and set the TX GO bit. Similarly, when receiving packets in transaction mode, firmware simply needs to retrieve

Below are the requirements for the crystal to be directly

the fully received packet in response to an interrupt request indicating reception of a packet.

Interrupts

The radio function provides an interrupt (IRQ) output, which is configurable to indicate the occurrence of various different events. The IRQ pin may be programmed to be either active high or active low, and be either a CMOS or open drain output. The IRQ pin can be multiplexed on the SPI if routed to an external pin.

The radio function features three sets of interrupts: transmit, receive, and system interrupts. These interrupts all share a single pin (IRQ), but can be independently enabled/disabled. In transmit mode, all receive interrupts are automatically disabled, and in receive mode all transmit interrupts are automatically disabled. However, the contents of the enable registers are preserved when switching between transmit and receive modes.

If more than one radio interrupt is enabled at any time, it is necessary to read the relevant status register to determine which event caused the IRQ pin to assert. Even when a given interrupt source is disabled, the status of the condition that would otherwise cause an interrupt can be determined by reading the appropriate status register. It is therefore possible to use the devices without making use of the IRQ pin by polling the status register(s) to wait for an event, rather than using the IRQ pin.

The microcontroller function supports 23 maskable interrupts in the vectored interrupt controller. Interrupt sources include a USB bus reset, LVR/POR, a programmable interval timer, a 1.024-ms output from the Free Running Timer, three USB endpoints, two capture timers, five GPIO Ports, three GPIO pins, two SPI, a 16-bit free running timer wrap, an internal wake-up timer, and a bus active interrupt. The wake-up timer causes periodic interrupts when enabled. The USB endpoints interrupt after a USB transaction complete is on the bus. The capture timers interrupt whenever a new timer value is saved due to a selected GPIO edge event. A total of eight GPIO interrupts support both TTL or CMOS thresholds. For additional flexibility, on the edge sensitive GPIO pins, the interrupt polarity is programmable to be either rising or falling.

Clocks

The radio function has a 12-MHz crystal (30-ppm or better) directly connected between XTAL and GND without the need for external capacitors. A digital clock out function is provided, with selectable output frequencies of 0.75, 1.5, 3, 6, or 12 MHz. This output may be used to clock an external micro-controller (MCU) or ASIC. This output is enabled by default, but may be disabled.

connected to XTAL pin and GND:



- Nominal Frequency: 12 MHz
- Operating Mode: Fundamental Mode
- Resonance Mode: Parallel Resonant
- Frequency Initial Stability: ±30 ppm
- Series Resistance: <60 ohms
- Load Capacitance: 10 pF
- Drive Level: 10 μ W–100 μ W

The MCU function features an internal oscillator. With the presence of USB traffic, the internal oscillator can be set to precisely tune to USB timing requirements (24 MHz \pm 1.5%). The clock generator provides the 12-MHz and 24-MHz clocks that remain internal to the microcontroller.

GPIO Interface

The MCU function features up to 20 general-purpose I/O (GPIO) pins to support USB, PS/2, and other applications. The I/O pins are grouped into five ports (Port 0 to 4). The pins on Port 0 and Port 1 may each be configured individually while the pins on Ports 2, 3, and 4 may only be configured as a group. Each GPIO port supports high-impedance inputs, configurable pull up, open drain output, CMOS/TTL inputs, and CMOS output with up to five pins that support programmable drive strength of up to 50-mA sink current. GPIO Port 1 features four pins that interface at a voltage level of 3.3 volts. Additionally, each I/O pin can be used to generate a GPIO interrupt to the microcontroller. Each GPIO port 0. GPIO Port 0 has three dedicated pins that have independent interrupt vectors (P0.2–P0.4).

Power-On Reset/Low-Voltage Detect

The power-on reset circuit detects logic when power is applied to the device, resets the logic to a known state, and begins executing instructions at Flash address 0x0000. When power falls below a programmable trip voltage, it generates reset or may be configured to generate interrupt. There is a low-voltage detect circuit that detects when V_{CC} drops below a programmable trip voltage. It may be configurable to generate an LVD interrupt to inform the processor about the low-voltage event. POR and LVD share the same interrupt. There is not a separate interrupt for each. The Watchdog timer can be used to ensure the firmware never gets stalled in an infinite loop.

Power Management

The device draws its power supply from the USB V_{bus} line. The V_{bus} supplies power to the MCU function, which has an internal 3.3 V regulator. This 3.3 V is supplied to the radio function via P1.2/V_{REG} after proper filtering as shown in Figure 3.

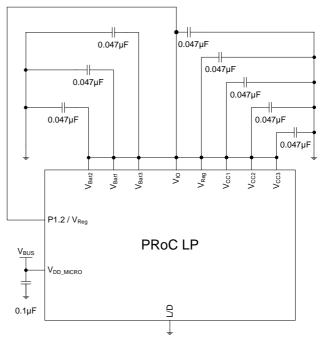


Figure 3. Power Management From Internal Regulator

Timers

The free-running 16-bit timer provides two interrupt sources: the programmable interval timer with $1-\mu s$ resolution and the 1.024-ms outputs. The timer can be used to measure the duration of an event under firmware control by reading the timer at the start and at the end of an event, then calculating the difference between the two values.

USB Interface

The MCU function includes an integrated USB serial interface engine (SIE) that allows the chip to easily interface to a USB host. The hardware supports one USB device address with three endpoints.

Low Noise Amplifier (LNA) and Received Signal Strength Indication (RSSI)

The gain of the receiver may be controlled directly by clearing the AGC EN bit and writing to the Low Noise Amplifier (LNA) bit of the RX_CFG_ADR register. When the LNA bit is cleared, the receiver gain is reduced by approximately 20 dB, allowing accurate reception of very strong received signals (for example when operating a receiver very close to the transmitter). An additional 20 dB of receiver attenuation can be added by setting the Attenuation (ATT) bit; this allows data reception to be limited to devices at very short ranges. Disabling AGC and enabling LNA is recommended unless receiving from a device using external PA.

The RSSI register returns the relative signal strength of the on-channel signal power.

When receiving, the device may be configured to automatically measure and store the relative strength of the signal being received as a 5-bit value. When enabled, an RSSI reading is taken and may be read through the SPI interface.



An RSSI reading is taken automatically when the start of a packet is detected. In addition, a new RSSI reading is taken every time the previous reading is read from the RSSI register, allowing the background RF energy level on any given channel to be easily measured when RSSI is read when no signal is being received. A new reading can occur as fast as once every 12 μ s.

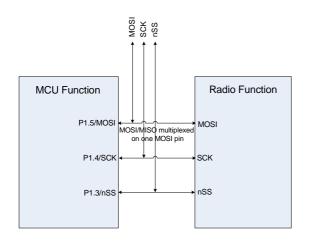
SPI Interface

The SPI interface between the MCU function and the radio function is a 3-wire SPI Interface. The three pins are MOSI (Master Out Slave In), SCK (Serial Clock), SS (Slave Select). There is an alternate 4-wire MISO Interface that requires the connection of two external pins. The SPI interface is controlled by configuring the SPI Configure Register (SICR Address: 0x3D).

3-Wire SPI Interface

The radio function receives a clock from the MCU function on the SCK pin. The MOSI pin is multiplexed with the MISO pin. Bidirectional data transfer takes place between the MCU function and the radio function through this multiplexed MOSI pin. When using this mode the user firmware should ensure that the MOSI pin on the MCU function is in a high impedance state, except when the MCU is actively transmitting data. Firmware must also control the direction of data flow and switch directions between MCU function and radio function by setting the SWAP bit [Bit 7] of the SPI Configure Register. The SS pin is asserted prior to initiating a data transfer between the MCU function and the radio function. The IRQ function may be optionally multiplexed with the MOSI pin; when this option is enabled the IRQ function is not available while the SS pin is low. When using this configuration, user firmware should ensure that the MOSI function on MCU function is in a high-impedance state whenever SS is high.



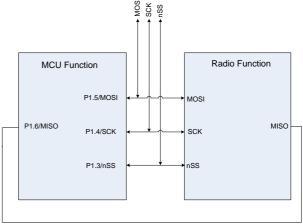


4-Wire SPI Interface

The 4-wire SPI communications interface consists of MOSI, MISO, SCK, and SS.

The device receives SCK from the MCU function on the SCK pin. Data from the MCU function is shifted in on the MOSI pin. Data to the MCU function is shifted out on the MISO pin. The active low SS pin must be asserted for the two functions to communicate. The IRQ function may be optionally multiplexed with the MOSI pin; when this option is enabled the IRQ function is not available while the SS pin is low. When using this configuration, user firmware should ensure that the MOSI function on MCU function is in a high-impedance state whenever SS is high.





This connection is external to the PRoC LP Chip

SPI Communication and Transactions

The SPI transactions can be single byte or multi-byte. The MCU function initiates a data transfer through a Command/Address byte. The following bytes are data bytes. The SPI transaction format is shown in Figure 6.

The DIR bit specifies the direction of data transfer. 0 = Master reads from slave. 1 = Master writes to slave.

The INC bit helps to read or write consecutive bytes from contiguous memory locations in a single burst mode operation.

If Slave Select is asserted and INC = 1, then the master MCU function reads a byte from the radio, the address is incremented by a byte location, and then the byte at that location is read, and so on.

If Slave Select is asserted and INC = 0, then the MCU function reads/writes the bytes in the same register in burst mode, but if it is a register file then it reads/writes the bytes in that register file.

The SPI interface between the radio function and the MCU is not dependent on the internal 12-MHz oscillator of the radio. Therefore, radio function registers can be read from or written into while the radio is in sleep mode.

SPI IO Voltage References

The SPI interfaces between MCU function and the radio and the IRQ and RST have a separate voltage reference V_{IO} , enabling the radio function to directly interface with the MCU



function, which operates at higher supply voltage. The internal SPIO pins between the MCU function and radio function should be connected with a regulated voltage of 3.3V (by setting [bit4] of Registers P13CR, P14CR, P15CR, and P16CR of the MCU function) and the internal 3.3V regulator of the MCU function should be turned on.

SPI Connects to External Devices

The three SPI wires, MOSI, SCK, and SS are also drawn out of the package as external pins to allow the user to interface their own external devices (such as optical sensors and others) through SPI. The radio function also has its own SPI wires MISO and IRQ, which can be used to send data back to the MCU function or send an interrupt request to the MCU function. They can also be configured as GPIO pins.

Figure 6. SPI Transaction Format

			Byte 1	Byte 1+N
Bit#	7	6	[5:0]	[7:0]
Bit Name	DIR	INC	Address	Data

CPU Architecture

This family of microcontrollers is based on a high-performance, 8-bit, Harvard-architecture microprocessor. Five registers control the primary operation of the CPU core. These registers are affected by various instructions, but are not directly accessible through the register space by the user.

Table 2. CPU Registers and Register Names

Register	Register Name
Flags	CPU_F
Program Counter	CPU_PC
Accumulator	CPU_A
Stack Pointer	CPU_SP
Index	CPU_X

The 16-bit Program Counter Register (CPU_PC) allows for direct addressing of the full eight Kbytes of program memory space.

The Flags Register can only be set or reset with logical instruction.

Table 3. CPU Flags Register (CPU_F) [R/W]

Bit #	7	6	5	4	3	2	1	0
Field		Reserved		XIO	Super	Carry	Zero	Global IE
Read/Write	-	-	-	R/W	R	RW	RW	RW
Default	0	0	0	0	0	0	1	0

The Accumulator Register (CPU_A) is the general-purpose register that holds the results of instructions that specify any of the source addressing modes.

The Index Register (CPU_X) holds an offset value that is used in the indexed addressing modes. Typically, this is used to address a block of data within the data memory space.

The Stack Pointer Register (CPU_SP) holds the address of the current top-of-stack in the data memory space. It is affected by the PUSH, POP, LCALL, CALL, RETI, and RET instructions, which manage the software stack. It can also be affected by the SWAP and ADD instructions.

The Flag Register (CPU_F) has three status bits: Zero Flag bit [1]; Carry Flag bit [2]; Supervisory State bit [3]. The Global Interrupt Enable bit [0] is used to globally enable or disable interrupts. The user cannot manipulate the Supervisory State status bit [3]. The flags are affected by arithmetic, logic, and shift operations. The manner in which each flag is changed is dependent upon the instruction being executed (for example, AND, OR, XOR). See Table 19.

CPU Registers

Flags Register



Table 3. CPU Flags Register (CPU_F) [R/W]

Bits 7:5	Reserved
Bit 4	XIO Set by the user to select between the register banks 0 = Bank 0 1 = Bank 1
Bit 3	Super Indicates whether the CPU is executing user code or Supervisor Code. (This code cannot be accessed directly by the user.) 0 = User Code 1 = Supervisor Code
Bit 2	Carry Set by CPU to indicate whether there has been a carry in the previous logical/arithmetic operation 0 = No Carry 1 = Carry
Bit 1	Zero Set by CPU to indicate whether there has been a zero result in the previous logical/arithmetic operation 0 = Not Equal to Zero 1 = Equal to Zero
Bit 0	Global IE Determines whether all interrupts are enabled or disabled 0 = Disabled 1 = Enabled
Note CPU_ clear the C	F register is only readable with explicit register address 0xF7. The OR F, expr and AND F, expr instructions must be used to set and PU_F bits

Accumulator Register

Table 4. CPU Accumulator Register (CPU_A)

Bit #	7	6	5	4	3	2	1	0	
Field	CPU Accumulator [7:0]								
Read/Write	-	-	-	-	_	-	-	-	
Default	0	0	0	0	0	0	0	0	
Bits 7:0 0 8-bit data value	CPU Accumulato holds the result		rithmetic instruc	tion that uses a	source address	ing mode			

Index Register

Table 5. CPU X Register (CPU_X)

Bit #	7	6	5	4	3	2	1	0	
Field	X [7:0]								
Read/Write	-	-	_	_	_	_	_	_	
Default	0	0	0	0	0	0	0	0	
Bits 7:0 > 8-bit data value	([7:0] holds an index	for any instructi	on that uses an	indexed address	sing mode				

Stack Pointer Register

Table 6. CPU Stack Pointer Register (CPU_SP)

Bit #	7	6	5	4	3	2	1	0	
Field		Stack Pointer [7:0]							
Read/Write	—	-	-	-	-	-	-	-	
Default	0	0	0	0	0	0	0	0	



Table 6. CPU Stack Pointer Register (CPU_SP)

Bits 7:0Stack Pointer [7:0]8-bit data value holds a pointer to the current top-of-stack

CPU Program Counter High Register

Table 7. CPU Program Counter High Register (CPU_PCH)

Bit #	7	6	5	4	3	2	1	0
Field	Program Counter [15:8]							
Read/Write	-	-	_	_	_	_	_	-
Default	0	0	0	0	0	0	0	0
Bits 7:0 F 8-bit data value	Program Counte holds the highe		ogram counter					

CPU Program Counter Low Register

Table 8. CPU Program Counter Low Register (CPU_PCL)

Bit #	7	6	5	4	3	2	1	0	
Field	Program Counter [7:0]								
Read/Write	-	-	-	-	-	-	-	-	
Default	0	0	0	0	0	0	0	0	
Bits 7:0 F 8-bit data value	Program Counte holds the lower		gram counter						

Addressing Modes

Examples of the different addressing modes are discussed in this section and example code is given.

Source Immediate

The result of an instruction using this addressing mode is placed in the A register, the F register, the SP register, or the X register, which is specified as part of the instruction opcode. Operand 1 is an immediate value that serves as a source for the instruction. Arithmetic instructions require two sources. Instructions using this addressing mode are two bytes in length.

Table 9. Source Immediate

	Оро	code	e Operand 1
Instruction			Immediate Value
Exam	ples		
ADD	A,	7	;In this case, the immediate value ;of 7 is added with the Accumulator, ;and the result is placed in the ;Accumulator.
MOV	Х,	8	;In this case, the immediate value ;of 8 is moved to the X register.
AND	F,	9	;In this case, the immediate value ;of 9 is logically ANDed with the F ;register and the result is placed ;in the F register.

Source Direct

The result of an instruction using this addressing mode is placed in either the A register or the X register, which is specified as part of the instruction opcode. Operand 1 is an address that points to a location in either the RAM memory space or the register space that is the source for the instruction. Arithmetic instructions require two sources; the second source is the A register or X register specified in the opcode. Instructions using this addressing mode are two bytes in length.

Table 10.Source Direct

Opcode		ode	Operand 1
Instruction			Source Address
Exam	ples		
ADD	A,	[7]	;In this case, the value in ;the RAM memory location at ;address 7 is added with the ;Accumulator, and the result ;is placed in the Accumulator.
MOV	Х,	REG[8]	;In this case, the value in ;the register space at address ;8 is moved to the X register.

Source Indexed

The result of an instruction using this addressing mode is placed in either the A register or the X register, which is



specified as part of the instruction opcode. Operand 1 is added to the X register forming an address that points to a location in either the RAM memory space or the register space that is the source for the instruction. Arithmetic instructions require two sources; the second source is the A register or X register specified in the opcode. Instructions using this addressing mode are two bytes in length.

Table 11.Source Indexed

Opcode	Operand 1
Instruction	Source Index

Examples

ADD	Α,	[X+7]	;In this case, the value in ;the memory location at ;address X + 7 is added with ;the Accumulator, and the ;result is placed in the ;Accumulator.
MOV	Х,	REG[X+8]	;In this case, the value in ;the register space at ;address X + 8 is moved to ;the X register.

Destination Direct

The result of an instruction using this addressing mode is placed within either the RAM memory space or the register space. Operand 1 is an address that points to the location of the result. The source for the instruction is either the A register or the X register, which is specified as part of the instruction opcode. Arithmetic instructions require two sources; the second source is the location specified by Operand 1. Instructions using this addressing mode are two bytes in length.

Table 12.Destination Direct

Opcode	Operand 1
Instruction	Destination Address

Examples

ADD	[7],	Α	;In this case, the value in ;the memory location at ;address 7 is added with the ;Accumulator, and the result ;is placed in the memory ;location at address 7. The ;Accumulator is unchanged.
MOV	REG[8],	A	;In this case, the Accumula- ;tor is moved to the regis- ;ter space location at ;address 8. The Accumulator ;is unchanged.

Destination Indexed

The result of an instruction using this addressing mode is placed within either the RAM memory space or the register space. Operand 1 is added to the X register forming the address that points to the location of the result. The source for

the instruction is the A register. Arithmetic instructions require two sources; the second source is the location specified by Operand 1 added with the X register. Instructions using this addressing mode are two bytes in length.

Table 13.Destination Indexed

Opcode	Operand 1
Instruction	Destination Index

Example

ADD [X+7

X+7],	A	;In this case, the value in the
		;memory location at address X+7
		; is added with the Accumulator,
		;and the result is placed in
		;the memory location at address
		;x+7. The Accumulator is
		;unchanged.

Destination Direct Source Immediate

The result of an instruction using this addressing mode is placed within either the RAM memory space or the register space. Operand 1 is the address of the result. The source for the instruction is Operand 2, which is an immediate value. Arithmetic instructions require two sources; the second source is the location specified by Operand 1. Instructions using this addressing mode are three bytes in length.

Table 14.Destination Direct Immediate

0	pcode		Operand 1	Operand 2	
Instruction		Destination Address		Immediate Value	
Examples					
ADD	[7],	5	;ory location a ;added to the i ;5, and the res	value in the mem- at address 7 is mmediate value of sult is placed in ation at address 7.	
MOV	REG[8],	6	<pre>;In this case, ;value of 6 is ;register space ;address 8.</pre>	moved into the	

Destination Indexed Source Immediate

The result of an instruction using this addressing mode is placed within either the RAM memory space or the register space. Operand 1 is added to the X register to form the address of the result. The source for the instruction is Operand 2, which is an immediate value. Arithmetic instructions require two sources; the second source is the location specified by Operand 1 added with the X register. Instructions using this addressing mode are three bytes in length.

Table 15.Destination Indexed Immediate

Opcode	Operand 1	Operand 2
Instruction	Destination Index	Immediate Value



Examples

ADD	[X+7],	5	<pre>;In this case, the value in ;the memory location at ;address X+7 is added with ;the immediate value of 5, ;and the result is placed ;in the memory location at ;address X+7.</pre>
MOV	REG[X+8],	6	;In this case, the immedi- ;ate value of 6 is moved ;into the location in the ;register space at ;address X+8.

Destination Direct Source Direct

The result of an instruction using this addressing mode is placed within the RAM memory. Operand 1 is the address of the result. Operand 2 is an address that points to a location in the RAM memory that is the source for the instruction. This addressing mode is only valid on the MOV instruction. The instruction using this addressing mode is three bytes in length.

Table 16.Destination Direct Source Direct

Opcode	Operand 1	Operand 2
Instruction	Destination Address	Source Address

Example

MOV [7], [8] ;In this case, the value in the ;memory location at address 8 is ;moved to the memory location at ;address 7.

Source Indirect Post Increment

The result of an instruction using this addressing mode is placed in the Accumulator. Operand 1 is an address pointing to a location within the memory space, which contains an address (the indirect address) for the source of the instruction. The indirect address is incremented as part of the instruction execution. This addressing mode is only valid on the MVI instruction. The instruction using this addressing mode is two bytes in length. Refer to the *PSoC Designer: Assembly Language User Guide* for further details on MVI instruction.

Table 17.Source Indirect Post Increment

Opcode		de	Operand 1
Instruction			Source Address Address
Exam	ple		
MVI	A,	[8]	;In this case, the value in the ;memory location at address 8 is

;memory location at address 8 is ;an indirect address. The memory ;location pointed to by the indi-;rect address is moved into the ;Accumulator. The indirect ;address is then incremented.

Destination Indirect Post Increment

The result of an instruction using this addressing mode is placed within the memory space. Operand 1 is an address pointing to a location within the memory space, which contains an address (the indirect address) for the destination of the instruction. The indirect address is incremented as part of the instruction execution. The source for the instruction is the Accumulator. This addressing mode is only valid on the MVI instruction. The instruction using this addressing mode is two bytes in length.

Table 18.Destination Indirect Post Increment

Opcode			Operand 1
Instruction			Destination Address Address
Examp	le		
MVI	[8],	A	;In this case, the value in ;the memory location at ;address 8 is an indirect ;address. The Accumulator is ;moved into the memory loca- ;tion pointed to by the indi- ;rect address. The indirect ;address is then incremented.



Instruction Set Summary

The instruction set is summarized in Table 19 numerically and serves as a quick reference. If more information is needed, the

Instruction Set Summary tables are described in detail in the PSoC Designer Assembly Language User Guide (available on the www.cypress.com web site).

Table 19.Instruction Set Summar	v Sorted Numerically	/ b	v Opcode Order ^[1, 2]

Opcode Hex	Cycles	Bytes	Instruction Format	Flags	Opcode Hex	Cycles	Bytes	Instruction Format	Flags	Opcode Hex	Cycles	Bytes	Instruction Format	Flags
00	15	1	SSC		2D	8	2	OR [X+expr], A	Z	5A	5	2	MOV [expr], X	
01	4	2	ADD A, expr	C, Z	2E	9	3	OR [expr], expr	Z	5B	4	1	MOV A, X	Z
02	6		ADD A, [expr]	C, Z	2F	10	3	OR [X+expr], expr	Z	5C	4	1	MOV X, A	
03	7		ADD A, [X+expr]	C, Z	30	9		HALT		5D	6		MOV A, reg[expr]	Z
04	7		ADD [expr], A	C, Z	31	4		XOR A, expr	Z	5E	7		MOV A, reg[X+expr]	Z
05	8		ADD [X+expr], A	C, Z	32	6		XOR A, [expr]	Z	5F	10		MOV [expr], [expr]	
06	9		ADD [expr], expr	C, Z	33	7		XOR A, [X+expr]	Z	60	5		MOV reg[expr], A	
07	10		ADD [X+expr], expr	C, Z	34	7		XOR [expr], A	Z	61	6		MOV reg[X+expr], A	
08	4		PUSH A		35	8		XOR [X+expr], A	Z	62	8		MOV reg[expr], expr	
09	4		ADC A, expr	C, Z	36	9		XOR [expr], expr	Z	63	9		MOV reg[X+expr], expr	
0A	6		ADC A, [expr]	C, Z	37	10		XOR [X+expr], expr	Z	64	4		ASL A	C, Z
0B	7		ADC A, [X+expr]	C, Z	38	5		ADD SP, expr		65	7		ASL [expr]	C, Z
0C	7		ADC [expr], A	C, Z	39	5		CMP A, expr		66	8		ASL [X+expr]	C, Z
0D	8		ADC [X+expr], A	C, Z	ЗA	7		CMP A, [expr]	if (A=B) Z=1	67	4		ASR A	C, Z
0E	9		ADC [expr], expr	C, Z	3B	8		CMP A, [X+expr]	if (A <b) c="1</td"><td>68</td><td>7</td><td></td><td>ASR [expr]</td><td>C, Z</td></b)>	68	7		ASR [expr]	C, Z
0F	10		ADC [X+expr], expr	C, Z	3C	8		CMP [expr], expr		69	8		ASR [X+expr]	C, Z
10	4		PUSH X		3D	9		CMP [X+expr], expr		6A	4		RLC A	C, Z
11	4		SUB A, expr	C, Z	3E	10		MVI A, [[expr]++]	Z	6B	7		RLC [expr]	C, Z
12	6		SUB A, [expr]	C, Z	3F	10		MVI [[expr]++], A		6C	8		RLC [X+expr]	C, Z
13	7		SUB A, [X+expr]	C, Z	40	4		NOP	_	6D	4		RRC A	C, Z
14	7		SUB [expr], A	C, Z	41	9		AND reg[expr], expr	Z	6E	7		RRC [expr]	C, Z
15	8		SUB [X+expr], A	C, Z	42	10		AND reg[X+expr], expr	Z	6F	8		RRC [X+expr]	C, Z
16	9		SUB [expr], expr	C, Z	43	9		OR reg[expr], expr	Z	70	4		AND F, expr	C, Z
17	10		SUB [X+expr], expr	C, Z	44	10		OR reg[X+expr], expr	Z	71	4		OR F, expr	C, Z
18	5		POP A	Z	45	9		XOR reg[expr], expr	Z	72	4		XOR F, expr	C, Z
19	4		SBB A, expr	C, Z	46	10		XOR reg[X+expr], expr	Z	73	4	1	CPL A	Z
1A	6		SBB A, [expr]	C, Z	47	8		TST [expr], expr	Z	74	4	1	INC A	C, Z
1B	7		SBB A, [X+expr]	C, Z	48	9		TST [X+expr], expr	Z	75	4		INC X	C, Z
1C	7		SBB [expr], A	C, Z	49	9		TST reg[expr], expr	Z	76	7		INC [expr]	C, Z
1D	8		SBB [X+expr], A	C, Z	4A	10		TST reg[X+expr], expr	Z	77	8		INC [X+expr]	C, Z
1E	9		SBB [expr], expr	C, Z	4B	5		SWAP A, X	Z	78 79	4		DEC A	C, Z
1F	10		SBB [X+expr], expr POP X	C, Z	4C 4D	7		SWAP A, [expr] SWAP X, [expr]	Z	79 7A	4		DEC X DEC [expr]	C, Z C, Z
20	5			7		7			Z		7			
21	4		AND A, expr	Z	4E	5		SWAP A, SP	۷.	7B	8		DEC [X+expr]	C, Z
22	6		AND A, [expr]	Z	4F	4		MOV X, SP	7	7C	13			
23	7		AND A, [X+expr]	Z Z	50 51	4 5		MOV A, expr	Z Z	7D 7E	7 10		LJMP RETI	C, Z
24 25	7 8		AND [expr], A AND [X+expr], A	Z	51 52			MOV A, [expr] MOV A, [X+expr]	Z	7E 7F	10 8		RET	υ, Ζ
25 26			AND [X+expr], A AND [expr], expr	Z	52 53	б 5		MOV A, [X+expr] MOV [expr], A	۷		8 5		JMP	
	9				53 54			MOV [expr], A MOV [X+expr], A		8x				
27	10		AND [X+expr], expr ROMX	Z	54 55					9x	11 5		CALL JZ	
28			OR A, expr	Z	55 56	8		MOV [expr], expr		Ax			JZ JNZ	
29	4		OR A, expr OR A, [expr]	Z	56 57	9 4		MOV [X+expr], expr		Bx	5		JNZ JC	
2A	6		OR A, [expr] OR A, [X+expr]	Z				MOV X, expr		Cx	5		JNC	
2B 2C	7			Z	58 59	6		MOV X, [expr]		Dx	5		JACC	
20	7	2	OR [expr], A	Z	59	7	2	MOV X, [X+expr]		Ex	7		INDEX	

Notes

Interrupt routines take 13 cycles before execution resumes at interrupt vector table.
 The number of cycles required by an instruction is increased by one for instructions that span 256-byte boundaries in the Flash memory space.



Memory Organization

Flash Program Memory Organization

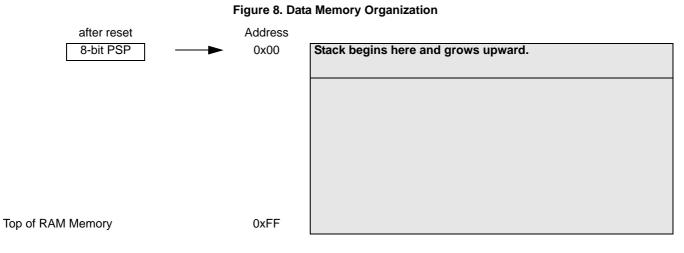
Figure 7. Program Memory Space with Interrupt Vector Table

after reset	Address	
16-bit PC	0x0000	Program execution begins here after a reset
	0x0004	POR/LVD
	0x0008	INTO
	0x000C	SPI Transmitter Empty
	0x0010	SPI Receiver Full
	0x0014	GPIO Port 0
	0x0018	GPIO Port 1
	0x001C	INT1
	0x0020	EP0
	0x0024	EP1
	0x0028	EP2
	0x002C	USB Reset
	0x0030	USB Active
	0x0034	1-ms Interval Timer
	0x0038	Programmable Interval Timer
	0x003C	Reserved
	0x0040	Reserved
	0x0044	16-bit Free Running Timer Wrap
	0x0048	INT2
	0x004C	Reserved
	0x0050	GPIO Port 2
	0x0054	Reserved
	0x0058	Reserved
	0x005C	Reserved
	0x0060	Reserved
	0x0064	Sleep Timer
	0x0068	Program Memory begins here (if below interrupts not used, program memory can start lower)
	0x1FFF	8 KB ends here



Data Memory Organization

The MCU function has 256 bytes of data RAM



Flash

This section describes the Flash block of the CYRF69213. Much of the user-visible Flash functionality, including programming and security, are implemented in the M8C Supervisory Read Only Memory (SROM). CYRF69213 Flash has an endurance of 1000 cycles and 10-year data retention.

Flash Programming and Security

All Flash programming is performed by code in the SROM. The registers that control the Flash programming are only visible to the M8C CPU when it is executing out of SROM. This makes it impossible to read, write, or erase the Flash by bypassing the security mechanisms implemented in the SROM.

Customer firmware can only program the Flash via SROM calls. The data or code images can be sourced by way of any interface with the appropriate support firmware. This type of programming requires a 'boot-loader'—a piece of firmware resident on the Flash. For safety reasons this boot-loader should not be overwritten during firmware rewrites.

The Flash provides four auxiliary rows that are used to hold Flash block protection flags, boot time calibration values, configuration tables, and any device values. The routines for accessing these auxiliary rows are documented in the SROM section. The auxiliary rows are not affected by the device erase function.

In-System Programming

Most designs that include an CYRF69213 part will have a USB connector attached to the USB D+/D- pins on the device. These designs require the ability to program or reprogram a part through these two pins alone.

CYRF69213 device enables this type of in-system programming by using the D+ and D- pins as the serial programming mode interface. This allows an external controller to cause the CYRF69213 part to enter serial programming mode and then to use the test queue to issue Flash access functions in the SROM. The programming protocol is not USB.

SROM

The SROM holds code that is used to boot the part, calibrate circuitry, and perform Flash operations. (Table 20 lists the SROM functions.) The functions of the SROM may be accessed in normal user code or operating from Flash. The SROM exists in a separate memory space from user code. The SROM functions are accessed by executing the Supervisory System Call instruction (SSC), which has an opcode of 00h. Prior to executing the SSC, the M8C's accumulator needs to be loaded with the desired SROM function code from Table 20. Undefined functions will cause a HALT if called from user code. The SROM functions are executing code with calls; therefore, the functions require stack space. With the exception of Reset, all of the SROM functions have a parameter block in SRAM that must be configured before executing the SSC. Table 21 lists all possible parameter block variables. The meaning of each parameter, with regards to a specific SROM function, is described later in this section.

Table 20.SROM Function Codes

Function Code	Function Name	Stack Space
00h	SWBootReset	0
01h	ReadBlock	7
02h	WriteBlock	10
03h	EraseBlock	9
05h	EraseAll	11
06h	TableRead	3
07h	CheckSum	3

Two important variables that are used for all functions are KEY1 and KEY2. These variables are used to help discriminate between valid SSCs and inadvertent SSCs. KEY1 must always have a value of 3Ah, while KEY2 must have the same value as the stack pointer when the SROM function begins execution. This would be the Stack Pointer value when the SSC opcode is executed, plus three. If either of the keys do



not match the expected values, the M8C will halt (with the exception of the SWBootReset function). The following code puts the correct value in KEY1 and KEY2. The code starts with a halt, to force the program to jump directly into the setup code and not run into it.

```
halt
SSCOP: mov [KEY1], 3ah
mov X, SP
mov A, X
add A, 3
mov [KEY2], A
```

Table 21.SROM Function Parameters

Variable Name	SRAM Address
Key1/Counter/Return Code	0,F8h
Key2/TMP	0,F9h
BlockID	0,FAh
Pointer	0,FBh
Clock	0,FCh
Mode	0,FDh
Delay	0,FEh
PCL	0,FFh

The SROM also features Return Codes and Lockouts.

Return Codes

Return codes aid in the determination of success or failure of a particular function. The return code is stored in KEY1's position in the parameter block. The CheckSum and TableRead functions do not have return codes because KEY1's position in the parameter block is used to return other data.

Table 22.SROM Return Codes

Return Code	Description
00h	Success
01h	Function not allowed due to level of protection on block
02h	Software reset without hardware reset
03h	Fatal error, SROM halted

Read, write, and erase operations may fail if the target block is read or write protected. Block protection levels are set during device programming.

The EraseAll function overwrites data in addition to leaving the entire user Flash in the erase state. The EraseAll function loops through the number of Flash macros in the product, executing the following sequence: erase, bulk program all zeros, erase. After all the user space in all the Flash macros are erased, a second loop erases and then programs each protection block with zeros.

SROM Function Descriptions

All SROM functions are described in the following sections.

SWBootReset Function

The SROM function, SWBootReset, is the function that is responsible for transitioning the device from a reset state to running user code. The SWBootReset function is executed whenever the SROM is entered with an M8C accumulator value of 00h; the SRAM parameter block is not used as an input to the function. This will happen, by design, after a hardware reset, because the M8C's accumulator is reset to 00h or when user code executes the SSC instruction with an accumulator value of 00h. The SWBootReset function will not execute when the SSC instruction is executed with a bad key value and a nonzero function code. A CYRF69213 device will execute the HALT instruction if a bad value is given for either KEY1 or KEY2.

The SWBootReset function verifies the integrity of the calibration data by way of a 16-bit checksum, before releasing the M8C to run user code.

ReadBlock Function

The ReadBlock function is used to read 64 contiguous bytes from Flash—a block.

The first thing this function does is to check the protection bits and determine if the desired BLOCKID is readable. If read protection is turned on, the ReadBlock function will exit, setting the accumulator and KEY2 back to 00h. KEY1 will have a value of 01h, indicating a read failure. If read protection is not enabled, the function will read 64 bytes from the Flash using a ROMX instruction and store the results in SRAM using an MVI instruction. The first of the 64 bytes will be stored in SRAM at the address indicated by the value of the POINTER parameter. When the ReadBlock completes successfully, the accumulator, KEY1, and KEY2 will all have a value of 00h.

Table 23.ReadBlock Parameters

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value, when SSC is executed
BLOCKID	0,FAh	Flash block number
POINTER	0,FBh	First of 64 addresses in SRAM where returned data should be stored

WriteBlock Function

The WriteBlock function is used to store data in the Flash. Data is moved 64 bytes at a time from SRAM to Flash using this function. The first thing the WriteBlock function does is to check the protection bits and determine if the desired BLOCKID is writable. If write protection is turned on, the Write-Block function will exit, setting the accumulator and KEY2 back to 00h. KEY1 will have a value of 01h, indicating a write failure. The configuration of the WriteBlock function is straightforward. The BLOCKID of the Flash block, where the data is stored, must be determined and stored at SRAM address FAh.

The SRAM address of the first of the 64 bytes to be stored in Flash must be indicated using the POINTER variable in the parameter block (SRAM address FBh). Finally, the CLOCK



and DELAY values must be set correctly. The CLOCK value determines the length of the write pulse that will be used to store the data in the Flash. The CLOCK and DELAY values are dependent on the CPU speed. Refer to 'Clocking' Section for additional information.

Table 24.WriteBlock Parameters

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value, when SSC is executed
BLOCKID	0,FAh	8-KB Flash block number (00h–7Fh) 4-KB Flash block number (00h–3Fh) 3-KB Flash block number (00h–2Fh)
POINTER	0,FBh	First of 64 addresses in SRAM, where the data to be stored in Flash is located prior to calling WriteBlock
CLOCK	0,FCh	Clock divider used to set the write pulse width
DELAY	0,FEh	For a CPU speed of 12 MHz set to 56h

EraseBlock Function

The EraseBlock function is used to erase a block of 64 contiguous bytes in Flash. The first thing the EraseBlock function does is to check the protection bits and determine if the desired BLOCKID is writable. If write protection is turned on, the EraseBlock function will exit, setting the accumulator and KEY2 back to 00h. KEY1 will have a value of 01h, indicating a write failure. The EraseBlock function is only useful as the first step in programming. Erasing a block will not cause data in a block to be one hundred percent unreadable. If the objective is to obliterate data in a block, the best method is to perform an EraseBlock followed by a WriteBlock of all zeros.

To set up the parameter block for the EraseBlock function, correct key values must be stored in KEY1 and KEY2. The block number to be erased must be stored in the BLOCKID variable and the CLOCK and DELAY values must be set based on the current CPU speed.

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value when SSC is executed
BLOCKID	0,FAh	Flash block number (00h–7Fh)
CLOCK	0,FCh	Clock divider used to set the erase pulse width
DELAY	0,FEh	For a CPU speed of 12 MHz set to 56h

Table 25. EraseBlock Parameters

ProtectBlock Function

The CYRF69213 device offers Flash protection on a block-by-block basis. Table 26 lists the protection modes available. In the table, ER and EW are used to indicate the

ability to perform external reads and writes. For internal writes, IW is used. Internal reading is always permitted by way of the ROMX instruction. The ability to read by way of the SROM ReadBlock function is indicated by SR. The protection level is stored in two bits according to Table 26. These bits are bit packed into the 64 bytes of the protection block. Therefore, each protection block byte stores the protection level for four Flash blocks. The bits are packed into a byte, with the lowest numbered block's protection level stored in the lowest numbered bits.

The first address of the protection block contains the protection level for blocks 0 through 3; the second address is for blocks 4 through 7. The 64th byte will store the protection level for blocks 252 through 255.

Table 26.Protection Modes

Mode	Se	ttings	Des	Description			Marketing		
00b	SR EI	R EW IV	V Unpro	Unprotected			Unprotected		
01b	SR EI	R EW IV	V Read	Read protect			Factory upgrade		
10b	SR EI	R EW IV	V Disab write	Disable external write			Field upgrade		
11b	SR EI	REWIV	V Disab write	le interr	nal	Ful	l protec	tion	
7	6	5	4	3		2	1	0	
Block	ock n+3 Block r		(n+2	n+2 Block n+			1 Block n		

The level of protection is only decreased by an EraseAll, which places zeros in all locations of the protection block. To set the level of protection, the ProtectBlock function is used. This function takes data from SRAM, starting at address 80h, and ORs it with the current values in the protection block. The result of the OR operation is then stored in the protection block. The EraseBlock function does not change the protection level for a block. Because the SRAM location for the protection data is fixed and there is only one protection block per Flash macro, the ProtectBlock function expects very few variables in the parameter block to be set prior to calling the function. The parameter block values that must be set, besides the keys, are the CLOCK and DELAY values.

Table 27.ProtectBlock Parameters

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value when SSC is executed
CLOCK	0,FCh	Clock divider used to set the write pulse width
DELAY	0,FEh	For a CPU speed of 12 MHz set to 56h

EraseAll Function

The EraseAll function performs a series of steps that destroy the user data in the Flash macros and resets the protection block in each Flash macro to all zeros (the unprotected state). The EraseAll function does not affect the three hidden blocks above the protection block in each Flash macro. The first of



these four hidden blocks is used to store the protection table for its eight Kbytes of user data.

The EraseAll function begins by erasing the user space of the Flash macro with the highest address range. A bulk program of all zeros is then performed on the same Flash macro, to destroy all traces of the previous contents. The bulk program is followed by a second erase that leaves the Flash macro in a state ready for writing. The erase, program, erase sequence is then performed on the next lowest Flash macro in the address space if it exists. Following the erase of the user space, the protection block for the Flash macro with the highest address range is erased. Following the erase of the protection block, zeros are written into every bit of the protection table. The next lowest Flash macro in the address space then has its protection block erased and filled with zeros.

The end result of the EraseAll function is that all user data in the Flash is destroyed and the Flash is left in an unprogrammed state, ready to accept one of the various write commands. The protection bits for all user data are also reset to the zero state.

The parameter block values that must be set, besides the keys, are the CLOCK and DELAY values.

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value when SSC is executed
CLOCK	0,FCh	Clock divider used to set the write pulse width
DELAY	0,FEh	For a CPU speed of 12 MHz set to 56h

Table 28. EraseAll Parameters

TableRead Function

The TableRead function gives the user access to part-specific data stored in the Flash during manufacturing. It also returns a Revision ID for the die (not to be confused with the Silicon ID).

Table 29. Table Read Parameters

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value when SSC is executed
BLOCKID	0,FAh	Table number to read

The table space for the CYRF69213 is simply a 64-byte row broken up into eight tables of eight bytes. The tables are numbered zero through seven. All user and hidden blocks in the CYRF69213 parts consist of 64 bytes.

An internal table holds the Silicon ID and returns the Revision ID. The Silicon ID is returned in SRAM, while the Revision ID is returned in the CPU_A and CPU_X registers. The Silicon ID is a value placed in the table by programming the Flash and is controlled by Cypress Semiconductor Product Engineering.

The Revision ID is hard coded into the SROM. The Revision ID is discussed in more detail later in this section.

An internal table holds alternate trim values for the device and returns a one-byte internal revision counter. The internal revision counter starts out with a value of zero and is incremented each time one of the other revision numbers is not incremented. It is reset to zero each time one of the other revision numbers is incremented. The internal revision count is returned in the CPU_A register. The CPU_X register will always be set to FFh when trim values are read. The BLOCKID value, in the parameter block, is used to indicate which table should be returned to the user. Only the three least significant bits of the BLOCKID parameter are used by the TableRead function for the CYRF69213. The upper five bits are ignored. When the function is called, it transfers bytes from the table to SRAM addresses F8h–FFh.

The M8C's A and X registers are used by the TableRead function to return the die's Revision ID. The Revision ID is a 16-bit value hard coded into the SROM that uniquely identifies the die's design.

Checksum Function

The Checksum function calculates a 16-bit checksum over a user specifiable number of blocks, within a single Flash macro (Bank) starting from block zero. The BLOCKID parameter is used to pass in the number of blocks to calculate the checksum over. A BLOCKID value of 1 will calculate the checksum of only block 0, while a BLOCKID value of 0 will calculate the checksum of all 256 user blocks. The 16-bit checksum is returned in KEY1 and KEY2. The parameter KEY1 holds the lower eight bits of the checksum and the parameter KEY2 holds the upper eight bits of the checksum.

The checksum algorithm executes the following sequence of three instructions over the number of blocks times 64 to be checksummed.

romx add [KEY1], A adc [KEY2], 0

Table 30.Checksum Parameters

Name	Address	Description
KEY1	0,F8h	3Ah
KEY2	0,F9h	Stack Pointer value when SSC is executed
BLOCKID	0,FAh	Number of Flash blocks to calculate checksum on

Clocking

The CYRF69213 internal oscillator outputs two frequencies, the Internal 24-MHz Oscillator and the 32-KHz Low-power Oscillator.

The Internal 24-MHz Oscillator is designed such that it may be trimmed to an output frequency of 24 MHz over temperature and voltage variation. With the presence of USB traffic, the Internal 24-MHz Oscillator can be set to precisely tune to USB timing requirements (24 MHz \pm 1.5%). Without USB traffic, the Internal 24-MHz Oscillator accuracy is 24 MHz \pm 5% (between



 $0^{\circ}\text{--}70^{\circ}\text{C}\text{)}.$ No external components are required to achieve this level of accuracy.

The internal low-speed oscillator of nominally 32 KHz provides a slow clock source for the CYRF69213 in suspend mode, particularly to generate a periodic wake-up interrupt and also to provide a clock to sequential logic during power-up and power-down events when the main clock is stopped. In addition, this oscillator can also be used as a clocking source for the Interval Timer clock (ITMRCLK) and Capture Timer clock (TCAPCLK). The 32-KHz Low-power Oscillator can operate in low-power mode or can provide a more accurate clock in normal mode. The Internal 32-KHz Low-power Oscillator accuracy ranges (between $0^{\circ} - 70^{\circ}$ C) as follows:

5V Normal mode: -8% to + 16%

5V LP mode: +12% to + 48%

When using the 32-KHz oscillator the PITMRL/H should be read until two consecutive readings match before sending/receiving data. The following firmware example assumes the developer is interested in the lower byte of the PIT.

Read_PIT_counter: mov A, reg[PITMRL] mov [57h], A mov A, reg[PITMRL] mov [58h], A mov [59h], A mov A, reg{PITMRL] mov [60h], A ;;;Start comparison mov A, [60h] mov X, [59h] sub A, [59h] jz done mov A, [59h] mov X, [58h] sub A, [58h] jz done mov X, [57h] ;;;correct data is in memory location 57h done: mov [57h], X ret



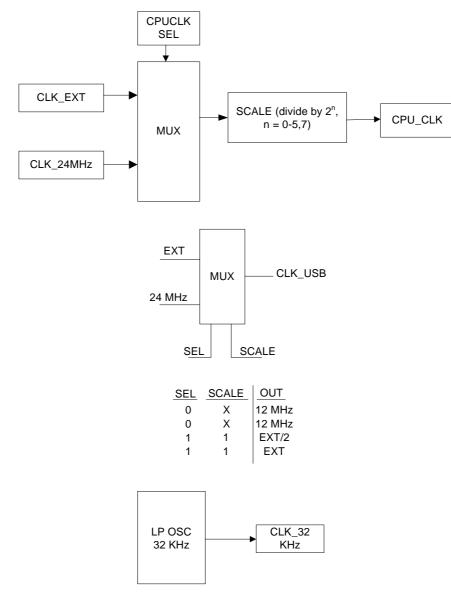


Figure 9. Clock Block Diagram

Clock Architecture Description

The CYRF69213 clock selection circuitry allows the selection of independent clocks for the CPU, USB, Interval Timers, and Capture Timers.

The CPU clock, CPUCLK, can be sourced from the external crystal oscillator or the Internal 24-MHz Oscillator. The selected clock source can optionally be divided by 2^n where *n* is 0–5,7 (see Table 34).

USBCLK, which must be 12 MHz for the USB SIE to function properly, can be sourced by the Internal 24-MHz Oscillator or the external crystal oscillator. An optional divide-by-two allows the use of the 24-MHz source.

The Interval Timer clock (ITMRCLK), can be sourced from the external crystal oscillator, the Internal 24-MHz Oscillator, the

Internal 32-KHz Low-power Oscillator, or from the timer capture clock (TCAPCLK). A programmable prescaler of 1, 2, 3, 4 then divides the selected source.

The Timer Capture clock (TCAPCLK) can be sourced from the external crystal oscillator, Internal 24-MHz Oscillator, or the Internal 32-KHz Low-power Oscillator.

When it is not being used by the external crystal oscillator, the CLKOUT pin can be driven from one of many sources. This is used for test and can also be used in some applications. The sources that can drive the CLKOUT are:

- CLKIN after the optional EFTB filter
- Internal 24-MHz Oscillator
- Internal 32-KHz Low-power Oscillator
- · CPUCLK after the programmable divider



Table 31.IOSC Trim (IOSCTR) [0x34] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field		foffset[2:0]				Gain[4:0]	•	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	D	D	D	D	D
value that is de Default field Bits 7:5 f	orate register is u etermined during foffset [2:0] This value is use	manufacturing	test. This value :	should not requi	re change during	g normal use. Ti	his is the meanir	ng of 'D' in the
f f	Setting each of the foffset bit $0 = 7.5$ foffset bit $1 = 15$ foffset bit $2 = 30$	nese bits causes KHz KHz					, , canzi al cir al	
	Gain [4:0] The effective frective gain of the of setStep) at each Gain bit $0 = -1.5$ Gain bit $1 = -3.0$ Gain bit $2 = -6$ K Gain bit $3 = -12$ Gain bit $4 = -24$	fset input. This bit, typical cond KHz KHz Hz KHz	value sets the si	ze of each offse	0 0	•	0	•

Table 32.LPOSC Trim (LPOSCTR) [0x36] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	32-KHz Low Power	Reserved	32-KHz Bia	is Trim [1:0]		32-KHz Fre	eq Trim [3:0]	
Read/Write	R/W	-	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	D	D	D	D	D	D	D
value that is d Default field. I	s used to calibrate etermined during f the 32-KHz Low m their factory ca 32-KHz Low Pov 0 = The 32-KHz 1 = The 32-KHz reduced accurac	manufacturing /-power bit need librated values ver Low-speed Osc Low-speed Osc	test. This value s s to be written, o illator operates i	should not requi care should be ta n normal mode	re change durin aken not to distu	g normal use. T irb the 32-KHz E	his is the meanir Bias Trim and the	ng of 'D' in the e 32-KHz Freq
Bit 6	Reserved							
Bits 5:4	32-KHz Bias Trin These bits contro 0 0 = Mid bias 0 1 = High bias 1 0 = Reserved 1 1 = Reserved		nt of the low-pov	ver oscillator.				
Important No conditions wit	te Do not program In this setting	m the 32-KHz B	as Trim [1:0] fiel	ld with the reser	ved 10b value, a	as the oscillator	does not oscillat	e at all corner
Bits 3:0	32-KHz Freq Trir	• •						
	These bits are us	sed to trim the fr	equency of the l	low-power oscilla	ator			



Table 33.CPU/USB Clock Config CPUCLKCR) [0x30] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	USB CLK/2 Disable	USB CLK Select		Res	served	-	CPUCLK Se- lect
Read/Write	-	R/W	R/W	-	-	-	-	R/W
Default	0	0	0	0	0	0	0	0
Bit 7	Reserved		•	•		•		
Bit 6	USB CLK/2 Disa This bit only affe 24-MHz Oscillato 0 = USBCLK sou external source i 1 = USBCLK is u	cts the USBCLK or, the divide by urce is divided by s used with a 24	two is always er / two. This is the I-MHz clock	nabled correct setting t	o use when the			
Bit 5	USB CLK Select This bit controls 0 = Internal 24-M requirement of 1 1 = External cloce Proper USB SIE	the clock source 1Hz Oscillator. W .5% tolerance (s k—Internal Osc	/ith the presence see Table 35) illator is not trim	e of USB traffic, t	fic.		can be trimmed t	to meet the USB
Bits 4:1	Reserved							
Bit 0 Note The CP	CPU CLK Select 0 = Internal 24-N 1 = External cloc U speed selection	/Hz Oscillator :k—External cloo	•	, .	ible 34)			



Table 34.OSC Control 0 (OSC_CR0) [0x1E0] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Rese	erved	No Buzz	Sleep T	imer [1:0]		CPU Speed [2:0	
Read/Write	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bits 7:6	Reserved							
	ically to detect ar cycle—Table 42 tion circuit to be of expense of a slig 0 = The LVD and 1 = The Sleep Do	ny POR and LV 2). To facilitate to continuously er htly higher tha I POR detection uty Cycle value	/D events on the the detection of F nabled during sle n average sleep n circuit is turned s is overridden. T	V _{CC} pin (the Sk POR and LVD even. This results current I on periodically he LVD and PO	eep Duty Cycle vents, the No E in a faster resp as configured R detection cir	VD and POR dete bits in the ECO_ Buzz bit is used to onse to an LVD o in the Sleep Duty cuit is always ena the Sleep [1:0] b	TR are used to o force the LVD a or POR event duri Cycle abled	control the cond POR det
	Sleep Timer [1:0]							
Sleep Timer [1:0	0] Sleep Time Frequency (er Clock Nominal)	Sleep Period (Nominal)	Watchdog Pe (Nominal)				
00	512 H	Ηz	1.95 ms	6 ms				
01	64 H	z	15.6 ms	47 ms				
10	8 Hz	z	125 ms	375 ms				
11	1 Hz	z	1 sec	3 sec				
Bits 2:0	default CPU spe Regardless of the apply. An examp MHz. If the CPU the device are th CPU speed is at	a may operate of ed is one-eight e CPU Speed b le of this scena speed register e same as if th 12 MHz or less	h of the internal 2 bit's setting, if the ario is a device th 's value is 0b011 e part was opera	24 MHz, or 3 MI actual CPU spe at is configured , the CPU clock	Hz eed is greater t to use an exte will be 20 MH	lue for the CPU S han 12 MHz, the rnal clock, which z. Therefore the s voltage requirem	24-MHz operatin is supplying a fre supply voltage ree	g requireme equency of 2 quirements f
CPU Speed [2		hen Internal or is selected	External Clo	ock				
000	3 MF	Iz (Default)	Clock In/8	3				
001		6 MHz	Clock In/4					
010		2 MHz	Clock In/2					
011		24 MHz	Clock In/1					
100		.5 MHz	Clock In/1					
101		50 KHz	Clock In/3					
110	1	87 KHz	Clock In/12	28				

Important Note Correct USB operations require the CPU clock speed be at least 1.5 MHz or not less than USB clock/8. If the two clocks have the same source then the CPU clock divider should not be set to divide by more than 8. If the two clocks have different sources, care must be taken to ensure that the maximum ratio of USB Clock/CPU Clock can never exceed 8 across the full specification range of both clock sources

Reserved

Reserved

111



Table 35.USB Osclock Clock Configuration (OSCLCKCR) [0x39] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field			Rese	erved			Fine Tune Only	USB Osclock Disable
Read/Write	-	-	-	-	_	_	R/W	R/W
Default	0	0	0	0	0	0	0	0
	s used to trim the e when the Intern Reserved				peed USB pack	ets as a timing r	eference. The L	JSB Osclock
Bit 1	Fine Tune Only 0 = Enable 1 = Disable the c form a course tur be set to reduce	ning in order to t	une the oscillato	r for correct USE	B SIE operation.	After the oscillat	tor is properly tu	
Bit 0	USB Osclock Dis 0 = Enable. With 1 = Disable. The lator is not source	the presence o Internal 24-MH	z Oscillator is no					ne internal oscil-

Table 36.Timer Clock Config (TMRCLKCR) [0x31] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	TCAPCL	Divider	TCAPCL	K Select	ITMRCL	K Divider	ITMRCL	K Select
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	-	-	-	-	1	1	0	0
	TCAPCLK Divide TCAPCLK Divide 00 = Divide by 2 01 = Divide by 4 10 = Divide by 6 11 = Divide by 8		CAPCLK divisor	ſ				
	TCAPCLK Selec The TCAPCLK S 0 0 = Internal 24- 0 1 = External cr CLKIN input if the 1 0 = Internal 32- 1 1 = TCAPCLK	elect field contro MHz Oscillator vstal oscillator— e external crysta KHz Low-powe	-external crystal al oscillator is dis	oscillator on Cl	KIN and CLKO			
	4-μs interval time change in the 10			at TCAPCLK is	running at 4 MH	z. Changes in T	CAPCLK freque	ncy will cause a
Bits 3:2	ITMRCLK Divide ITMRCLK Divide 0 0 = Divider valu 0 1 = Divider valu 1 0 = Divider valu 1 1 = Divider valu	r r controls the IT ue of 1 ue of 2 ue of 3						
	ITMRCLK Select 0 0 = Internal 24- 0 1 = External cr CLKIN input if the 1 0 = Internal 32- 1 1 = TCAPCLK	MHz Oscillator /stal oscillator – e external crysta	al oscillator is dis		KIN and CLKO	OUT if the extern	al crystal oscillat	or is enabled,



Interval Timer Clock (ITMRCLK)

The Interval Timer Clock (ITMRCLK) can be sourced from the external crystal oscillator, the Internal 24-MHz oscillator, the internal 32-KHz low-power oscillator, or the timer capture clock. A programmable prescaler of 1, 2, 3, or 4 then divides the selected source. The 12-bit Programmable Interval Timer is a simple down counter with a programmable reload value. It provides a 1- μ s resolution by default. When the down counter reaches zero, the next clock is spent reloading. The reload value can be read and written while the counter is running, but care should be taken to ensure that the counter does not unintentionally reload while the 12-bit reload value is only partially stored—for example, between the two writes of the 12-bit value. The programmable interval timer generates an interrupt to the CPU on each reload.

The parameters to be set will appear on the device editor view of PSoC Designer once you place the CYRF69213 Timer User Module. The parameters are PITIMER_Source and PITIMER_Divider. The PITIMER_Source is the clock to the timer and the $\ensuremath{\mathsf{PITMER_Divider}}$ is the value the clock is divided by.

The interval register (PITMR) holds the value that is loaded into the PIT counter on terminal count. The PIT counter is a down counter.

The Programmable Interval Timer resolution is configurable. For example:

TCAPCLK divide by x of CPU clock (for example TCAPCLK divide by 2 of a 24-MHz CPU clock will give a frequency of 12 MHz)

ITMRCLK divide by x of TCAPCLK (for example, ITMRCLK divide by 3 of TCAPCLK is 4 MHz so resolution is 0.25 $\mu s)$

Timer Capture Clock (TCAPCLK)

The Timer Capture clock can be sourced from the external crystal oscillator, internal 24-MHz oscillator or the Internal 332-KHz low-power oscillator. A programmable prescaler of 2, 4, 6, or 8 then divides the selected source.

Figure 10. Programmable Interval Timer Block Diagram

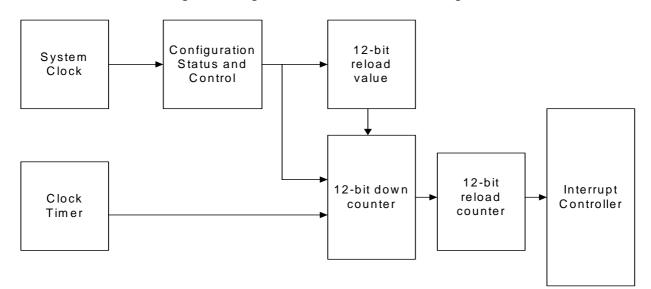




Figure 11. Timer Capture Block Diagram

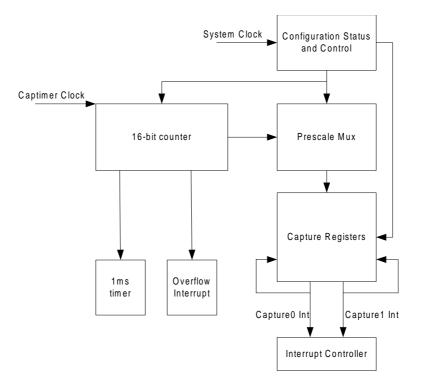


Table 37.Clock I/O Config (CLKIOCR) [0x32] [R/W]

Bit #	7	6	5	4	3	2	1	0		
Field		•	Rese	erved			CLKOU	T Select		
Read/Write	-	R/W R/W								
Default	0	0	0	0	0	0	0	0		
Bits 7:2	Reserved	•	•	•		•	·			
Bits 1:0	CLKOUT Select 0 0 = Internal 24 0 1 = External cr CLKIN input if th 1 0 = Internal 32 1 1 = CPUCLK	-MHz Oscillator ystal oscillator – e external oscill	ator is disabled	oscillator on CL	KIN and CLKO	UT if the externa	al crystal oscillate	or is enabled,		

CPU Clock During Sleep Mode

When the CPU enters sleep mode the CPUCLK Select (Bit [0], Table 33) is forced to the internal oscillator, and the oscillator is stopped. When the CPU comes out of sleep mode it is running on the internal oscillator. The internal oscillator recovery time is three clock cycles of the Internal 32-KHz Low-power Oscillator.

If the system requires the CPU to run off the external clock after awakening from sleep mode, firmware will need to switch the clock source for the CPU.

Reset

The microcontroller supports two types of resets: Power-on Reset (POR) and Watchdog Reset (WDR). When reset is

initiated, all registers are restored to their default states and all interrupts are disabled.

The occurrence of a reset is recorded in the System Status and Control Register (CPU_SCR). Bits within this register record the occurrence of POR and WDR Reset respectively. The firmware can interrogate these bits to determine the cause of a reset.

The microcontroller resumes execution from Flash address 0x0000 after a reset. The internal clocking mode is active after a reset, until changed by user firmware.

Note The CPU clock defaults to 3 MHz (Internal 24-MHz Oscillator divide-by-8 mode) at POR to guarantee operation at the low V_{CC} that might be present during the supply ramp.



Bit #	7	6	5	4	3	2	1	0
Field	GIES	Reserved	WDRS	PORS	Sleep	Rese	erved	Stop
Read/Write	R	-	R/C ^[3]	R/C ^[3]	R/W	-	-	R/W
Default	0	0	0	1	0	0	0	0
The bits of th	ne CPU_SCR regis	ster are used to	convey status a	nd control of eve	ents for various	functions of an C	YRF69213 de	vice
Bit 7	GIES The Global Interr used to provide t is set, it indicates interrupts 0 = Global interro 1 = Global interro	he ability to read s that the GIE bi upts disabled	the GIE bit of th	e CPU_F regis	ter. However, the	e CPU_F register	r is now readat	ole. When this bi
Bit 6	Reserved							
Bit 5	WDRS The WDRS bit is reset that has oc 0 = No WDR 1 = A WDR even	curred. The use			as occurred. Th	e user can read t	this bit to deter	mine the type of
Bit 4	PORS The PORS bit is reset that has oc 0 = No POR 1 = A POR event	curred. The use	r can clear but r	not set this bit			nis bit to detern	mine the type of
Bit 3	SLEEP Set by the user to in more detail in 0 = Normal opera 1 = Sleep	the Sleep Mod		will remain in sle	eep mode until a	ny interrupt is pe	nding. The Sle	ep bit is coverec
Bit 2:1	Reserved							
Bit 0	STOP This bit is set by place. If an appli							,

Table 38.System Status and Control Register (CPU_SCR) [0xFF] [R/W]

Power-on Reset

POR occurs every time the power to the device is switched on. POR is released when the supply is typically 2.6V for the upward supply transition, with typically 50 mV of hysteresis during the power-on transient. Bit 4 of the System Status and Control Register (CPU_SCR) is set to record this event (the register contents are set to 00010000 by the POR). After a POR, the microprocessor is held off for approximately 20 ms for the V_{CC} supply to stabilize before executing the first instruction at address 0x00 in the Flash. If the V_{CC} voltage drops below the POR downward supply trip point, POR is reasserted. The V_{CC} supply needs to ramp linearly from 0 to 4V in 0 to 200 ms.

Important The PORS status bit is set at POR and can only be cleared by the user. It cannot be set by firmware.

Watchdog Timer Reset

The user has the option to enable the WDT. The WDT is enabled by clearing the PORS bit. Once the PORS bit is

Note

3. C = Clear. This bit can only be cleared by the user and cannot be set by firmware

cleared, the WDT cannot be disabled. The only exception to this is if a POR event takes place, which will disable the WDT.

The sleep timer is used to generate the sleep time period and the Watchdog time period. The sleep timer is clocked by the Internal 32-KHz Low-power Oscillator system clock. The user can program the sleep time period using the Sleep Timer bits of the OSC_CR0 Register (Table 34). When the sleep time elapses (sleep timer overflows), an interrupt to the Sleep Timer Interrupt Vector will be generated.

The Watchdog Timer period is automatically set to be three counts of the Sleep Timer overflows. This represents between two and three sleep intervals depending on the count in the Sleep Timer at the previous WDT clear. When this timer reaches three, a WDR is generated.

The user can either clear the WDT, or the WDT and the Sleep Timer. Whenever the user writes to the Reset WDT Register (RES_WDT), the WDT will be cleared. If the data that is written is the hex value 0x38, the Sleep Timer will also be cleared at the same time.



Table 39.Reset Watchdog Timer (RESWDT) [0xE3] [W]

Bit #	7	6	5	4	3	2	1	0			
Field		Reset Watchdog Timer [7:0]									
Read/Write	W	W	W	W	W	W	W	W			
Default	0	0	0	0	0	0	0	0			
Any write to thi	s register will cle	ar Watchdog Ti	mer, a write of 0	x38 will also cle	ar the Sleep Tim	ner					
Bits 7:0	Reset Watchdog	Timer [7:0]									

Sleep Mode

The CPU can only be put to sleep by the firmware. This is accomplished by setting the Sleep bit in the System Status and Control Register (CPU_SCR). This stops the CPU from executing instructions, and the CPU will remain asleep until an interrupt comes pending, or there is a reset event (either a Power-on Reset, or a Watchdog Timer Reset).

The Low-voltage Detection circuit (LVD) drops into fully functional power-reduced states, and the latency for the LVD is increased. The actual latency can be traded against power consumption by changing the Sleep Duty Cycle field of the ECO_TR Register.

The Internal 32-KHz Low-speed Oscillator remains running. Prior to entering suspend mode, firmware can optionally configure the 32-KHz Low-speed Oscillator to operate in a low-power mode to help reduce the overall power consumption (using Bit 7, Table 32). This will help save approximately 5 μ A; however, the trade off is that the 32-KHz Low-speed Oscillator will be less accurate.

All interrupts remain active. Only the occurrence of an interrupt will wake the part from sleep. The Stop bit in the System Status and Control Register (CPU_SCR) must be cleared for a part to resume out of sleep. The Global Interrupt Enable bit of the CPU Flags Register (CPU_F) does not have any effect. Any unmasked interrupt will wake the system up. As a result, any interrupts not intended for waking must be disabled through the Interrupt Mask Registers.

When the CPU enters sleep mode the CPUCLK Select (Bit 1, Table 33) is forced to the Internal Oscillator. The internal oscillator recovery time is three clock cycles of the Internal 32-KHz Low-power Oscillator. The Internal 24-MHz Oscillator restarts immediately on exiting Sleep mode. If an external clock is used, firmware will need to switch the clock source for the CPU.

On exiting sleep mode, once the clock is stable and the delay time has expired, the instruction immediately following the sleep instruction is executed before the interrupt service routine (if enabled).

The Sleep interrupt allows the microcontroller to wake up periodically and poll system components while maintaining very low average power consumption. The Sleep interrupt may also be used to provide periodic interrupts during non-sleep modes.

Sleep Sequence

The SLEEP bit is an input into the sleep logic circuit. This circuit is designed to sequence the device into and out of the hardware sleep state. The hardware sequence to put the device to sleep is shown in Figure 12 and is defined as follows.

- 1. Firmware sets the SLEEP bit in the CPU_SCR0 register. The Bus Request (BRQ) signal to the CPU is immediately asserted. This is a request by the system to halt CPU operation at an instruction boundary. The CPU samples BRQ on the positive edge of CPUCLK.
- 2. Due to the specific timing of the register write, the CPU issues a Bus Request Acknowledge (BRA) on the following positive edge of the CPU clock. The sleep logic waits for the following negative edge of the CPU clock and then asserts a system-wide Power Down (PD) signal. In Figure 12 the CPU is halted and the system-wide power down signal is asserted.
- 3. The system-wide PD (power down) signal controls several major circuit blocks: The Flash memory module, the internal 24-MHz oscillator, the EFTB filter and the bandgap voltage reference. These circuits transition into a zero power state. The only operational circuits on chip are the Low Power oscillator, the bandgap refresh circuit, and the supply voltage monitor (POR/LVD) circuit.

Note To achieve the lowest possible power consumption during suspend/sleep, the following conditions must be observed in addition to considerations for the sleep timer.

- All GPIOs must be set to outputs and driven low
- The USB pins P1.0 and P1.1 should be configured as inputs with their pull ups enabled.



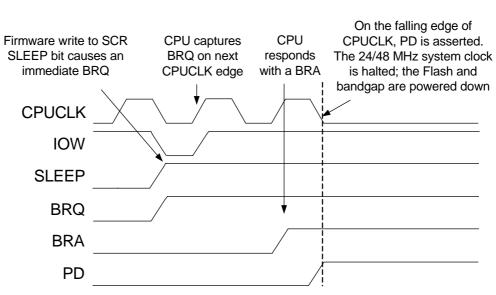


Figure 12. Sleep Timing

Wakeup Sequence

Once asleep, the only event that can wake the system up is an interrupt. The global interrupt enable of the CPU flag register does not need to be set. Any unmasked interrupt will wake the system up. It is optional for the CPU to actually take the interrupt after the wakeup sequence. The wakeup sequence is synchronized to the 32-KHz clock for purposes of sequencing a startup delay, to allow the Flash memory module enough time to power up before the CPU asserts the first read access. Another reason for the delay is to allow the oscillator, Bandgap, and LVD/POR circuits time to settle before actually being used in the system. As shown in Figure 13, the wakeup sequence is as follows:

- 1. The wakeup interrupt occurs and is synchronized by the negative edge of the 32-KHz clock.
- 2. At the following positive edge of the 32-KHz clock, the system-wide PD signal is negated. The Flash memory

module, internal oscillator, EFTB, and bandgap circuit are all powered up to a normal operating state.

- 3. At the following positive edge of the 32-KHz clock, the current values for the precision POR and LVD have settled and are sampled.
- 4. At the following negative edge of the 32-KHz clock (after about 15 μs nominal), the BRQ signal is negated by the sleep logic circuit. On the following CPUCLK, BRA is negated by the CPU and instruction execution resumes. Note that in Figure 13 fixed function blocks, such as Flash, internal oscillator, EFTB, and bandgap, have about 15 μs start up. The wakeup times (interrupt to CPU operational) will range from 75 μs to 105 μs.



	Sleep Timer or GPIO	Interrupt is double sampled by 32K clock and PD is negated to system (nominal)
CLK32K		
INT		
SLEEP		
PD		
BANDGAP		
LVD PPOR		
ENABLE		
SAMPLE		
SAMPLE LVD/POR		
CPUCLK/ 24MHz	(Not to Scale)	
BRQ		
BRA		
CPU		

Figure 13. Wakeup Timing



Low-Voltage Detect Control

Table 40.Low-voltage Control Register (LVDCR) [0x1E3] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Rese	erved	PORLE	V[1:0]	Reserved		VM[2:0]	1
Read/Write	-	_	R/W	R/W	_	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
This register	controls the configu	ration of the Pov	ver-on Reset/Lov	v-voltage Detec	tion block			
Bits 7:6	Reserved			0				
Bits 5:4	PORLEV[1:0]							
	This field controls	the level below w	which the precision	on power-on-res	set (PPOR) detec	tor generates	a reset	
	0 0 = 2.7V Range	(trip near 2.6V)			. ,	-		
	0 1 = 3V Range (t	rip near 2.9V)						
	1 0 = 5V Range, 2	• •	4.65V)					
	1 1 = PPOR will n		,	ad from the Volt	age Monitor Com	parators Regis	ster (Table 41)) aive the inte
							(, <u>g</u>
	nal PPOR compa	rator state with tri	ip point set to the	e 3V range setti	na			
Bit 3	nal PPOR compare Reserved	rator state with tri	p point set to the	e 3V range setti	ng			
	Reserved	rator state with tri	p point set to the	e 3V range setti	ng			
	Reserved VM[2:0]			-	-	ating an interr	int and the lev	el at which th
Bit 3 Bits 2:0	Reserved VM[2:0] This field controls	the level below w		-	-	ating an interro	upt and the leve	el at which th
	Reserved VM[2:0] This field controls Flash is enabled f	the level below v or operation.	which the low-volt	-	-	ating an interro	upt and the lev	el at which th
Bits 2:0	Reserved VM[2:0] This field controls Flash is enabled f	the level below w or operation. LVD Trip Point (which the low-volt	-	-	ating an intern	upt and the lev	el at which th
Bits 2:0	Reserved VM[2:0] This field controls Flash is enabled f	the level below v or operation. LVD Trip Point (Typical	vhich the low-volt	-	-	ating an interro	upt and the lev	el at which th
Bits 2:0	Reserved VM[2:0] This field controls Flash is enabled f	the level below w or operation. LVD Trip Point (Typical 2.70	vhich the low-volt V) Aax. 2.735	-	-	ating an interro	upt and the lev	el at which th
Bits 2:0	Reserved VM[2:0] This field controls Flash is enabled f 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	the level below w or operation. LVD Trip Point (Typical 2.70 2.92	V) Max. 2.735 2.950	-	-	ating an interro	upt and the lev	el at which th
Bits 2:0	Reserved VM[2:0] This field controls Flash is enabled f Min. 2.681	the level below w or operation. LVD Trip Point (Typical 2.70	vhich the low-volt V) Aax. 2.735	-	-	ating an intern	upt and the lev	el at which th
Bits 2:0	Reserved VM[2:0] This field controls Flash is enabled f 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	the level below w or operation. LVD Trip Point (Typical 2.70 2.92	V) Max. 2.735 2.950	-	-	ating an intern	upt and the lev	el at which th
Bits 2:0 VM[2:0] 000 001 010	Reserved VM[2:0] This field controls Flash is enabled f 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	the level below w or operation. LVD Trip Point (2.70 2.92 3.02	Vhich the low-volt V) 2.735 2.950 3.053	-	-	ating an intern	upt and the lev	el at which th
Bits 2:0 VM[2:0] 000 001 010 011	Reserved VM[2:0] This field controls Flash is enabled f 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	the level below v or operation. LVD Trip Point (2.70 2.92 3.02 3.13	vhich the low-volt V) Max. 2.735 2.950 3.053 3.164	-	-	ating an intern	upt and the lev	el at which th
Bits 2:0 VM[2:0] 000 001 010 011 100	Reserved VM[2:0] This field controls Flash is enabled f 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	the level below v or operation. LVD Trip Point (Typical 2.70 2.92 3.02 3.13 4.48	V) Max. 2.735 2.950 3.053 3.164 4.528	-	-	ating an intern	upt and the lev	el at which th

POR Compare State

Table 41.Voltage Monitor Comparators Register (VLTCMP) [0x1E4] [R]

Bit #	7	6	5	4	3	2	1	0
Field			Rese	erved			LVD	PPOR
Read/Write	-	_	-	-	-	-	R	R
Default	0	0	0	0	0	0	0	0
This read-only	register allows re	eading the curre	nt state of the L	ow-voltage-Dete	ection and Precis	sion-Power-On-I	Reset comparate	ors
Bits 7:2	Reserved							
	LVD This bit is set to i the trip point set 0 = No low-voltage 1 = A low-voltage	by VM[2:0] (See ge-detect event	Table 40)	ect comparator I	nas tripped, indi	cating that the s	upply voltage ha	is gone below
	PPOR This bit is set to in trip point set by F 0 = No precision-1 = A precision-p	PORLEV[1:0] power-on-reset	event		rator has tripped	d, indicating that	the supply volta	ge is below the



ECO Trim Register

Table 42.ECO (ECO_TR) [0x1EB] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field	Sleep Duty	Cycle [1:0]		Reserved							
Read/Write	R/W	R/W	-								
Default	0	0	0	0	0	0	0	0			
This register co	ontrols the ratios	(in numbers of	32-KHz clock pe	eriods) of 'on' tim	e versus 'off' tin	ne for LVD and	POR detection of	ircuit			
	Sleep Duty Cycle 0 = 128 periods 0 = 512 periods 1 = 32 periods 1 = 8 periods of	s of the Internal s of the Internal of the Internal 3	32-KHz Low-spe 2-KHz Low-spe	eed Oscillator ed Oscillator							

General-Purpose I/O Ports

The general-purpose I/O ports are discussed in the following sections.

Port Data Registers

Table 43.P0 Data Register (P0DATA)[0x00] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	P0.7	Reserved	Reserved	P0.4/INT2	P0.3/INT1	P0.2/INT0	Reserved	Reserved
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
returns the cu	ontains the data for rrent state of the DO 7 Data		to this register s	sets the bit value	s to be output on	output enabled	pins. Reading fr	om this register
Bit 7	P0.7 Data							
Bits 6:5	Reserved The use of the pi	ns as the P0.6–	P0.5 GPIOs and	d the alternative	functions exist i	n the CYRF692	13	
Bits 4:2	P0.4–P0.2 Data/ In addition to the (INT0–INT2). To The use of the pi	ir use as the P0 configure the P0).4–P0.2 pins, re	efer to the P0.2/I	NT0-P0.4/INT2	Configuration F	Register (Table	
Bit 1	Reserved							
Bit 0	Reserved							

Table 44.P1 Data Register (P1DATA) [0x01] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	P1.7	P1.6/SMISO	P1.5/SMOSI	P1.4/SCLK	P1.3/SSEL	P1.2/VREG	P1.1/D-	P1.0/D+
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0



Table 44.P1 Data Register (P1DATA) [0x01] [R/W]

This register contains the data for Port 1. Writing to this register sets the bit values to be output on output enabled pins. Reading from this register returns the current state of the Port 1 pins Bit 7 P1.7 Data Bits 6:3 P1.6-P1.3 Data/SPI Pins (SMISO, SMOSI, SCLK, SSEL) In addition to their use as the P1.6–P1.3 GPIOs, these pins can also be used for the alternative function as the SPI interface pins. To configure the P1.6-P1.3 pins, refer to the P1.3-P1.6 Configuration Register (Table 51) The use of the pins as the P1.6–P1.3 GPIOs and the alternative functions exist in all the CYRF69213 parts Bit 2 P1.2/VREG A 1-µF min, 2-µF max capacitor is required on VREG output. Bits 1:0 P1.1-P1.0/D- and D+ When USB mode is disabled (Bit 7 in Table 76 is clear), the P1.1 and P1.0 bits are used to control the state of the P1.0 and P1.1 pins. When the USB mode is enabled, the P1.1 and P1.0 pins are used as the D- and D+ pins, respectively. If the USB Force State bit (Bit 0 in Table 74) is set, the state of the D- and D+ pins can be controlled by writing to the D- and D+ bits

Table 45.P2 Data Register (P2DATA) [0x02] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field			Rese	erved			P2.1-	-P2.0
Read/Write	-	-	-	-	-	-	R/W	R/W
Default	0	0	0	0	0	0	0	0
returns the cur	ntains the data for rent state of the Reserved Data [7	Port 2 pins	to this register s	sets the bit value	s to be output on	output enabled	pins. Reading fro	om this register

Bits 1:0 P2 Data [1:0]

GPIO Port Configuration

All the GPIO configuration registers have common configuration controls. The following are the bit definitions of the GPIO configuration registers.

Int Enable

When set, the Int Enable bit allows the GPIO to generate interrupts. Interrupt generate can occur regardless of whether the pin is configured for input or output. All interrupts are edge sensitive, however for any interrupt that is shared by multiple sources (that is, Ports 2, 3, and 4) all inputs must be deasserted before a new interrupt can occur.

When clear, the corresponding interrupt is disabled on the pin.

It is possible to configure GPIOs as outputs, enable the interrupt on the pin and then to generate the interrupt by driving the appropriate pin state. This is useful in test and may have value in applications as well.

Int Act Low

When set, the corresponding interrupt is active on the falling edge.

When clear, the corresponding interrupt is active on the rising edge.

TTL Thresh

When set, the input has TTL threshold. When clear, the input has standard CMOS threshold.

High Sink

When set, the output can sink up to 50 mA.

When clear, the output can sink up to 8 mA.

On the CYRF69213, only the P1.7–P1.3 have 50-mA sink drive capability. Other pins have 8-mA sink drive capability.

Open Drain

When set, the output on the pin is determined by the Port Data Register. If the corresponding bit in the Port Data Register is set, the pin is in high-impedance state. If the corresponding bit in the Port Data Register is clear, the pin is driven low.

When clear, the output is driven LOW or HIGH.

Pull-up Enable

When set the pin has a 7K pull up to V_{CC} (or VREG for ports with V3.3 enabled).

When clear, the pull up is disabled.

Output Enable

When set, the output driver of the pin is enabled.

When clear, the output driver of the pin is disabled.

For pins with shared functions there are some special cases.

VREG Output/SPI Use

The P1.2 (VREG), P1.3 (SSEL), P1.4 (SCLK), P1.5 (SMOSI) and P1.6 (SMISO) pins can be used for their dedicated functions or for GPIO.

To enable the pin for GPIO, clear the corresponding VREG Output or SPI Use bit. The SPI function controls the output enable for its dedicated function pins when their GPIO enable bit is clear.



3.3V Drive

The P1.3 (SSEL), P1.4 (SCLK), P1.5 (SMOSI) and P1.6 (SMISO) pins have an alternate voltage source from the voltage regulator. If the 3.3V Drive bit is set a high level is driven from the voltage regulator instead of from V_{CC} .

Setting the 3.3V Drive bit does not enable the voltage regulator. That must be done explicitly by setting the VREG Enable bit in the VREGCR Register (Table 75).



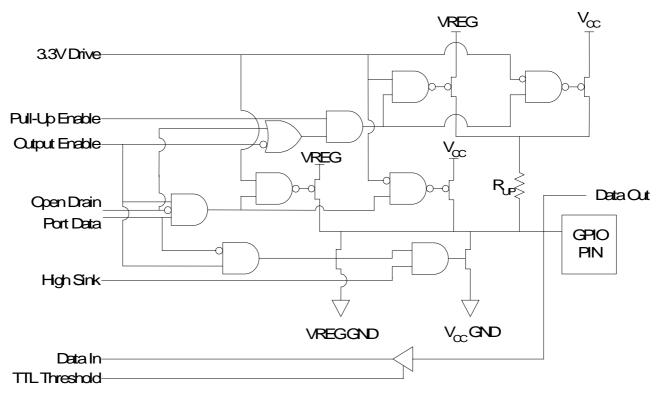


Table 46.P0.2/INT0-P0.4/INT2 Configuration (P02CR-P04CR) [0x07-0x09] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Rese	erved	Int Act Low	TTL Thresh	Reserved	Open Drain	Pull-up Enable	Output Enable
Read/Write	_	_	R/W	R/W	_	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0

These registers control the operation of pins P0.2–P0.4, respectively. These pins are shared between the P0.2–P0.4 GPIOs and the INT0–INT2. These registers exist in all CYRF69213 parts. The INT0–INT2 interrupts are different than all the other GPIO interrupts. These pins are connected directly to the interrupt controller to provide three edge-sensitive interrupts with independent interrupt vectors. These interrupts occur on a rising edge when Int act Low is clear and on a falling edge when Int act Low is set. These pins are enabled as interrupt sources in the interrupt controller registers (Table 72 and Table 70)

To use these pins as interrupt inputs configure them as inputs by clearing the corresponding Output Enable. If the INTO-INT2 pins are configured as outputs with interrupts enabled, firmware can generate an interrupt by writing the appropriate value to the P0.2, P0.3 and P0.4 data bits in the P0 Data Register

Regardless of whether the pins are used as Interrupt or GPIO pins the Int Enable, Int act Low, TTL Threshold, Open Drain, and Pull-up Enable bits control the behavior of the pin

The P0.2/INT0-P0.4/INT2 pins are individually configured with the P02CR (0x07), P03CR (0x08), and P04CR (0x09), respectively.

Note Changing the state of the Int Act Low bit can cause an unintentional interrupt to be generated. When configuring these interrupt sources, it is best to follow the following procedure:

1. Disable interrupt source

2. Configure interrupt source

3. Clear any pending interrupts from the source

4. Enable interrupt source



Table 47.P0.7 Configuration (P07CR) [0x0C] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Int Enable	Int Act Low	TTL Thresh	Reserved	Open Drain	Pull-up Enable	Output Enable
Read/Write	-	R/W	R/W	R/W	-	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
This register co	ntrols the opera	tion of pin P0.7.	•	•		•	•	

This register controls the operation of pin P0.7.

Table 48.P1.0/D+ Configuration (P10CR) [0x0D] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Int Enable	Int Act Low		Reserved		Reserved	Output Enable
Read/Write	R/W	R/W	R/W	_	_	_	-	R/W
Default	0	0	0	0	0	0	0	0

This register controls the operation of the P1.0 (D+) pin when the USB interface is not enabled, allowing the pin to be used as a PS2 interface or a GPIO. See Table 76 for information on enabling USB. When USB is enabled, none of the controls in this register have any effect on the P1.0 pin

Note The P1.0 is an open drain only output. It can actively drive a signal low, but cannot actively drive a signal high

PS/2 Pull-up Enable

Bit 1

0 = Disable the 5K-ohm pull-up resistors

1 = Enable 5K-ohm pull-up resistors for both P1.0 and P1.1. Enable the use of the P1.0 (D+) and P1.1 (D–) pins as a PS2 style interface

Table 49.P1.1/D– Configuration (P11CR) [0x0E] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Int Enable	Int Act Low	Rese	erved	Open Drain	Reserved	Output Enable
Read/Write	_	R/W	R/W	_	_	R/W	_	R/W
Default	0	0	0	0	0	0	0	0

This register controls the operation of the P1.1 (D–) pin when the USB interface is not enabled, allowing the pin to be used as a PS2 interface or a GPIO. See Table 76 for information on enabling USB. When USB is enabled, none of the controls in this register have any effect on the P1.1 pin. When USB is disabled, the 5-Kohm pull-up resistor on this pin can be enabled by the PS/2 Pull-up Enable bit of the P10CR Register (Table 48)

Note There is no 2-mA sourcing capability on this pin. The pin can only sink 5 mA at V_{OL3}

Table 50.P1.2 Configuration (P12CR) [0x0F] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	CLK Output	Int Enable	Int Act Low	TTL Threshold	Reserved	Open Drain	Pull-up Enable	Output Enable
Read/Write	R/W	R/W	R/W	R/W	-	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
This register co	ontrols the opera	tion of the P1.2						
	CLK Output) = The internally I = When CLK C			onto P1.2 pin ted clock is sent	out onto P1.2 p	in		



Table 51.P1.3 Configuration (P13CR) [0x10] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Int Enable	Int Act Low	3.3V Drive	High Sink	Open Drain	Pull-up Enable	Output Enable
Read/Write	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0

This register controls the operation of the P1.3 pin. This register exists in all CYRF69213 parts

The P1.3 GPIO's threshold is always set to TTL

When the SPI hardware is enabled, the output enable and output state of the pin is controlled by the SPI circuitry. When the SPI hardware is disabled, the pin is controlled by the Output Enable bit and the corresponding bit in the P1 data register

Regardless of whether the pin is used as an SPI or GPIO pin the Int Enable, Int act Low, 3.3V Drive, High Sink, Open Drain, and Pull-up Enable control the behavior of the pin

The 50-mA sink drive capability is only available in the CY7C638xx.

Table 52.P1.4-P1.6 Configuration (P14CR-P16CR) [0x11-0x13] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	SPI Use	Int Enable	Int Act Low	3.3V Drive	High Sink	Open Drain	Pull-up Enable	Output Enable
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0

These registers control the operation of pins P1.4–P1.6, respectively

The P1.4–P1.6 GPIO's threshold is always set to TTL

When the SPI hardware is enabled, pins that are configured as SPI Use have their output enable and output state controlled by the SPI circuitry. When the SPI hardware is disabled or a pin has its SPI Use bit clear, the pin is controlled by the Output Enable bit and the corresponding bit in the P1 data register

Regardless of whether any pin is used as an SPI or GPIO pin the Int Enable, Int act Low, 3.3V Drive, High Sink, Open Drain, and Pull-up Enable control the behavior of the pin

Bit 7 SPI Use

0 = Disable the SPI alternate function. The pin is used as a GPIO

1 = Enable the SPI function. The SPI circuitry controls the output of the pin

Important Note for Comm Modes 01 or 10 (SPI Master or SPI Slave, see Table 56)

When configured for SPI (SPI Use = 1 and Comm Modes [1:0] = SPI Master or SPI Slave mode), the input/output direction of pins P1.3, P1.5, and P1.6 is set automatically by the SPI logic. However, pin P1.4's input/output direction is NOT automatically set; it must be explicitly set by firmware. For SPI Master mode, pin P1.4 must be configured as an output; for SPI Slave mode, pin P1.4 must be configured as an input

Table 53. P1.7 Configuration (P17CR) [0x14] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field	Reserved	Int Enable	Int Act Low	TTL Thresh	High Sink	Open Drain	Pull-up Enable	Output Enable			
Read/Write	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Default	0	0	0	0	0	0	1	0			
U	This register controls the operation of pin P1.7. This register only exists in CY7C638xx The 50-mA sink drive capability is only available in the CY7C638xx. The P1.7 GPIO's threshold is always set to TTL										

Table 54.P2 Configuration (P2CR) [0x15] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field	Reserved	Int Enable	Int Act Low	TTL Thresh	High Sink	Open Drain	Pull-up Enable	Output Enable			
Read/Write	_	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Default	0	0	0	0	0	0	0	0			
	This register only exists in CY7C638xx. This register controls the operation of pins P2.0–P2.1. In the CY7C638xx, only 8-mA sink drive capability is available on this pin regardless of the setting of the High Sink bit										



Serial Peripheral Interface (SPI)

The SPI Master/Slave Interface core logic runs on the SPI clock domain, making its functionality independent of system clock speed. SPI is a four pin serial interface comprised of a clock, an enable and two data pins.

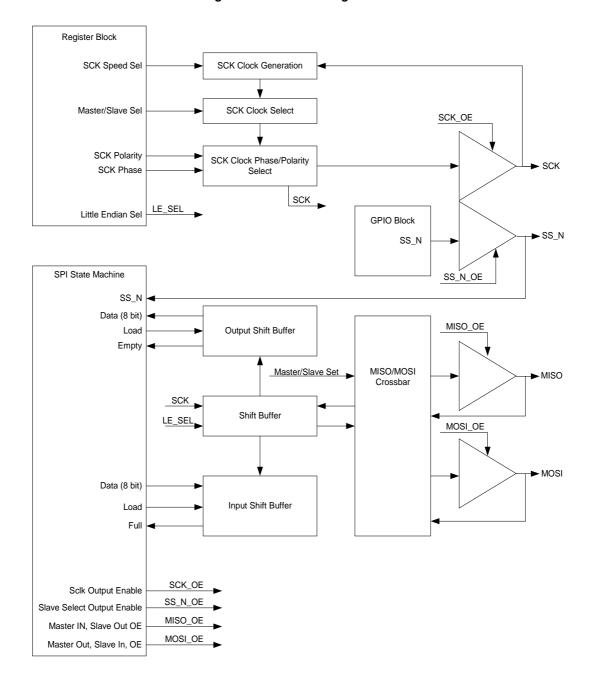


Figure 15. SPI Block Diagram



SPI Data Register

Table 55.SPI Data Register (SPIDATA) [0x3C] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field				SPIDa	ta[7:0]						
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Default	0	0	0	0	0	0	0	0			
When read, th	s register returns	register returns the contents of the receive buffer. When written, it loads the transmit holding register									
Bits 7:0	SPI Data [7:0]										

When an interrupt occurs to indicate to firmware that a byte of receive data is available, or the transmitter holding register is empty, firmware has 7 SPI clocks to manage the buffers—to empty the receiver buffer, or to refill the transmit holding register. Failure to meet this timing requirement will result in incorrect data transfer.

SPI Configure Register

Table 56.SPI Configure Register (SPICR) [0x3D] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Swap	LSB First	Comm	Mode	CPOL	CPHA	SCLK	Select
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bit 7	Swap 0 = Swap functio 1 = The SPI bloc SPI-like commun	k swaps its use	of SMOSI and S	SMISO. Among	other things, this	s can be useful i	n implementing	single wire
Bit 6	LSB First 0 = The SPI tran 1 = The SPI tran		· · ·	0	,			
Bits 5:4	Comm Mode [1:0 0 0: All SPI comm 0 1: SPI master 1 0: SPI slave m 1 1: Reserved	nunication disat	bled					
Bit 3	CPOL This bit controls 0 = SCLK idles to 1 = SCLK idles to	, wc	CLK) idle polari	ty				
Bit 2	CPHA The Clock Phase binations of LSB		•	ock on which da	ta is sampled. Ta	able 57 shows	the timing for th	e various com-
Bits 1:0	SCLK Select This field selects	the speed of th	e master SCLK.	When in maste	r mode, SCLK is	generated by d	lividing the base	CPUCLK
When configu However, pin	ote for Comm Mo ired for SPI, (SPI I P1.4's input/output I as an output; for	Use = 1—Table	52), the input/o	utput direction o	explicitly set by f	, and P1.6 is se firmware. For SI	t automatically b PI Master mode,	y the SPI logic. , pin P1.4 must



Table 57.SPI Mode Timing vs. LSB First, CPOL and CPHA

LSB First		CPOL	Diagram
0	0	0	SCLK SSEL DATA X M\$B X Bit 7 X Bit 6 X Bit 5 X Bit 4 X Bit 3 X Bit 2 X LSB X X
0	0	4	
	0	1	SCLK SSEL DATA X MSB X Bit 7 X Bit 6 X Bit 5 X Bit 4 X Bit 3 X Bit 2 X LSB X X
0	1	0	SCLK SSEL DATA X M\$B Bi7 X Bit6 X Bit5 X Bit4 X Bit3 X Bit2 X LSB X
0	1	1	SCLK SSEL DATA X M\$B Bil 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 LSB X
1	0	0	SCLK SSEL DATA X LSB Bi 2 Bit 3 Bit 4 Bit 5 Bit 6 Bit 7 MSB X
1	0	1	SCLK SSEL DATA X L\$B Bit 2 Bit 3 Bit 4 Bit 5 Bit 6 Bit 7 MSB X
1	1	0	SCLK SSEL DATA X LSB Bit2 / Bit3 / Bit4 / Bit5 / Bit6 / Bit7 / MSB / X
1	1	1	SCLK SSEL DATA X LSB Bi 2 X Bit 3 X Bit 4 X Bit 5 X Bit 6 X Bit 7 MSB X X

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Table 58.SPI SCLK Frequency

SCLK	CPUCLK	SCLK Frequency when CPUCLK =					
Select	Divisor	12 MHz	24 MHz				
00	6	2 MHz	4 MHz				
01	12	1 MHz	2 MHz				
10	48	250 KHz	500 KHz				
11	96	125 KHz	250 KHz				

Timer Registers

All timer functions of the CYRF69213 are provided by a single timer block. The timer block is asynchronous from the CPU clock.

Registers

Free-Running Counter

The 16-bit free-running counter is clocked by a 4/6-MHz source. It can be read in software for use as a general-purpose time base. When the low order byte is read, the high order byte is registered. Reading the high order byte reads this register allowing the CPU to read the 16-bit value atomically (loads all bits at one time). The free-running timer generates an interrupt at a 1024- μ s rate. It can also generate an interrupt when the free-running counter overflow occurs—every 16.384 ms. This allows extending the length of the timer in software.

Figure 16. 16-Bit Free-Running Counter Block Diagram

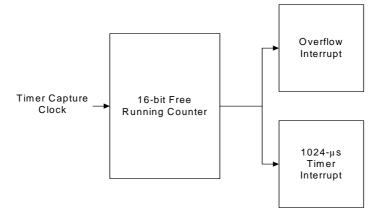


Table 59.Free-Running Timer Low-Order Byte (FRTMRL) [0x20] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field				Free-running	g Timer [7:0]			
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bits 7:0	Free-running Tim	ner [7:0]						

This register holds the low-order byte of the 16-bit free-running timer. Reading this register causes the high-order byte to be moved into a holding register allowing an automatic read of all 16 bits simultaneously.

For reads, the actual read occurs in the cycle when the low order is read. For writes, the actual time the write occurs is the cycle when the high order is written

When reading the free-running timer, the low-order byte should be read first and the high-order second. When writing, the low-order byte should be written first then the high-order byte

Table 60.Free-Running Timer High-Order Byte (FRTMRH) [0x21] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field				Free-running	Timer [15:8]			
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bits 7:0 F	ree-running Tim	ner [15:8]						
When reading t be written first t			der byte should	be read first and	the high-order s	econd. When w	riting, the low-or	der byte should



Table 61.Programmable Interval Timer Low (PITMRL) [0x26] [R]

Bit #	7	6	5	4	3	2	1	0			
Field		Prog Interval Timer [7:0]									
Read/Write	R	R	R	R	R	R	R	R			
Default	0	0	0	0	0	0	0	0			

Bits 7:0 'Prog Interval Timer [7:0]

This register holds the low-order byte of the 12-bit programmable interval timer. Reading this register causes the high-order byte to be moved into a holding register allowing an automatic read of all 12 bits simultaneously

Table 62.Programmable Interval Timer High (PITMRH) [0x27] [R]

Bit #	7	6	5	4	3	2	1	0
Field		Rese	erved			Prog Interva	l Timer [11:8]	
Read/Write	-	-	-	-	R	R	R	R
Default	0	0	0	0	0	0	0	0
Bits 7:4	Reserved							
Bits 3:0	Prog Internal Tim	ner [11:8]						
This register h 12-bit timer at	nolds the high-ord the instant that th	ler nibble of the he low-order byt	12-bit programn e was last read	nable interval tim	ner. Reading this	s register returns	s the high-order	nibble of the

Table 63.Programmable Interval Reload Low (PIRL) [0x28] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field		Prog Interval [7:0]									
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Default	0	0	0	0	0	0	0	0			
Bits 7:0 F	Prog Interval [7:0)]		•		•	•				

Bits 7:0 Prog Interval [7:0]

This register holds the lower 8 bits of the timer. While writing into the 12-bit reload register, write lower byte first then the higher nibble

Table 64.Programmable Interval Reload High (PIRH) [0x29] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field		Rese	erved		Prog Interval[11:8]						
Read/Write	-	-	-	-	R/W	R/W	R/W	R/W			
Default	0	0	0	0	0	0	0	0			
Bits 7:4	Reserved										
Bits 3:0	Prog Interval [11	og Interval [11:8]									
This register h	This register holds the higher 4 bits of the timer. While writing into the 12-bit reload register, write lower byte first then the higher nibble										



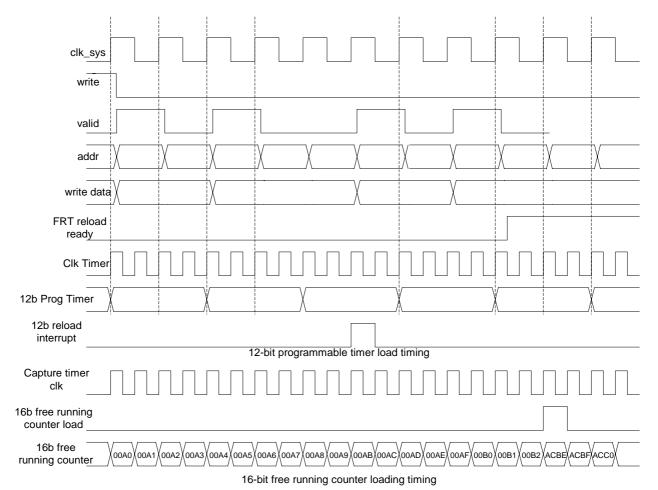
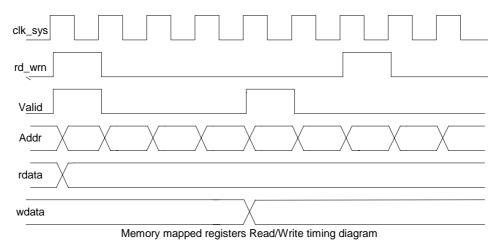


Figure 17. 16-Bit Free-Running Counter Loading Timing Diagram





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Interrupt Controller

The interrupt controller and its associated registers allow the user's code to respond to an interrupt from almost every functional block in the CYRF69213 devices. The registers associated with the interrupt controller allow interrupts to be disabled either globally or individually. The registers also provide a mechanism by which a user may clear all pending and posted interrupts, or clear individual posted or pending interrupts.

The following table lists all interrupts and the priorities that are available in the CYRF69213.

Table 65.Interrupt Numbers, Priorities, Vectors

Interrupt Priority	Interrupt Address	Name
0	0000h	Reset
1	0004h	POR/LVD
2	0008h	INT0
3	000Ch	SPI Transmitter Empty
4	0010h	SPI Receiver Full
5	0014h	GPIO Port 0
6	0018h	GPIO Port 1
7	001Ch	INT1
8	0020h	EP0
9	0024h	EP1
10	0028h	EP2
11	002Ch	USB Reset
12	0030h	USB Active
13	0034h	1-ms Interval timer
14	0038h	Programmable Interval Timer
15	003Ch	Reserved
16	0040h	Reserved

Table 65.Interrupt Numbers, Priorities, Vectors (continued)

Interrupt Priority	Interrupt Address	Name
17	0044h	16-bit Free Running Timer Wrap
18	0048h	INT2
19	004Ch	Reserved
20	0050h	GPIO Port 2
21	0054h	Reserved
22	0058h	Reserved
23	005Ch	Reserved
24	0060h	Reserved
25	0064h	Sleep Timer

Architectural Description

An interrupt is posted when its interrupt conditions occur. This results in the flip-flop in Figure 19 clocking in a '1'. The interrupt will remain posted until the interrupt is taken or until it is cleared by writing to the appropriate INT_CLRx register.

A posted interrupt is not pending unless it is enabled by setting its interrupt mask bit (in the appropriate INT_MSKx register). All pending interrupts are processed by the Priority Encoder to determine the highest priority interrupt which will be taken by the M8C if the Global Interrupt Enable bit is set in the CPU_F register.

Disabling an interrupt by clearing its interrupt mask bit (in the INT_MSKx register) does not clear a posted interrupt, nor does it prevent an interrupt from being posted. It simply prevents a posted interrupt from becoming pending.

Nested interrupts can be accomplished by re-enabling interrupts inside an interrupt service routine. To do this, set the IE bit in the Flag Register.

A block diagram of the CYRF69213 Interrupt Controller is shown in Figure 19.

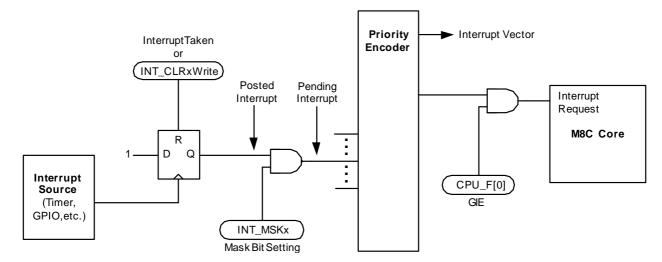


Figure 19. Interrupt Controller Block Diagram

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Interrupt Processing

The sequence of events that occur during interrupt processing is as follows:

1. An interrupt becomes active, either because:

- a. The interrupt condition occurs (for example, a timer expires).
- b. A previously posted interrupt is enabled through an update of an interrupt mask register.
- c. An interrupt is pending and GIE is set from 0 to 1 in the CPU Flag register.
- 2. The current executing instruction finishes.
- 3. The internal interrupt is dispatched, taking 13 cycles. During this time, the following actions occur:
 - a. The MSB and LSB of Program Counter and Flag registers (CPU_PC and CPU_F) are stored onto the program stack by an automatic CALL instruction (13 cycles) generated during the interrupt acknowledge process.
 - b. The PCH, PCL, and Flag register (CPU_F) are stored onto the program stack (in that order) by an automatic CALL instruction (13 cycles) generated during the interrupt acknowledge process.
 - c. The CPU_F register is then cleared. Since this clears the GIE bit to 0, additional interrupts are temporarily disabled
 - d. The PCH (PC[15:8]) is cleared to zero.
 - e. The interrupt vector is read from the interrupt controller and its value placed into PCL (PC[7:0]). This sets the program counter to point to the appropriate address in the interrupt table (for example, 0004h for the POR/LVD interrupt).
- Program execution vectors to the interrupt table. Typically, a LJMP instruction in the interrupt table sends execution to the user's Interrupt Service Routine (ISR) for this interrupt.
- 5. The ISR executes. Note that interrupts are disabled since GIE = 0. In the ISR, interrupts can be re-enabled if desired

Table 66. Interrupt Clear 0 (INT_CLR0) [0xDA] [R/W]

by setting GIE = 1 (care must be taken to avoid stack overflow).

- 6. The ISR ends with a RETI instruction which restores the Program Counter and Flag registers (CPU_PC and CPU_F). The restored Flag register re-enables interrupts, since GIE = 1 again.
- 7. Execution resumes at the next instruction, after the one that occurred before the interrupt. However, if there are more pending interrupts, the subsequent interrupts will be processed before the next normal program instruction.

Interrupt Latency

The time between the assertion of an enabled interrupt and the start of its ISR can be calculated from the following equation.

Latency = Time for current instruction to finish + Time for internal interrupt routine to execute + Time for LJMP instruction in interrupt table to execute.

For example, if the 5-cycle JMP instruction is executing when an interrupt becomes active, the total number of CPU clock cycles before the ISR begins would be as follows:

(1 to 5 cycles for JMP to finish) + (13 cycles for interrupt routine) + (7 cycles for LJMP) = 21 to 25 cycles.

In the example above, at 24 MHz, 25 clock cycles take 1.042 $\mu s.$

Interrupt Registers

The Interrupt Registers are discussed it the following sections.

Interrupt Clear Register

The Interrupt Clear Registers (INT_CLRx) are used to enable the individual interrupt sources' ability to clear posted interrupts.

When an INT_CLRx register is read, any bits that are set indicates an interrupt has been posted for that hardware resource. Therefore, reading these registers gives the user the ability to determine all posted interrupts.

Bit #	7	6	5	4	3	2	1	0
Field	GPIO Port 1	Sleep Timer	INT1	GPIO Port 0	SPI Receive	SPI Transmit	INT0	POR/LVD
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0

When reading this register,

0 = There's no posted interrupt for the corresponding hardware

1 = Posted interrupt for the corresponding hardware present

Writing a '0' to the bits will clear the posted interrupts for the corresponding hardware. Writing a '1' to the bits AND to the ENSWINT (Bit 7 of the INT_MSK3 Register) will post the corresponding hardware interrupt



Table 67. Interrupt Clear 1 (INT_CLR1) [0xDB] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Prog Interval Timer	1-ms Timer	USB Active	USB Reset	USB EP2	USB EP1	USB EP0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0

When reading this register,

0 = There's no posted interrupt for the corresponding hardware

1 = Posted interrupt for the corresponding hardware present

Writing a '0' to the bits will clear the posted interrupts for the corresponding hardware. Writing a '1' to the bits AND to the ENSWINT (Bit 7 of the INT_MSK3 Register) will post the corresponding hardware interrupt

Bit 7 Reserved

Table 68.Interrupt Clear 2 (INT_CLR2) [0xDC] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Reserved	Reserved	GPIO Port 2	Reserved	INT2	16-bit Counter Wrap	Reserved
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0

When reading this register,

0 = There's no posted interrupt for the corresponding hardware

1 = Posted interrupt for the corresponding hardware present

Writing a '0' to the bits will clear the posted interrupts for the corresponding hardware. Writing a '1' to the bits AND to the ENSWINT (Bit 7 of the INT_MSK3 Register) will post the corresponding hardware interrupt

Bits 7,6,5,3,0 Reserved

Interrupt Mask Registers

The Interrupt Mask Registers (INT_MSKx) are used to enable the individual interrupt sources' ability to create pending interrupts.

There are four Interrupt Mask Registers (INT_MSK0, INT_MSK1, INT_MSK2, and INT_MSK3), which may be referred to in general as INT_MSKx. If cleared, each bit in an INT_MSKx register prevents a posted interrupt from becoming a pending interrupt (input to the priority encoder). However, an interrupt can still post even if its mask bit is zero. All INT_MSKx bits are independent of all other INT_MSKx bits.

If an INT_MSKx bit is set, the interrupt source associated with that mask bit may generate an interrupt that will become a pending interrupt. The Enable Software Interrupt (ENSWINT) bit in INT_MSK3[7] determines the way an individual bit value written to an INT_CLRx register is interpreted. When is cleared, writing 1's to an INT_CLRx register has no effect. However, writing 0's to an INT_CLRx register, when ENSWINT is cleared, will cause the corresponding interrupt to clear. If the ENSWINT bit is set, any 0's written to the INT_CLRx registers are ignored. However, 1's written to an INT_CLRx register, while ENSWINT is set, will cause an interrupt to post for the corresponding interrupt.

Software interrupts can aid in debugging interrupt service routines by eliminating the need to create system level interactions that are sometimes necessary to create a hardware-only interrupt.

Bit #	7	6	5	4	3	2	1	0	
Field	ENSWINT				Reserved				
Read/Write	R/W	_	-	-	_	_	-	-	
Default	0	0	0	0	0	0	0	0	
Bit 7	Enable Software Interrupt (ENSWINT) 0 = Disable. Writing 0's to an INT_CLRx register, when ENSWINT is cleared, will cause the corresponding interrupt to clear 1 = Enable. Writing 1's to an INT_CLRx register, when ENSWINT is set, will cause the corresponding interrupt to post								
Bits 6:0	Reserved								

Table 69.Interrupt Mask 3 (INT_MSK3) [0xDE] [R/W]



Table 70.Interrupt Mask 2 (INT_MSK2) [0xDF] [R/W]

Bit #	7	6	5	4	3	2	1	0		
Field	Reserved	Reserved	Reserved	GPIO Port 2 Int Enable	Reserved	INT2 Int Enable	16-bit Counter Wrap Int Enable	Reserved		
Read/Write	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
Default	0	0	0	0	0	0	0	0		
Bit 7	Reserved	•	•							
Bit 6	Reserved									
Bit 5	Reserved	eserved								
Bit 4	0 = Mask GPIO I	GPIO Port 2 Interrupt Enable = Mask GPIO Port 2 interrupt = Unmask GPIO Port 2 interrupt								
Bit 3	Reserved									
Bit 2	INT2 Interrupt Er 0 = Mask INT2 ir 1 = Unmask INT	nterrupt								
Bit 1	0 = Mask 16-bit (16-bit Counter Wrap Interrupt Enable) = Mask 16-bit Counter Wrap interrupt 1 = Unmask 16-bit Counter Wrap interrupt								
Bit 0	Reserved									

Table 71.Interrupt Mask 1 (INT_MSK1) [0xE1] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Reserved	Prog Interval Timer Int Enable	1-ms Timer Int Enable	USB Active Int Enable	USB Reset Int Enable	USB EP2 Int Enable	USB EP1 Int Enable	USB EP0 Int Enable
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bit 7	Reserved							
Bit 6	Prog Interval Tim 0 = Mask Prog Ir 1 = Unmask Prog	nterval Timer inte	errupt					
Bit 5	1-ms Timer Inter 0 = Mask 1-ms ir 1 = Unmask 1-m	nterrupt						
Bit 4	USB Active Inter 0 = Mask USB A 1 = Unmask USB	ctive interrupt	t					
Bit 3	USB Reset Inter 0 = Mask USB R 1 = Unmask USB	eset interrupt	t					
Bit 2	USB EP2 Interru 0 = Mask EP2 in 1 = Unmask EP2	terrupt						
Bit 1	USB EP1 Interru 0 = Mask EP1 in 1 = Unmask EP1	terrupt						
Bit 0	USB EP0 Interru 0 = Mask EP0 in 1 = Unmask EP0	terrupt						



Table 72. Interrupt Mask 0 (INT_MSK0) [0xE0] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	GPIO Port 1 Int Enable	Sleep Timer Int Enable	INT1 Int Enable	GPIO Port 0 Int Enable	SPI Receive Int Enable	SPI Transmit Int Enable	INT0 Int Enable	POR/LVD Int Enable
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bit 7	GPIO Port 1 Inte 0 = Mask GPIO I 1 = Unmask GPI	Port 1 interrupt	ot					
Bit 6	Sleep Timer Inte 0 = Mask Sleep 1 = Unmask Slee	Timer interrupt	ot					
Bit 5	INT1 Interrupt Er 0 = Mask INT1 ir 1 = Unmask INT	nterrupt						
Bit 4	GPIO Port 0 Inte 0 = Mask GPIO I 1 = Unmask GPI	Port 0 interrupt	ot					
Bit 3	SPI Receive Inte 0 = Mask SPI Re 1 = Unmask SPI	eceive interrupt	ot					
Bit 2	SPI Transmit Inte 0 = Mask SPI Tra 1 = Unmask SPI	ansmit interrupt	pt					
Bit 1	INT0 Interrupt Er 0 = Mask INT0 ir 1 = Unmask INT0	nterrupt						
Bit 0	POR/LVD Interru 0 = Mask POR/L 1 = Unmask POR	VD interrupt						

Interrupt Vector Clear Register

Table 73.Interrupt Vector Clear Register (INT_VC) [0xE2] [R/W]

Bit #	7	6	5	4	3	2	1	0			
Field				Pending Int	errupt [7:0]						
Read/Write	R/W	R/W R/W R/W R/W R/W R/W R/W									
Default	0	0	0	0	0	0	0	0			
	ector Clear Regi ending interrupts	ister (INT_VC) h	olds the interrup	ot vector for the	nighest priority p	pending interrup	t when read, and	d when written			
Bits 7:0	Pending Interrup	t [7:0]									
	8-bit data value h interrupts	bit data value holds the interrupt vector for the highest priority pending interrupt. Writing to this register will clear all pending									



USB Transceiver

USB Transceiver Configuration

Table 74.USB Transceiver Configure Register (USBXCR) [0x74] [R/W]

Bit #	7	6	5	4	3	2	1	0					
Field	USB Pull-up Enable			Rese	erved			USB Force State					
Read/Write	R/W	-	-	-	-	-	-	R/W					
Default	0	0	0 0 0 0 0										
Bit 7	USB Pull-up Enable 0 = Disable the pull-up resistor on D– 1 = Enable the pull-up resistor on D–. This pull-up is to V _{CC} IF VREG is not enabled or to the internally generated 3.3V when VREG is enabled												
Bits 6:1	Reserved												
Bit 0	USB Force State This bit allows th 0 = Disable USB 1 = Enable USB USB mode. Refe	e state of the US Force State Force State. Alle	ows the D– and	D+ pins to be co				e USBIO is in					
3.3V regulato the bandgap (wakeup follow up following a pulse occurrir the bandgap	USB transceiver has a dedicated 3.3V regulator for USB signalling purposes and to provide for the 1.5K D– pull up. Unlike the othe ator, this regulator cannot be controlled/accessed by firmware. When the device is suspended, this regulator is disabled along with ap (which provides the reference voltage to the regulator) and the D– line is pulled up to 5V through an alternate 6.5K resistor. During lowing a suspend, the band gap and the regulator are switched on in any order. Under an extremely rare case when the device wakes g a bus reset condition and the voltage regulator and the band gap turn on in that particular order, there is possibility of a glitch/low ring on the D– line. The host can misinterpret this as a deattach condition. This condition, although rare, can be avoided by keeping ap circuitry enabled during sleep. This is achieved by setting the 'No Buzz' bit, bit[5] in the OSC_CR0 register. This is an issue only the is put to sleep during a bus reset condition.												

VREG Control

Table 75.VREG Control Register (VREGCR) [0x73] [R/W]

Bit #	7	6	5	4	3	2	1	0					
Field		•	Rese	erved			Keep Alive	VREG Enable					
Read/Write	-	-	-	-	-	-	R/W	R/W					
Default	0 0 0 0 0 0 0												
Bits 7:2													
Bit 1	Keep Alive Keep Alive when P12CR[0],P12CI 0 = Disabled 1 = Enabled		0 0	to source up to	20 µA of currer	nt when voltage i	regulator is disa	bled,					
Bit 0 Note Use of ti voltage	VREG Enable This bit turns on This block should below $4.35V$ 0 = Disable the 3 1 = Enable the 3 he alternate drive	d not be enabled 3.3V voltage reg .3V voltage regu	d when V _{CC} is buulator output on	elow 4.35V—alti the VREG/P1.2 the VREG/P1.2	hough no damag pin pin. GPIO functi	ge or irregularitie	es will occur if it s disabled	is enabled					

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USB Serial Interface Engine (SIE)

The SIE allows the microcontroller to communicate with the USB host at low-speed data rates (1.5 Mbps). The SIE simplifies the interface between the microcontroller and USB by incorporating hardware that handles the following USB bus activity independently of the microcontroller:

- Translating the encoded received data and formatting the data to be transmitted on the bus
- CRC checking and generation. Flagging the microcontroller if errors exist during transmission
- Address checking. Ignoring the transactions not addressed to the device
- Sending appropriate ACK/NAK/STALL handshakes

USB Device

Table 76.USB Device Address (USBCR) [0x40] [R/W]

- Identifying token type (SETUP, IN, or OUT). Setting the appropriate token bit once a valid token is received
- Placing valid received data in the appropriate endpoint FIFOs
- Sending and updating the data toggle bit (Data1/0)
- Bit stuffing/unstuffing.

Firmware is required to handle the rest of the USB interface with the following tasks:

- · Coordinate enumeration by decoding USB device requests
- · Fill and empty the FIFOs
- Suspend/Resume coordination
- · Verify and select Data toggle values

Bit #	7	6	5	4	3	2	1	0				
Field	USB Enable			De	evice Address[6	5:0]						
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W				
Default	0	0	0	0	0	0	0	0				
The content of	ent of this register is cleared when a USB Bus Reset condition occurs											
Bit 7	USB Enable This bit must be in Device Address this bit prior to er 0 = Disable USB 1 = Enable USB	ss [6:0]. When the the theorem of the second se	his bit is cleared, ode to save powe and put the US	the USB transc er B transceiver int	eiver enters po o power-down :	wer-down state. state						
Bits 6:0	Device Address These bits must assigned by the	be set by firmwa	are during the U	SB enumeration	process (for ex	ample, SetAddro	ess) to the non-z	zero address				

Table 77.Endpoint 0, 1, and 2 Count (EP0CNT-EP2CNT) [0x41, 0x43, 0x45] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Data Toggle	Data Valid	Rese	erved		Byte Co	ount[3:0]	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bit 7	Data Toggle This bit selects th Toggle. For OUT 0 = DATA0 1 = DATA1	•	00					ansmitted Data
Bit 6	Data Valid This bit is used for does not update 0 = Data is invali 1 = Data is valid	for some endpo	int mode setting	S			errors have occu	urred. This bit
Bits 5:4	Reserved							
Bits 3:0	Byte Count Bit [3 Byte Count Bits in bytes to be transic count is updated	ndicate the numb mitted to the hos by hardware to t	t from the endpo the number of da	oint FIFO. Valid v ata bytes receive	alues are 0 to 8 d, plus 2 for the	inclusive. For O CRC bytes. Valie	UT or SETUP tra d values are 2–1	insactions, the 0 inclusive.
by the CPU. F	Count Register, Reading the regist	whenever the c er unlocks it. Th	ount updates fro	ware from overv	vriting a status u	, the count regis pdate on it	ster locks and ca	nnot be written



Endpoint 0 Mode

Because both firmware and the SIE are allowed to write to the Endpoint 0 Mode and Count Registers the SIE provides an interlocking mechanism to prevent accidental overwriting of data. When the SIE writes to these registers they are locked and the processor cannot write to them until after it has read them. Writing to this register clears the upper four bits regardless of the value written.

Table 78.Endpoint 0 Mode (EP0MODE) [0x44] [R/W]

Bit #	7	6	5	4	3	2	1	0
Field	Setup Received	IN Received	OUT Received	ACK'd Trans		Mode	ə[3:0]	
Read/Write	R/C[3]	R/C[3]	R/C[3]	R/C[3]	R/W	R/W	R/W	R/W
Default	0	0	0	0	0	0	0	0
Bit 7	SETUP Receive This bit is set by the SETUP trans While this bit is s transaction befor This bit is cleare 0 = No SETUP received 1 = SETUP received	hardware when cactions until the cet to '1', the CP re firmware has d by any non-loo eceived	e end of the data U cannot write to a chance to read	, phase of a cont o the EP0 FIFO. d the SETUP da	rol write transfe This prevents f	er and cannot be	cleared during	this interval.
Bit 6	IN Received This bit, when se data packet.Whe ing an ACK hand This bit is clearer 0 = No IN received 1 = IN received	n clear, it indica Ishake d by any non-loc	tes that either no	o IN has been re				
Bit 5	OUT Received This bit, when se packet in an OUT This bit is cleared 0 = No OUT receive 1 = OUT receive	Γ transaction. W d by any non-loo eived	/hen clear, it indi	cates no OUT re		This bit is updat	ed to '1' after th	ne last received
Bit 4	ACK'd Transactic The ACK'd trans packet This bit is cleared 1 = The transact 0 = The transact	action bit is set v d by any non-loo ion completes w	cked writes to the vith an ACK	e register	ransaction to th	e register's endp	oint that comple	etes with a ACK
Bits 3:0	Mode [3:0] The endpoint mo the USB SIE res endpoint	des determine h	now the SIE resp	onds to USB tra			•	



Table 79.Endpoint 1 and 2 Mode (EP1MODE – EP2MODE) [0x45, 0x46] [R/W]

Bit #	7	6	5	4	3	2 1 0							
Field	Stall	Reserved	NAK Int Enable	ACK'd Transaction		Mode	ə[3:0]						
Read/Write	R/W	R/W	R/W	R/C (Note 3)	R/W	R/W	R/W	R/W					
Default	0	0	0	0	0	0	0	0					
Bit 7	Stall When this bit is s mode bits are se					K-OUT, and the	SIE will stall an	IN packet if the					
Bit 6	Reserved												
Bit 5	NAK Int Enable This bit, when set, causes an endpoint interrupt to be generated even when a transfer completes with a NAK. Unlike enCoRe, CYRF69213 family members do not generate an endpoint interrupt under these conditions unless this bit is set 0 = Disable interrupt on NAK'd transactions 1 = Enable interrupt on NAK'd transaction												
Bit 4	ACK'd Transaction The ACK'd trans ACK packet This bit is cleared 0 = The transaction 1 = The transaction	action bit is set d by any writes t ion does not cor	o the register nplete with an A		transaction to th	e register's end	point that compl	etes with an					
Bits 3:0	Mode [3:0] The endpoint mo the USB SIE res endpoint.												
respectively (i EP1MODE an to EP2MODE can put the er	/hen the SIE writes to the EP1MODE or the EP2MODE register it blocks firmware writes to the EP2MODE or the EP1MODE registers, tively (if both writes occur in the same clock cycle). This is because the design employs only one common 'update' signal for both ODE and EP2MODE registers. Thus, when SIE writes to the EP1MODE register, the update signal is set and this prevents firmware writes MODE register. SIE writes to the endpoint mode registers have higher priority than firmware writes. This mode register write block situation t the endpoints in incorrect modes. Firmware must read the EP1/2MODE registers immediately following a firmware write and rewrite if us read is incorrect												

Endpoint Data Buffers

The three data buffers are used to hold data for both IN and OUT transactions. Each data buffer is 8 bytes long.

The reset values of the Endpoint Data Registers are unknown.

Unlike past enCoRe parts the USB data buffers are only accessible in the I/O space of the processor.

Table 80.Endpoint 0 Data (EP0DATA) [0x50-0x57] [R/W]

Bit #	7	6	5	4	3	2	1	0						
Field		Endpoint 0 Data Buffer [7:0]												
Read/Write	R/W	R/W R/W R/W R/W R/W R/W R/W												
Default	Unknown	Unknown Unknown Unknown Unknown Unknown Unknown Unknown Unknown												
The Endpoint 0	buffer is comprised of 8 bytes located at address 0x50 to 0x57													

Table 81.Endpoint 1 Data (EP1DATA) [0x58-0x5F] [R/W]

Bit #	7	6	5	4	3	2	1	0						
Field		Endpoint 1 Data Buffer [7:0]												
Read/Write	R/W	R/W R/W R/W R/W R/W R/W R/W												
Default	Unknown	Unknown Unknown Unknown Unknown Unknown Unknown Unknown Unknown												
The Endpoint 1	Ibuffer is comprised of 8 bytes located at address 0x58 to 0x5F													



Table 82.Endpoint 2 Data (EP2DATA) [0x60-0x67] [R/W]

Bit #	7	6	5	4	3	2	1	0					
Field		Endpoint 2 Data Buffer [7:0]											
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W					
Default	Unknown Unknown Unknown Unknown Unknown Unknown Unknown Unknown												
The Endpoint 2	It 2 buffer is comprised of 8 bytes located at address 0x60 to 0x67												

USB Mode Tables

Mode	Encoding	SETUP	IN	OUT	Comments
DISABLE	0000	Ignore	Ignore	Ignore	Ignore all USB traffic to this endpoint. Used by Data and Control endpoints
NAK IN/OUT	0001	Accept	NAK	NAK	NAK IN and OUT token. Control endpoint only
STATUS OUT ONLY	0010	Accept	STALL	Check	STALL IN and ACK zero byte OUT. Control endpoint only
STALL IN/OUT	0011	Accept	STALL	STALL	STALL IN and OUT token. Control endpoint only
STATUS IN ONLY	0110	Accept	TX0 byte	STALL	STALL OUT and send zero byte data for IN token. Control end- point only
ACK OUT – STATUS IN	1011	Accept	TX0 byte	ACK	ACK the OUT token or send zero byte data for IN token. Control endpoint only
ACK IN – STATUS OUT	1111	Accept	TX Count	Check	Respond to IN data or Status OUT. Control endpoint only
NAK OUT	1000	Ignore	Ignore	NAK	Send NAK handshake to OUT token. Data endpoint only
ACK OUT (STALL = 0)	1001	Ignore	Ignore	ACK	This mode is changed by the SIE to mode 1000 on issuance of ACK handshake to an OUT. Data endpoint only
ACK OUT (STALL = 1)	1001	Ignore	Ignore	STALL	STALL the OUT transfer
NAK IN	1100	Ignore	NAK	Ignore	Send NAK handshake for IN token. Data endpoint only
ACK IN (STALL = 0)	1101	Ignore	TX Count	Ignore	This mode is changed by the SIE to mode 1100 after receiving ACK handshake to an IN data. Data endpoint only
ACK IN (STALL = 1)	1101	Ignore	STALL	Ignore	STALL the IN transfer. Data endpoint only
Reserved	0101	Ignore	Ignore	Ignore	These modes are not supported by SIE. Firmware should not use this mode in Control and Data endpoints
Reserved	0111	Ignore	Ignore	Ignore	
Reserved	1010	Ignore	Ignore	Ignore	
Reserved	0100	Ignore	Ignore	Ignore]
Reserved	1110	Ignore	Ignore	Ignore	1

Mode Column

The 'Mode' column contains the mnemonic names given to the modes of the endpoint. The mode of the endpoint is determined by the four-bit binaries in the 'Encoding' column as discussed in the following section. The Status IN and Status OUT represent the status IN or OUT stage of the control transfer.

Encoding Column

The contents of the 'Encoding' column represent the Mode Bits [3:0] of the Endpoint Mode Registers (Table 78 and Table 79). The endpoint modes determine how the SIE responds to different tokens that the host sends to the endpoints. For example, if the Mode Bits [3:0] of the Endpoint 0 Mode Register are set to '0001', which is NAK IN/OUT mode, the SIE will send an ACK handshake in response to SETUP tokens and NAK any IN or OUT tokens.

SETUP, IN, and OUT Columns

Depending on the mode specified in the 'Encoding' column, the 'SETUP', 'IN', and 'OUT' columns contain the SIE's responses when the endpoint receives SETUP, IN, and OUT tokens, respectively.

A 'Check' in the Out column means that upon receiving an OUT token the SIE checks to see whether the OUT is of zero length and has a Data Toggle (Data1/0) of 1. If these conditions are true, the SIE responds with an ACK. If any of the above conditions is not met, the SIE will respond with either a STALL or Ignore.

A 'TX Count' entry in the IN column means that the SIE will transmit the number of bytes specified in the Byte Count Bit [3:0] of the Endpoint Count Register (Table 77) in response to any IN token.



Details of Mode for Differing Traffic Conditions

Contr	rol Endp	oint														
SIE		Bus Ev	ent		SIE	EF	PO I	Nod	le R	egister	EP0 C	Count Re	egister	EP0	Interrupt	Comments
Mode	Token	Count	Dval	D0/1	Response	S	I	0	Α	MODE	DTOG	DVAL	COUNT	FIFO		
DISA	BLED								•		•				•	•
0000	х	х	х	х												Ignore All
STALL	_IN_OUT															1
0011	SETUP	>10	х	х				İ			l		1	junk	İ	Ignore
0011	SETUP	<=10	invalid	х										junk		Ignore
0011	SETUP	<=10	valid	х	ACK	1			1	0001	update	1	update	data	Yes	ACK SETUP
0011	IN	х	х	х	STALL											Stall IN
0011	OUT	>10	х	х												Ignore
0011	OUT	<=10	invalid	х												Ignore
0011	OUT	<=10	valid	х	STALL											Stall OUT
NAK_IN	N_OUT										1					I
0001	SETUP	>10	х	Х										junk		Ignore
0001	SETUP	<=10	invalid	х										junk		Ignore
0001	SETUP	<=10	valid	х	ACK	1			1	0001	update	1	update	data	Yes	ACK SETUP
0001	IN	х	х	х	NAK											NAK IN
0001	OUT	>10	х	х												Ignore
0001	OUT	<=10	invalid	х												Ignore
0001	OUT	<=10	valid	х	NAK											NAK OUT
ACK_I	N_STATU	S_OUT						I	1	1	I		1			
1111	SETUP	>10	х	х										junk		Ignore
1111	SETUP	<=10	invalid	х										junk		Ignore
1111	SETUP	<=10	valid	х	ACK	1			1	0001	update	1	update	data	Yes	ACK SETUP
1111	IN	х	х	х	ТХ											Host Not ACK'd
1111	IN	х	х	х	ТХ		1		1	0001					Yes	Host ACK'd
1111	OUT	>10	х	х												Ignore
1111	OUT	<=10	invalid	х												Ignore
1111	OUT	<=10, <>2	valid	х	STALL					0011					Yes	Bad Status
1111	OUT	2	valid	0	STALL					0011					Yes	Bad Status
1111	OUT	2	valid	1	ACK			1	1	0010	1	1	2		Yes	Good Status
STATU								I						l		
0010	SETUP	>10	x	х										junk		Ignore
0010	SETUP	<=10	invalid	х										junk		Ignore
0010	SETUP	<=10	valid	х	ACK	1			1	0001	update	1	update	data	Yes	ACK SETUP
0010	IN	х	x	х	STALL					0011	•				Yes	Stall IN
0010	OUT	>10	x	х												Ignore
0010	OUT	<=10	invalid	x												Ignore
0010	OUT	<=10, <>2	valid	x	STALL					0011			1		Yes	Bad Status
0010	OUT	2	valid	0	STALL					0011					Yes	Bad Status
0010	OUT	2	valid	1	ACK	-	-	1	1		1	1	2		Yes	Good Status
	OUT_STAT							l .		I				I		- oou claido
1011	SETUP	>10	х	x		1	1	1					1	junk	I	Ignore
1011	SETUP	<=10	invalid	x										junk		Ignore
1011	SETUP	<=10 <=10	valid	x	ACK	1			1	0001	update	1	update	data	Yes	ACK SETUP
1011	IN	x	X	x	TX 0	ŀ	-		H		apaato		-poulo	Juliu		Host Not ACK'd
1011		~	~	^	17.0		<u> </u>	I					I	l		- ISSUNDLAGING



Dotai											u)		1		1	r
1011	IN	х	х	х	TX 0		1		1	0011					Yes	Host ACK'd
1011	OUT	>10	х	х										junk		Ignore
1011	OUT	<=10	invalid	х										junk		Ignore
1011	OUT	<=10	valid	х	ACK			1	1	0001	update	1	update	data	Yes	Good OUT
STATU	S_IN															
0110	SETUP	>10	х	х										junk		Ignore
0110	SETUP	<=10	invalid	х										junk		Ignore
0110	SETUP	<=10	valid	х	ACK	1			1	0001	update	1	update	data	Yes	ACK SETUP
0110	IN	х	х	х	TX 0											Host Not ACK'd
0110	IN	х	х	х	TX 0		1		1	0011					Yes	Host ACK'd
0110	OUT	>10	х	х												Ignore
0110	OUT	<=10	invalid	х												Ignore
0110	OUT	<=10	valid	х	STALL					0011					Yes	Stall OUT
Data	Out End	points	•								•		•			
SIE		Bus Ev	/ent		SIE	EF	PO I	/lod	le R	legister	EP0 C	Count Re	egister	EP0	Interrupt	Comments
Mode	Token	Count	Dval	D0/1	Response	S	I	0	Α	MODE	DTOG	DVAL	COUNT	FIFO		
ACK O	UT (STAL	L Bit = 0)													J	
1001	IN	х	х	х												Ignore
1001	OUT	>MAX	х	х										junk		Ignore
1001	OUT	<=MAX	invalid	invalid										junk		Ignore
1001	OUT	<=MAX	valid	valid	ACK				1	1000	update	1	update	data	Yes	ACK OUT
ACK O	UT (STAL	L Bit = 1)	1								1					I
1001	IN	х	х	х												Ignore
1001	OUT	>MAX	х	х												Ignore
1001	OUT	<=MAX	invalid	invalid												Ignore
1001	OUT	<=MAX	valid	valid	STALL											Stall OUT
NAK O	UT		•								•					
1000	IN	х	х	х												Ignore
1000	OUT	>MAX	х	х												Ignore
1000	OUT	<=MAX	invalid	invalid												Ignore
1000	OUT	<=MAX	valid	valid	NAK										If Enabled	NAK OUT
Data	In Endpo	oints		•	•					•		•	•		•	•
SIE		Bus Ev	/ent		SIE	EF	PO I	/lod	le R	legister	EP0 C	Count Re	egister	EP0	Interrupt	Comments
Mode	Token	Count	Dval	D0/1	Response	S	I	0	Α	MODE	DTOG	DVAL	COUNT	FIFO		
ACK IN	(STALL	Bit = 0)													J	
1101		х	х	х												Ignore
	OUT			~												
1101	IN	х	х	x												Host Not ACK'd
1101 1101		x x			ТХ				1	1100					Yes	Host Not ACK'd Host ACK'd
1101	IN	Х	x	х	ТХ				1	1100					Yes	
1101	IN IN	Х	x	х	ТХ				1	1100					Yes	
1101 ACK IN	IN IN ISTALL	× Bit = 1)	x x	x x	TX				1	1100					Yes	Host ACK'd
1101 ACK IN 1101	IN IN IN IN IN	× Bit = 1) ×	x x x	x x x					1	1100					Yes	Host ACK'd Ignore
1101 ACK IN 1101 1101	IN IN IN IN IN	× Bit = 1) ×	x x x	x x x					1	1100					Yes	Host ACK'd Ignore

Details of Mode for Differing Traffic Conditions (continued)



Register Summary

Addr	Name	7	6	5	4	3	2	1	0	R/W	Default
00	PODATA	P0.7	Reserved	Reserved	P0.4/INT2	P0.3/INT1	P0.2/INT0	Reserved	Reserved	bbbb	00000000
01	P1DATA	P1.7	P1.6/SMI SO	P1.5/SMO SI	P1.4/SCLK	P1.3/SSEL	P1.2/VREG	P1.1/D-	P1.0/D+	bbbbbbbb	00000000
02	P2DATA		•		Res			P2.1-	-P2.0	bbbbbbbb	00000000
07–09	P02CR- P04CR	Reserved	Reserved	Int Act Low	TTL Thresh	Reserved	Open Drain	Pull-up Enable	Output Enable	bbbbbb	00000000
0C	P07CR	Reserved	Int Enable	Int Act Low	TTL Thresh	Reserved	Open Drain	Pull-up Enable	Output Enable	-ppppppp	00000000
0D	P10CR	Reserved	Int Enable	Int Act Low		Reserved		Reserved	Output Enable	-bbb	0000000
0E	P11CR	Reserved	Int Enable	Int Act Low	Rese	erved	Open Drain	Reserved	Output Enable	-bbb-b	00000000
0F	P12CR	CLK Output	Int Enable	Int Act Low	TTL Thresh	Reserved	Open Drain	Pull-up Enable	Output Enable	bbbbbbbb	0000000
10	P13CR	Reserved	Int Enable	Int Act Low	3.3V Drive	High Sink	Open Drain	Pull-up Enable	Output Enable	-ppppppp	0000000
11–13	P14CR- P16CR	SPI Use	Int Enable	Int Act Low	3.3V Drive	High Sink	Open Drain	Pull-up Enable	Output Enable	bbbbbbbb	00000000
14	P17CR	Reserved	Int Enable	Int Act Low	TTL Thresh	High Sink	Open Drain	Pull-up Enable	Output Enable	-bbbbbbb	0000000
15	P2CR	Reserved	Int Enable	Int Act Low	TTL Thresh	Reserved	Open Drain	Pull-up Enable	Output Enable	-ppppppp	0000000
20	FRTMRL				Free-Runr	ning Timer [7:	0]			bbbbbbbb	0000000
21	FRTMRH				Free-Runn	ing Timer [15	:8]			bbbbbbbb	0000000
26	PITMRL				Prog Inter	val Timer [7:	0]			bbbbbbbb	0000000
27	PITMRH		Res	erved			Prog Interval	Timer [11:8]		bbbb	0000000
28	PIRL				Prog Ir	g Interval [7:0]				bbbbbbbb	0000000
29	PIRH		Res	erved		Prog Interval [11:8]				bbbb	0000000
30	CPUCLKCR	Reserved	USB CLK/2 Disable	USB CLK Select		Res	erved		CPU CLK Select	-bbb	00010000
31	ITMRCLKCR	TCAPCL	K Divider	TCAPC	LK Select	ITMRCLK Divider ITMRCLK Select				bbbbbbbb	10001111
32	CLKIOCR		Reserved			Reserved		CLKOU	T Select	bbbbb	0000000
34	IOSCTR		foffset[2:0]				Gain[4:0]			bbbbbbbb	000ddddd
35	XOSCTR		Reserved			Reserved		Reserved	Mode	bbb-b	000ddd0d
36	LPOSCTR	32-KHz Low Power	Reserved	32-KHz Bi	as Trim [1:0]		32-KHz Fred			b-bbbbbb	ddddddd
39	OSCLCKCR		1	R	eserved			Fine Tune Only	USB Osclock Disable	bb	00000000
3C	SPIDATA				SPI	Data[7:0]				bbbbbbbb	0000000
3D	SPICR	Swap	LSB First	Comr	n Mode	CPOL	CPHA	SCLK	Select	bbbbbbbb	00000000
40	USBCR	USB Enable			De	evice Addres	s[6:0]			bbbbbbbb	0000000
41	EP0CNT	Data Toggle	Data Valid	Res	erved		Byte Cou	unt[3:0]		bbbbbbbb	00000000
42	EP1CNT	Data Toggle	Data Valid	Res	erved		Byte Cou	unt[3:0]		bbbbbbbb	00000000
43	EP2CNT	Data Toggle	Data Valid		erved		Byte Cou	unt[3:0]		bbbbbbbb	00000000
44	EP0MODE	Setup rcv'd	IN rcv'd		ACK'd trans		Mode			ccccbbbb	00000000
45	EP1MODE	Stall	Reserved	NAK Int Enable	Ack'd trans		Mode			b-bcbbbb	0000000
46	EP2MODE	Stall	Reserved	NAK Int Enable	Ack'd trans		Mode	[3:0]		b-bcbbbb	0000000
50–57	EP0DATA					Data Buffer [7	,			bbbbbbbb	????????
58–5F	EP1DATA				Endpoint 1	Data Buffer [7	7:0]			bbbbbbbb	????????
					-	int 2 Data Buffer [7:0]				bbbbbbbb	????????



Register Summary (continued)

Addr	Name	7	6	5	4	3	2	1	0	R/W	Default
73	VREGCR			R	eserved	•		Keep Alive	VREG Enable	bb	00000000
74	USBXCR	USB Pull-up Enable			Re	served			USB Force State	bb	00000000
DA	INT_CLR0	GPIO Port 1	Sleep Timer	INT1	GPIO Port 0	SPI Receive	SPI Transmit	INT0	POR/LVD	bbbbbbbb	00000000
DB	INT_CLR1	Reserved	Prog Interval Timer	1-ms Timer	USB Active	USB Reset	USB EP2	USB EP1	USB EP0	-bbbbbbb	00000000
DC	INT_CLR2	Reserved	Reserved	Reserved	GPIO Port 2	Reserved	INT2	16-bit Counter Wrap	Reserved	-bbbbbb-	00000000
DE	INT_MSK3	ENSWINT				Reserved				b	00000000
DF	INT_MSK2	Reserved	Reserved	Reserved	GPIO Port 2 Int Enable	Reserved	INT2 Int Enable	16-bit Counter Wrap Int Enable	Reserved	bbbb-	0000000
E1	INT_MSK1	Reserved	Prog Interval Timer Int Enable	1-ms Timer Int Enable	USB Active Int Enable	USB Reset Int Enable	USB EP2 Int Enable	USB EP1 Int Enable	USB EP0 Int Enable	bbbbbbbb	0000000
E0	INT_MSK0	GPIO Port 1 Int Enable	Sleep Timer Int Enable	INT1 Int Enable	GPIO Port 0 Int Enable	SPI Receive Int Enable	SPI Transmit Int Enable	INT0 Int Enable	POR/LVD Int Enable	bbbbbbbb	00000000
E2	INT_VC				Pending	Interrupt [7:0]			bbbbbbbb	00000000
E3	RESWDT				Reset Watc	hdog Timer [7:0]			wwwwwww	00000000
	CPU_A				Temporary	Register T1 [7:0]				00000000
	CPU_X)	×[7:0]					00000000
	CPU_PCL				Program	Counter [7:0]				00000000
	CPU_PCH				Program	Counter [15:8	3]				0000000
	CPU_SP				Stack F	Pointer [7:0]					00000000
-	CPU_F		Reserved		XOI	Super	Super Carry Zero Global IE			brwww	00000010
FF	CPU_SCR	GIES	Reserved	WDRS	PORS	Sleep	Reserved	Reserved	Stop	r-ccbb	00010000
1E0	OSC_CR0	Res	erved	No Buzz	Sleep Ti	mer [1:0]	CP	U Speed [2:	0]	bbbbbb	00000000
1E3	LVDCR	Res	erved	PORL	EV[1:0]	EV[1:0] Reserved VM[2:0]				bb-bbbb	00000000
1EB	ECO_TR	Sleep Duty	Cycle [1:0]			Res	erved			bb	0000000
1E4	VLTCMP			R	eserved			LVD	PPOR	rr	0000000

 LEGEND

 In the R/W column,

 b = Both Read and Write

 r = Read Only

 w = Write Only

 c = Read/Clear

 ? = Unknown

 d = calibration value. Should not change during normal use



Radio Function Register Descriptions

All registers are read and writeable, except where noted. Registers may be written to or read from either individually or in sequential groups. A single-byte read or write reads or writes from the addressed register. Incrementing burst read and write is a sequence that begins with an address, and then reads or writes to/from each register in address order for as long as clocking continues. It is possible to repeatedly read (poll) a single register using a non-incrementing burst read.

These registers are managed and configured over SPI by the user firmware running in the microcontroller function.

Table 83.Register Map Summary

Address	Mnemonic	b7	b6	b5	b4	b3	b2	b1	b0	Default ^[4]	Access ^[4]
0x00	CHANNEL_ADR	Not Used				Channel				-1001000	-bbbbbbbb
0x01	TX_LENGTH_ADR				TX I	_ength				00000000	bbbbbbbb
0x02	TX_CTRL_ADR	TX GO	TX CLR	TXB15 IRQEN	TXB8 IRQEN	TXB0 IRQEN	TXBERR IRQEN	TXC IRQEN	TXE IRQEN	00000011	bbbbbbbb
0x03	TX_CFG_ADR	Not Used	Not Used	DATA CODE LENGTH		MODE		PA SETTING		000101	bbbbbb
0x04	TX_IRQ_STATUS_ADR	OS IRQ	LV IRQ	TXB15 IRQ	TXB8 IRQ	TXB0 IRQ	TXBERR IRQ	TXC IRQ	TXE IRQ	10111000	rrrrrrr
0x05	RX_CTRL_ADR	RX GO	RSVD	RXB16 IRQEN	RXB8 IRQEN	RXB1 IRQEN	RXBERR IRQEN	RXC IRQEN	RXE IRQEN	00000111	bbbbbbbb
0x06	RX_CFG_ADR	AGC EN	LNA	ATT	HILO	FASTTURN EN	Not Used	RXOW EN	VLD EN	10010-10	bbbbb-bb
0x07	RX_IRQ_STATUS_ADR	RXOW IRQ	SOFDET IRQ	RXB16 IRQ	RXB8 IRQ	RXB1 IRQ	RXBERR IRQ	RXC IRQ	RXE IRQ	00000000	brrrrrr
0x08	RX_STATUS_ADR	RX ACK	PKT ERR	EOP ERR	CRC0	Bad CRC	RX Code	RX Dat	a Mode	00001	rrrrrrr
0x09	RX_COUNT_ADR					Count				00000000	rrrrrrr
0x0A	RX_LENGTH_ADR					_ength				00000000	rrrrrrr
0x0B	PWR_CTRL_ADR	PMU EN	LVIRQ EN	PMU MODE FORCE	Not Used		I TH	-	OUTV	10100000	bbb-bbbb
0x0C	XTAL_CTRL_ADR		JT FN	XSIRQ EN	Not Used	Not Used		FREQ	-	000100	bbbbbb
0x0D	IO_CFG_ADR	IRQ OD	IRQ POL	MISO OD	XOUT OD	PACTL OD	PACTL GPIO	SPI 3PIN	IRQ GPIO	00000000	bbbbbbbb
0x0E	GPIO_CTRL_ADR	XOUT OP	MISO OP	PACTL OP	IRQ OP	XOUT IP	MISO IP	PACTL IP	IRQ IP	0000	bbbbrrrr
0x0F	XACT_CFG_ADR	ACK EN	Not Used	FRC END		END STATE		ACł	КТО	1-000000	b-bbbbbb
0x10	FRAMING_CFG_ADR	SOP EN	SOP LEN	LEN EN			SOP TH			10100101	bbbbbbbb
0x11	DATA32_THOLD_ADR	Not Used	Not Used	Not Used	Not Used		TH32			0100	bbbb
0x12	DATA64_THOLD_ADR	Not Used	Not Used	Not Used	TH64					01010	bbbbb
0x13	RSSI_ADR	SOP	Not Used	LNA	RSSI					0-100000	r-rrrrr
0x14	EOP_CTRL_ADR	HEN		HINT			E	EOP		10100100	bbbbbbbb
0x15	CRC_SEED_LSB_ADR				CRC SEED LSB					00000000	bbbbbbbb
0x16	CRC_SEED_MSB_ADR				CRC SEED MSB					00000000	bbbbbbbb
0x17	TX_CRC_LSB_ADR				CR	CLSB					rrrrrrr
0x18	TX_CRC_MSB_ADR				CRO	CMSB					rrrrrrr
0x19	RX_CRC_LSB_ADR				CR	CLSB				11111111	rrrrrrr
0x1A	RX_CRC_MSB_ADR				CRO	CMSB				11111111	rrrrrrr
0x1B	TX OFFSET LSB ADR					IM LSB				00000000	bbbbbbbb
0x1C	TX_OFFSET_MSB_ADR	Not Used	Not Used	Not Used	Not Used	-	STR	IM MSB		0000	bbbb
0x1D	MODE OVERRIDE ADR	RSVD	RSVD	FRC SEN	FRC	WAKE	Not Used	Not Used	RST	000000	wwwwww
0x1E	RX_OVERRIDE_ADR	ACK RX	RXTX DLY	MAN RXACK	FRC RXDR	DIS CRC0	DIS RXCRC	ACE	Not Used	0000000-	bbbbbbb-
0x1F	TX_OVERRIDE_ADR	ACK TX	FRC PRE	RSVD	MAN TXACK	OVRD ACK	DIS TXCRC	RSVD	TX INV	00000000	bbbbbbbb
0x27	CLK_OVERRIDE_ADR	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RXF	RSVD	00000000	wwwwwww
0x28	CLK_EN_ADR	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RXF	RSVD	00000000	wwwwwww
0x29	RX_ABORT_ADR	RSVD	RSVD	ABORT EN	RSVD	RSVD	RSVD	RSVD	RSVD	00000000	wwwwwww
0x32	AUTO_CAL_TIME_ADR			•	AUTO_CAI	TIME_MAX	•			00000011	wwwwwww
0x35	AUTO_CAL_OFFSET_ADR			AL	ITO_CAL_OI	FSET_MINU	S_4			00000000	wwwwwww
0x39	ANALOG_CTRL_ADR	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	ALL SLOW	00000000	wwwwwww
Register Fi	iles										
0x20	TX_BUFFER_ADR				TX Bi	uffer File					wwwwwww
0x21	RX_BUFFER_ADR				RX Buffer File						rrrrrrr
0x22	SOP_CODE_ADR				SOP Code File					Note 5	bbbbbbbb
0x23	DATA CODE ADR					ode File				Note 6	bbbbbbbb
-										Note 7	bbbbbbbb
0x24	PREAMBLE ADR				Preamble File						
0x24 0x25	PREAMBLE_ADR MFG ID ADR					ID File				NOUL /	rrrrrrr

A. b = read/write, r = read only, w = write only, - = not used, default value is undefined.
5. SOP_CODE_ADR default = 0x17FF9E213690C782.
6. DATA_CODE_ADR default = 0x02F9939702FA5CE3012BF1DB0132BE6F.
7. PREAMBLE_ADR default = 0x333302.



Mnemonic		C	HANNEL_ADR				Address	0x00
Bit	7	6	5	4	3	2	1	0
Default	-	1	0	0	1	0	0	0
Read/Write	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Function	Not Used		1		Channel			
tin fast (100-μs) - 0 medium (180-μs)	ne it takes the sy 3 6 9 12 15 18 2) - 2 4 8 10 14 10 5 7 11 13 17 19 subject to regul	vnthesizer to se 21 24 27 30 33 6 20 22 26 28 3 9 23 25 29 31 3 ation.	ttle. 36 39 42 45 48 5 32 34 38 40 44 46 5 35 37 41 43 47	1 54 57 60 63 50 52 56 58 6	66 69 72 96 52 64 68 70 74 7	76 78 80 82 84	to this register wi 86 88 90 92 94 35 87 89 91 93 95	·

Mnemonic			TX_L	ENGTH_ADR		Address	0x01		
Bit		7	6	5	4	3	2	1	0
Default		0	0	0	0	0	0	0	0
Read/Write		R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Function					TX L	ength	•	• • • •	
Bits 7:0 Maximum pac	ano ten for	d CRC16 fields after transmiss all packets is 40	(if enabled), but	no data field. P t has begun. Ty or framed 64-ch	acket lengths o pically, length is ip DDR where t	f more than 16 updated prior the maximum p	bytes will requir to setting TX GC acket length is		bytes be writ-

Mnemonio	;	т	X_CTRL_ADR				Address	0x02
Bit	7	6	5	4	3	2	1	0
Default	0	0	0	0	0	0	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Function	TX GO	TX CLR	TXB15 IRQEN	TXB8 IRQEN	TXB0 IRQEN	TXBERR IRQEN	TXC IRQEN	TXE IRQEN
Bit 7	Start Transmissio automatically at th is loaded after set the length of the S channel in 8DR m length) + 32 µs (le TXBERR IRQ will	ne end of packet titing this bit, the SOP code, the le node with 32-chip ength byte) = 22	transmission. T length of time a ength of preamb o SOP codes the	The transmit buff vailable to load le, and the pack e time available	fer may be load the buffer depen tet data rate. Fo is 100 μs (syntl	ed either before nds on the start r example, if sta h start) + 32 μs	e or after setting ing state (sleep, arting from idle r (preamble) + 64	this bit. If data idle or synth), node on a fast μs (SOP
Bit 6	Clear TX Buffer. W may be retransmi setting this bit if T GO bit has been s	tted by setting T X GO is set afte	X GO and not s r the new packe	etting this bit. A t is loaded to the	new transmit pa e buffer. If the T	acket may be lo X_BUFFER_AD	aded and transr DR is to be loade	nitted without ed after the TX
Bit 5	Buffer Not Full Int	errupt Enable. S	ee TX_IRQ_ST	ATUS_ADR for	description.			
Bit 4	Buffer Half Empty	Interrupt Enable	e. See TX_IRQ_	_STATUS_ADR	for description.			
Bit 3	Buffer Empty Inte	rrupt Enable. Se	e TX_IRQ_STA	TUS_ADR for d	escription.			
Bit 2	Buffer Error Interr	upt Enable. See	TX_IRQ_STAT	US_ADR for de	scription.			
Bit 1	Transmission Cor set together.	nplete Interrupt	Enable. See TX	_IRQ_STATUS_	_ADR for descri	ption. TXC IRQ	EN and TXE IR	QEN must be
Bit 0	Transmit Error Int together.	errupt Enable. S	ee TX_IRQ_ST	ATUS_ADR for	description. TX	C IRQEN and T	XE IRQEN mus	t be set



Mnemonic			-	TX_CFG_ADR		Address	0x03			
Bit	7		6	5	4	3	2	1	0	
Default		-	-	0	0	0	1	0	1	
Read/Write		-	-	R/W	R/W	R/W	R/W	R/W	R/W	
Function		Not Used	Not Used	Data Code Length	Data	Mode		PA Setting		
Bit 5		ata Code Length		0	_	_		n of the packet. T	his bit is	
Bits 4:3						• •	,	= DDR Mode, 11 = using GFSK data		
Bits 2:0		Setting. This fie = –5 dBm, 6 = 0		0	ngth. 0 = -30 dB	Bm, 1 = −25 dBr	m, 2 = −20 dBm	ı, 3 = −15 dBm, 4	= −10 dBm,	

Mnemonic		TX_IRQ_	STATUS_ADR				Address	0x04
Bit	7	6	5	4	3	2	1	0
Default	1	0	1	1	1	0	0	0
Read/Write	R	R	R	R	R	R	R	R
Function	OS IRQ	LV IRQ	TXB15 IRQ	TXB8 IRQ	TXB0 IRQ	TXBERR IRQ	TXC IRQ	TXE IRQ
whenever one of may change val termination of a Bit 7 C Bit 6 L Bit 5 B Bit 4 B Bit 3 B Bit 2 B e	RQ status bits is or more bits in this ue at different tin transmission due oscillator Stable If ow Voltage Interr iterrupt is automa uffer Not Full Inter uffer Half Empty uffer Empty Interr uffer Error Interru mpty and the num nd the buffer is a	s register is set nes in response e to an exceptio RQ Status. This rupt Status. This atically disabled errupt Status. The Interrupt Status rupt Status. This nber of bytes rep	and the corresp to a single even n does not leave bit is set when bit is set when whenever the F his bit is set when . This bit is set whe s bit is set at an IRQ is triggered maining to be tra	onding IRQ ena nt). In particular, e the device in a the internal crys the voltage on N PMU is disabled enever there are whenever there y time that the t I by either of two ansmitted is great	able bit is also so , standard error an inconsistent s tal oscillator has V_{BAT} is below th . When enabled a 15 or fewer by are 8 or fewer by ransmit buffer is o events: (1) Wh ater than zero; (et. Status bits an handling is only state. s settled (synthe e LVI threshold I, this bit reflects tes remaining in bytes remaining s empty. hen the transmit 2) When a byte	re non-atomic (d effective if the p esizer sequence (see PWR_CTL the voltage on the transmit but in the transmit but buffer (TX_BUF	ifferent flags premature starts). _ADR). This V _{BAT} . ifer. puffer. FER_ADR) is
e e n te o e a T Bit 0 T tr	ransmission Corr nabled then this i nabled, this intern ay change value er returns TXC IR ccurred by exam rror in transmissi second read to t XC IRQ and TXE ransmit Error Inte ansaction mode. lears this bit.	interrupt is triggered at different time Q = 1 and TXE ining the status on. If the first re- his register for a E IRQ. errupt Status. Th	ered immediate at the end of a es in response to IRQ = 0 then fir of TXE. There c ad of this registe given transacti	ly after transmis transaction. Rea to a single event mware must ex can be a case w er returns TXC I on. If an ACK is red when there	asion of the last ading this regist. If transaction r ecute a second hen this bit is no RQ = 1 and TXI received RXC I is an error in tra	bit of the CRC1 er clears this bit node is enabled read to this reg of triggered whe E IRQ = 1 then t IRQ and RXE IR	6. If transaction . TXC IRQ and ⁻ and the first rea ister to determin n ACK EN = 1 a the firmware mu Q may be asset interrupt is only	mode is TXE IRQ flags ad of this regis- ie if an error nd there is an st not execute rted instead of applicable to



Mnemonic		R	X_CTRL_ADR				Address	0x05
Bit	7	6	5	4	3	2	1	0
Default	0	0	0	0	0	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Function	RX GO	RSVD	RXB16 IRQEN	RXB8 IRQEN	RXB1 IRQEN	RXBERR IRQEN	RXC IRQEN	RXE IRQEN
Bit 7 Bit 6 Bit 5 Bit 4 Bit 3	Start Receive. Se will start automati recommended m RX_COUNT_ADI RX_ABORT_ADF Start of Packet D Buffer Full Interru Buffer Half Empty Buffer Not Empty	ically after this bi ethod to exit rec R bytes from RX R for description etect Interrupt E pt Enable. See / Interrupt Enabl	t is set. Firmwar eive mode wher _BUFFER_ADF nable. See RX_ RX_IRQ_STATL e. See RX_IRQ	e must never clo a an error has oc R or poll RSSI_A IRQ_STATUS_A JS_ADR for des _STATUS_ADR	ear this bit. This ccurred is to ford \DR.SOP (bit 7) \DR for descript cription. for description.	bit must not be ce END STATE a until set. See X tion.	set until after it s and then dummy	elf clears. The read all

Mnemonic			RX_CFG_ADR				Address	0x06
Bit	7	6	5	4	3	2	1	0
Default	1	0	0	1	0	-	1	0
Read/Write	R/W	R/W	R/W	R/W	R/W	-	R/W	R/W
Function	AGC EN	LNA	ATT	HILO	FAST TURN EN	Not Used	RXOW EN	VLD EN
Status bits ar	re non-atomic (differ	ent flags may c	hange value at	different times in	n response to a	single event).		
Bit 7 Bit 6	Automatic Gain Co When this bit is cle tion. It is recomme may receive data to Low Noise Amplifi when AGC EN is s	eared the LNA is ended that this b from a device us er (LNA) Manua	s controlled mar it be disabled a sing an external al Control. Wher	nually using the nd bit 6 (LNA) b PA to transmit AGC EN (Bit 7	LNA bit. Typical e enabled unles signals at >+4 d) is cleared, this	l applications wi is the device wil Bm. is bit controls the	ill clear this bit d Il be used in a sy e state of the rec	uring initializa- vstem where it eiver LNA;
Bit 5	receive mode is sl Receive Attenuato the receiver so tha LNA is manually d	or Enable. Settin at only very stror	g this bit enable	s the receiver a	ttenuator. The re	eceiver attenuat	tor may be used	
Bit 4	HILO. When FAST selected, or the lov receiver and shou initialization.	TURN EN is s w frequency. 1 =	= hi; 0 = lo. Whe	en FAST TURN	EN is not enable	ed this also con	trols the highlow	bit to the
Bit 3	Fast Turn Mode E above the RX Syn turnaround, becau sizer resettling per bits are automatica will set this bit duri	thesizer frequer use the same sy riod between tra ally inverted to o	ncy or 1 MHz be nthesizer freque insmit and recei compensate for	elow the receive ency may be us ive. Note that w	r synthesizer fre ed for both trans hen this bit is se	equency. Use of smit and receive t, and the HILO	this mode allow e, thus eliminatin bit is cleared, re	s for very fast g the synthe- eceived data
Bit 1	Overwrite Enable. receive buffer are this bit is cleared, t SOP conditions ar from the receive b	lost, and the ne then the receive e ignored, and i	w packet is load buffer may not	ded into the rece be overwritten b	eive buffer. Whe by a new packet,	n this bit is set, and whenever	the RXOW IRQ the receive buffe	is enabled. If er is not empty
Bit 0	Valid Flag Enable. store valid flags. S		,		re only 8 bytes o	of data. The oth	er half of the buf	fer is used to



Mnemonic		RX_IRQ_	STATUS_ADR				Address	0x07			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	R/W	R	R	R	R	R	R	R			
Function	RXOW IRQ	RSVD	RXB16 IRQ	RXB8 IRQ	RXB1 IRQ	RXBERRIRQ	RXC IRQ	RXE IRQ			
whenever one may change v	II IRQ Status bits is or more bits in thi ralue at different tin a transmission dur Receive Overwrite before the previou is only possible wh may be read from	s register is set nes in response e to an exceptio e Interrupt Status is packet has be nen the RXOW	and the corresp to a single ever n does not leave s. This IRQ is tri en read from th EN bit in RX_CF	onding IRQ ena nt). In particular, e the device in a ggered when th e buffer. This bit	able bit is also s standard error an inconsistent e receive buffer t is cleared by w	et. Status bits a handling is only state. r is overwritten b vriting any value	re non-atomic (d reffective if the p by a packet bein to this register.	ifferent flags premature g received This condition			
Bit 6	Reserved. Must no		сі.								
Bit 5			s. This bit is set	whenever the r	eceive buffer is	full. and cleare	d otherwise.				
Bit 3	Receive Buffer Full Interrupt Status. This bit is set whenever the receive buffer is full, and cleared otherwise. Receive Buffer Half Full Interrupt Status. This bit is set whenever there are eight or more bytes remaining in the receive buffer. Firmware must read exactly eight bytes when reading RXB8 IRQ. It is possible, in rare cases, that the last byte of a packet may remain in the buffer even though the RXB1_IRQ flag has cleared. This can ONLY happen on the last byte of a packet and only if the packet data is being read out of the buffer while the packet is still being received. The flag is trustworthy under all other conditions, and for all bytes prior to the last. When using RXB1_IRQ and unloading the packet data during reception, the user should be sure to check the RX_COUNT_ADR value after the RXC/RXE is set and unload the last remaining byte if the number of bytes unloaded is less than the reported count, even though the RXB1_IRQ is not set Receive Buffer Not Empty Interrupt Status. This bit is set at any time that there are 1 or more bytes in the receive buffer, and cleared when the receive buffer is empty. RXB1 IRQ must not be set when RXB8 IRQ is set and vice versa.										
Bit 2	Receive Buffer En	ror Interrupt Stat ad data; (2) Wh	us. This IRQ is	triggered in one	e of two ways: (1) When the rec	eive buffer is em				
Bit 1	Receive Buffer Error Interrupt Status. This IRQ is triggered in one of two ways: (1) When the receive buffer is empty and there is an attempt to read data; (2) When the receive buffer is full and more data is received. This flag is cleared when RX GO is set and a SOP is received. Packet Receive Complete Interrupt Status. This IRQ is triggered when a packet has been received. If transaction mode is enabled, then this bit is not set until after transmission of the ACK. If transaction mode is not enabled then this bit is set as soon as a valid packet is received. This bit is cleared when this register is read. RXC IRQ and RXE IRQ flags may change value at different times in response to a single event. There are cases when this bit is not triggered when ACK EN = 1 and there is an error in reception. Therefore, firmware should examine RXC IRQ, RXE IRQ, and CRC 0 to determine receive status. If the first read of this register returns RXC IRQ = 1 and RXE IRQ = 0 then firmware must execute a second read to this register to determine if an error occurred by examining the status of RXE IRQ. If the first read of this register returns RXC IRQ = 1 and RXE IRQ = 1 then the firmware must not execute a second read to this register for a given transaction.										
Bit 0	Receive Error Inter received with a babecause the received reading RX_STAT	d CRC16, an ur ve buffer is still	nexpected EOP not empty when	is detected, a p the next packe	acket type (data t starts. The exa	a or ACK) mism	atch, or a packe	t is dropped			



Mnemonic		RX_	STATUS_ADR				Address	0x08				
Bit	7	6	5	4	3	2	1	0				
Default	0	0	0	0	1	-	-	-				
Read/Write	R	R	R	R	R	R	R	R				
Function	RX ACK PKT ERR EOP ERR		EOP ERR	CRC0	Bad CRC	RX Code	RX Data	Mode				
at different tir	that firmware does nes in response to	a single event).				,	0 ,	Ū				
Bit 7	RX Packet Type. I packet.											
Bit 6	Receive Packet Type Error. This bit is set when the packet type received is not what was expected and cleared when the packet type received was as expected. For example, if a data packet is expected and an ACK is received, this bit will be set.											
Bit 5	Unexpected EOP. received. This bit invalid bits detected	is cleared when	SOP pattern for	the next packe	t has been rece	0						
Bit 4	Zero-seed CRC16	6. This bit is set	whenever the C	RC16 of the las	t received pack	et has a zero se	ed.					
Bit 3	Bad CRC16. This	bit is set when t	he CRC16 of th	e last received	packet is incorre	ect.						
Bit 2		ceive Code Length. This bit indicates the DATA_CODE_ADR code length used in the last correctly received packet. = 64-chip code, 0 = 32-chip code.										
Bits 1:0		ceive Data Mode. These bits indicate the data mode of the last correctly received packet. 00 = 1-Mbps GFSK, 01 = 8DR, = DDR, 11 = Not Valid. These bits do not apply to unframed packets.										

Mnemonic		RX_	COUNT_ADR				Address	0x09			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	R	R	R	R	R	R	R	R			
Function		RX Count									
Bits 7:0	non-atomic (upda This register conta is complete, this re 0x00 when RX_LE	ains the total nur	nber of payload h the value in R	X_LENGTH_AD	OR unless there	e was a packet e	error. This registe	•			

Mnemonic		RX_l	ENGTH_ADR				Address	0x0A			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	R	R	R	R	R	R	R	R			
Function		RX Length									
Bits 7:0	e non-atomic (diffe This register conta detected). If there error is flagged.	ains the length fi	eld which is upd	ated with the re	ception of a ne	ew length field (s		•			



Mnemonic			PW	R_CTRL_ADR				Address	0x0B		
Bit		7	6	5	4	3 2		1	0		
Default		1	0	1	-	0	0	0	0		
Read/Write		R/W	R/W	R/W	-	R/W	R/W	R/W	R/W		
Function		PMU EN	LVIRQ EN	PMU MODE FORCE	Not Used	LVI	ТН	PMU C	DUTV		
Bit 7		wer Management Unit (PMU) Enable. Setting this bit enables the PMU if PMU Mode Force (bit 5) is set, otherwise it has no ect. See PMU Mode Force bit (bit 5) description.									
Bit 6	falls b	Low Voltage Interrupt Enable. Setting this bit enables the LV IRQ interrupt. When this interrupt is enabled, if the V _{BAT} voltage falls below the threshold set by LVI TH, then a low voltage interrupt will be generated. The LVI is not available when the device is in sleep mode. The LVI event on IRQ pin is automatically disabled whenever the PMU is disabled.									
Bit 5		PMU Mode Force. If this bit is set, the PMU operation will be based on the value of PMU Enable bit (bit 7). If this bit is not set, then the PMU is diabled when in Sleep mode and enabled when not in Sleep mode.									
Bits 3:2		-			ne voltage on V _E	_{BAT} at which the	LVI is triggered	l. 11 = 1.8V, 10 =	2.0V,		
Bits 1:0	the PM	01 = 2.2V, 00 = PMU OUTV voltage. PMU Output Voltage. This field sets the minimum output voltage of the PMU. 11 = 2.4V, 10 = 2.5V, 01 = 2.6V, 00 = 2.7V. When the PMU is active, the voltage output by the PMU on V_{REG} will never be less than this voltage, provided that the total load on the V_{REG} pin is less than the specified maximum value and the voltage in V_{BAT} is greater than the specified minimum value.									
To force the	•		le the PMU (inc To allow the chip	U 1	,.		rce the chip to a	always disable the	e PMU set bit		
The sequence	e of wri	ting the bits	in this register i	mpact the sleep	current I _{SB} .						

Mnemonic XTAL_CTRL_ADR Address 0x0C Bit 7 1 0 6 5 4 3 2 Default 0 0 0 0 0 --1 Read/Write R/W R/W R/W --R/W R/W R/W Function **XOUT FN** XSIRQ EN Not Used Not Used FREQ XOUT Pin Function. This field selects between the different functions of the XOUT pin. 00 = Clock frequency set by XOUT Bits 7:6 FREQ; 01 = Active LOW PA Control; 10 = Radio data serial bit stream. If this option is selected and SPI is configured for 3-wire mode then the MISO pin will output a serial clock associated with this data stream; 11 = GPIO. To disable this output, set to GPIO mode, and set the GPIO state in IO_CFG_ADR. Bit 5 Crystal Stable Interrupt Enable. This bit enables the OS IRQ interrupt. When enabled, this interrupt generates an IRQ event when the crystal has stabilized after the device has woken from sleep mode. This event is cleared by writing zero to this bit. XOUT Frequency. This field sets the frequency output on the XOUT pin when XOUT FN is set to 00. 0 = 12 MHz, 1 = 6 MHz, Bits 2:0 2 = 3 MHz, 3 = 1.5 MHz, 4 = 0.75 MHz; other values are not defined.



Mnemonic				IO_CFG_ADR				Address	0x0D		
Bit		7	6	5	4	3	2	1	0		
Default		0	0	0	0	0	0	0	0		
Read/Write	F	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
Function	IR	Q OD	IRQ POL	MISO OD	XOUT OD	PACTL OD	PACTL GPIO	SPI 3PIN	IRQ GPIO		
Bit 7	IRQ Pin I as a star	Drive Strendard CM	ength. Setting th OS output, with	is bit configures the output '1' di	the IRQ pin as rive voltage beir	an open drain on ng equal to the V	output. Clearing V _{IO} pin voltage.	ng output registe this bit configure	es the IRQ pin		
Bit 6		Polarity. Setting this bit configures the IRQ signal polarity to be active HIGH. Clearing this bit configures the IRQ signal ity to be active LOW.									
Bit 5		SO Pin Drive Strength. Setting this bit configures the MISO pin as an open drain output. Clearing this bit configures the SO pin as a standard CMOS output, with the output '1' drive voltage being equal to the V _{IO} pin voltage.									
Bit 4			0 0	0	•		rain output. Clea ual to the V _{IO} pi	aring this bit con in voltage.	figures the		
Bit 3							drain output. Cl qual to the V _{IO} p	earing this bit co bin voltage.	onfigures the		
Bit 2	PACTL F	Pin Functi	on. When this b	it is set the PAC	TL pin is availa	ble for use as a	GPIO.				
Bit 1		Ande. When this bit is cleared, the SPI interface acts as a standard 4-wire SPI Slave interface. When this bit is set, the SPI ace operates in '3-Wire Mode' combining MISO and MOSI on the same pin (SDAT), and the MISO pin is available as a									
Bit 0	figurable	in IRQ P	OL. When this b	oit is set, the IRC	ם pin is availabl	e for use as a G	PIO pin, and th	blarity of this IRC e IRQ function is SS signal is ina	s multiplexed		

Mnemonic		GPI	O_CTRL_ADR		0x0E			
Bit	7	6	5	4	3	2	1	0
Default	0	0	0	0	-	-	-	-
Read/Write	R/W	R/W	R/W R/W R R R		R/W	R R	R	
Function	XOUT OP	MISO OP	PACTL OP	IRQ OP	XOUT IP	MISO IP	PACTL IP	IRQ IP
To use a GP Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0	IO pin as an input, ti XOUT Output. Wh MISO Output. Wh PACTL Output. Wh IRQ Output. Wher XOUT Input. When MISO Input. When IRQ Input. When t	ten the XOUT p en the MISO pir hen the PACTL in the IRQ pin is in the XOUT pin in the MISO pin i en the PACTL p	in is configured to is configured to pin is configure configured to be is configured to s configured to in is configured	to be a GPIO, th o be a GPIO, th d to be a GPIO, e a GPIO, the st o be a GPIO, the to be a GPIO, the to be a GPIO, th	he state of this b e state of this b the state of this ate of this bit se e state of this bit state of this bit he state of this b	bit sets the output it sets the output s bit sets the output ets the output stat t reflects the volt poit reflects the voltation of reflects the voltation	ut state of the Xi t state of the Mis put state of the ate of the IRQ pi tage on the XOL age on the MISC pltage on the PA	OUT pin. SO pin. PACTL pin. n. JT pin.) pin.



Mnemonic			XA	CT_CFG_ADR				Address	0x0F		
Bit		7	6	5	4	3	2	1	0		
Default		1	-	0	0	0	0	0	0		
Read/Write		R/W	-	R/W	R/W	W R/W R/W R/W		R/W			
Function		ACK EN	Not Used	FRC END		END STATE		ACK	ТО		
Bit 7	thi tra										
Bit 5	Force End State. Setting this bit forces a transition to the state set in END STATE. By setting the desired END STATE at the same time as setting this bit the device may be forced to immediately transition from its current state to any other state. This bit is automatically cleared upon completion. Transaction End State. This field defines the mode to which the device transitions after receiving or transmitting a packet. 000										
Bits 4:2	= \$ typ wh de RX	Sleep Mode; 00 bically be set to then the device to vice can begin to KE IRQ to deterr	1 = Idle Mode; 0 000 or 001 whe ransitions to rec receiving data. I nine the status of	10 = Synth Moo n the device is t eive mode as a f the system on of the packet. If	de (TX); 011 = S transmitting pac n END STATE, ly support packet the system supp	ynth Mode (RX) kets and 100 wh the receiver mus ets <=16 bytes t	; 100 = RX Moo nen the device i st still be armed hen firmware sh 16 bytes ensure	de. In normal use s receiving pack I by setting RX G nould examine R that END STAT	e, this field will ets. Note that GO before the XC IRQ and		
Bits 1:0	pa tim is t 10	cket during which beout period is e this value multip	ch an ACK must xpressed in terr lied by 64 μs at the SOP_COE	be correctly rea ns of a number nd if SOP LEN i DE_ADR code le	ceived in order t of SOP_CODE_ s cleared then t ength. ACK_TO	o prevent a tran _ADR code leng he timeout is thi	smit error cond ths; if SOP LEN s value multiplie	riod after transm ition from being of l is set, then the t ed by 32 μ s. 00 = + Data Code Lei	detected. This imeout period = 4x, 01 = 8x,		

Mnemonic			FRAMI	IG_CFG_ADR				Address	0x10		
Bit		7	6	5	4	3	2	1	0		
Default		1	0	1	0	0	1	0	1		
Read/Write		R/W	R/W	R/W	R/W R/W R/W R/W						
Function	S	SOP EN	SOP LEN	LEN EN	SOP TH						
Bit 7	SOP Enable. When this bit is set, each transmitted packet begins with a SOP field, and only packets beginning with a valid SOP field will be received. If this bit is cleared, no SOP field will be generated when a packet is transmitted, and packet reception will begin whenever two successive correlations against the DATA_CODE_ADR code are detected. SOP PN Code Length. When this bit is set the SOP_CODE_ADR code length is 64 chips. When this bit is cleared the										
Bit 6	SOP PN Code Length. When this bit is set the SOP_CODE_ADR code length is 64 chips. When this bit is cleared the SOP_CODE_ADR code length is 32 chips.										
Bit 5	SOP fie bit is cle	5 1 5 1									
Bits 4:0	is a thre fields. T When S	SOP Correlator Threshold. This is the receive data correlator threshold used when attempting to detect a SOP symbol. There is a threshold for the SOP_CODE_ADR code. This (single) threshold is applied independently to each of SOP1 and SOP2 fields. There are then two thresholds for each of the 64-chip DATA_CODE_ADR codes and 32-chip DATA_CODE_ADR codes. When SOP LEN is set, all 5 bits of this field are used. When SOP LEN is cleared, the most significant bit is disregarded. Typical applications configure SOP TH = 04h for SOP32 and SOP TH = 0Eh for SOP64.									



Mnemonic		DATA32	_THOLD_ADR				Address	0x11	
Bit	7	6	5	4	3	2	1	0	
Default	-	-	-	-	0	1	0	0	
Read/Write	-	-	-	-	R/W	R/W	R/W	R/W	
Function	Not Used	Not Used	Not Used	Not Used	TH32				
	32-chip Data PN Code Correlator Threshold. This register sets the correlator threshold used in DSSS modes when DATA CODE LENGTH (see TX_CFG_ADR) is set to 32. Typical applications configure TH32 = 05h.								

Mnemonic		DATA64	_THOLD_ADR				Address	0x12	
Bit	7	6	5	4	3	2	1	0	
Default	-	-	-	0	1	0	1	0	
Read/Write	-	-	-	R/W	R/W	R/W	R/W	R/W	
Function	Not Used	Not Used	Not Used			TH64			
Bits 4:0	4 Chip Data PN Code Correlator Threshold. This register sets the correlator threshold used in DSSS modes when the DATA CODE LENGTH (see TX_CFG_ADR) is set to 64. Typical applications configure TH64 = 0Eh.								

Mnemonic			RSSI_ADR				Address	0x13
Bit	7	6	5	4	3	2	1	0
Default	0	-	1	0	0	0	0	0
Read/Write	R	-	R	R	R	R	R	R
Function	SOP	Not Used	ΙΝΑ		•	RSSI		

A Received Signal Strength Indicator (RSSI) reading is taken automatically when an SOP symbol is detected. In addition, an RSSI reading is taken whenever RSSI_ADR is read. The contents of this register are not valid after the device is configured for receive mode until either a SOP symbol is detected, or the register is read. The conversion can occur as often as once every 12 µs.

To measure the background RF signal strength on a channel before a packet has been received, the MCU should perform a 'dummy' read of this register, the results of which should be discarded. This 'dummy' read will cause an RSSI measurement to be taken, and therefore subsequent readings of the register will yield valid data.

Bit 7 SOP RSSI Reading. When set, this bit indicates that the reading in the RSSI field was taken when a SOP symbol was detected. When cleared, this bit indicates that the reading stored in the RSSI field was triggered by a previous SPI read of this register.

Bit 5 LNA State. This bit indicates the LNA state when the RSSI reading was taken. When cleared, this bit indicates that the LNA was disabled when the RSSI reading was taken; if set, this bit indicates that the LNA was enabled when the RSSI reading was taken.

Bits 4:0 RSSI Reading. This field indicates the instantaneous strength of the RF signal being received at the time that the RSSI reading was taken. A larger value indicates a stronger signal. The signal strength measured is for the RF signal on the configured channel, and is measured after the LNA stage.



Mnemonic		EO	P_CTRL_ADR				Address	0x14	
Bit	7	6	5	4	3	2	1	0	
Default	1	0	1	0	0	1	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W R/W R/W R/W			
Function	HEN	HINT EOP							
	bit is set, then the of packet) condition EOP Hint Enable. symbol periods se bytes. Use of this dition.	n is detected. When set, this l et by the HINT fi	bit will cause an eld and the last	EOP to be dete two received by	ected if no corre	elations have be calculated CRC1	en detected for t 6 for all previous	he number of sly received	
Bits 6:4 Bits 4:0	EOP Hint Symbol Count. The minimum number of symbols of consecutive non-correlations at which the last two bytes are checked against the calculated CRC16 to detect an EOP condition. EOP Symbol Count. An EOP condition is deemed to exist when the number of consecutive non-correlations is detected.								

Mnemonic		CRC_SE	ED_LSB_ADR		Address							
Bit	7	6	5	4	3	2	1	0				
Default	0	0	0	0	0	0	0	0				
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W				
Function	1			CRC SE	ED LSB	•						
use a randomly s transmitter/receiv	selected CRC16 ver are using the	CRC SEED LSB allows different devices to generate or recognize different CRC16s for the same payload data. If a transmitter and receiver lected CRC16 seed, the probability of correctly receiving data intended for a different receiver is 1/65535, even if the other r are using the same SOP_CODE_ADR codes and channel. C16 Seed Least Significant Byte. The LSB of the starting value of the CRC16 calculation.										

Mnemonic		CRC_SEE	ED_MSB_ADR				Address	0x16			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Function		CRC SEED MSB									
Bits 7:0 CF	RC16 Seed Most Significant Byte. The MSB of the starting value of the CRC16 calculation.										

Mnemonic		TX_CI	RC_LSB_ADR		0x17						
Bit	7	6	5	4	3	2	1	0			
Default	-	-	-	-	-	-	-	-			
Read/Write	R	R R R R R R R									
Function				TX CR	C LSB						
		eulated CRC16 LSB. The LSB of the CRC16 that was calculated for the last transmitted packet. This value is only valid after set transmission is complete.									



Mnemonic		TX_CF	RC_MSB_ADR	Address				0x18		
Bit	7	6	5	4	3	2	1	0		
Default	-	-	-	-	-	-	-	-		
Read/Write	R	R R R R R R R								
Function		TX CRC MSB								
		sulated CRC16 MSB. The MSB of the CRC16 that was calculated for the last transmitted packet. This value is only valid packet transmission is complete.								

Mnemonic		RX_CI	RC_LSB_ADR		Address				
Bit	7	6	5	4	3	2	1	0	
Default	1	1	1	1	1	1	1	1	
Read/Write	R	R R R R R R F							
Function		•		RX CR	C LSB				
	Received CRC16 eld matched the				received packet	t. This value is v	alid whether or r	not the CRC16	

Mnemonic		RX_CF	RC_MSB_ADR				Address	0x1A			
Bit	7	6	5	4	3	2	1	0			
Default	1	1	1	1	1	1	1	1			
Read/Write	R	R	R	R	R	R	R	R			
Function		RX CRC MSB									
		eived CRC16 MSB. The MSB of the CRC16 field from the last received packet. This value is valid whether or not the C16 field matched the calculated CRC16 of the received packet.									

Mnemonic		TX_OFFS	SET_LSB_ADR		0x1B			
Bit	7	6	5	4	3	2	1	0
Default	0	0	0	0	0	0	0	0
Read/Write	R/W	R	R	R	R	R	R	R
Function		1	1	STRI	M LSB		1 1	
Bits 7:0 T	he least significa	int 8 bits of the	synthesizer offset	t value. This is	a 12-bit 2's con	nplement signe	d number, which n	nav be used

Synthesizer offset has no effect on receive frequency.

Mnemonic		TX_OFFS	ET_MSB_ADR				Address	0x1C		
Bit	7	6	5	4	3	2	1	0		
Default	-	-	-	-	0	0	0	0		
Read/Write	-	-	-	-	R/W	R/W	R/W	R/W		
Function	Not Used	Not Used	Not Used	Not Used	STRIM MSB					
Bits 3:0 The most significant 4 bits of the synthesizer trim value. Typically, this register is loaded with 0x05 during initialization.										



Mnemonic			MODE_OV	ERRIDE_ADR				Address	0x1D
Bit		7	6	5	4	3	2	1	0
Default		0	0	0	0	0	-	-	0
Read/Write		W	W	W	W	W	-	-	W
Function		RSVD	RSVD	FRC SEN	FRC A	WAKE	Not Used	Not Used	RST
Bits 7	Re	eserved. Do not	write a 1 to the	se bits.			•		
Bits 5				ing this bit force nning before thi		er to start. Clear	ing this bit has r	no effect. For this	bit to operate
Bits 4:3				it of sleep mode ting. Clearing bo	0			tor to keep runni	ng at all times

Bits 0 Reset. Setting this bit forces a full reset of the device. Clearing this bit has no effect.

Mnemonic		RX_OV	ERRIDE_ADR				Address	0x1E	
Bit	7	6	5	4	3	2	1	0	
Default	0	0	0	0	0	0	0	-	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	-	
Function	ACK RX	RXTX DLY	MAN RXACK	FRC RXDR	DIS CRC0	DIS RXCRC	ACE	Not Used	
This register p	provides the ability	to override som	e automatic fea	tures of the dev	ice.	•			
Bits 7		this bit is set, the device uses the transmit synthesizer frequency rather than the receive synthesizer frequency for the channel when automatically entering receive mode.							
Bits 6	When this bit is se	et and ACK EN i	s enabled, the t	ransmission of t	he ACK packet	is delayed by 2	0 μs.		
Bits 5	Force Expected P ACK packet at the			-	e is in receive m	ode, the device	is configured to	receive an	
Bits 4	Force Receive Da receive data at the			-	nore the data ra	ate encoded in t	he SOP symbol	, and will	
Bits 3	Reject packets wit packets with a CR							nd accept only	
Bits 2		RX CRC16 checker is disabled. If packets with CRC16 enabled are received, the CRC16 will be treated as payload data stored in the receive buffer.							
Bits 1		ept Bad CRC16. Setting this bit causes the receiver to accept packets with a CRC16 that do not match the seed in C_SEED_LSB_ADR and CRC_SEED_MSB_ADR. An ACK is to be sent regardless of the condition of the received CRC16.							

Mnemonic		TX_OV	ERRIDE_ADR				Address	0x1F		
Bit	7	6	5	4	3	2	1	0		
Default	0	0	0	0	0	0	0	0		
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
Function	ACK TX	FRC PRE	RSVD	MAN TXACK	OVRD ACK	DIS TXCRC	RSVD	TX INV		
This register	provides the ability	to override som	e automatic fea	tures of the dev	ice.					
Bits 7		en this bit is set, the device uses the receive synthesizer frequency rather than the transmit synthesizer frequency for the en channel when automatically entering transmit mode.								
Bits 6	Force Preamble. PREAMBLE_ADF		,					e		
Bits 5	Reserved. Do not	write a 1 to this	bit.							
Bits 4	Transmit ACK Pa	cket. When this	bit is set, the de	vice sends an A	CK packet whe	en TX GO is set.				
Bits 3	ACK Override. Us	e TX_CFG_AD	R to determine t	the data rate and	d the CRC16 us	sed when transn	nitting an ACK p	acket.		
Bits 2	Disable Transmit	sable Transmit CRC16. When set, no CRC16 field is present at the end of transmitted packets.								
Bits 1	Reserved. Do not	eserved. Do not write a 1 to this bit.								
Bits 0	TX Data Invert. W	/hen this bit is se	et the transmit b	itstream is inver	ted.					



Mnemonic		CLK_	OFFSET_ADR			Address	0x27			
Bit	7	6	5	4	3	2	1	0		
Default	0	0	0	0	0	0	0	0		
Read/Write	W	W	W	W	W	W	W	W		
Function	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RXF	RSVD		
This register pro	ovides the ability	to override som	e automatic feat	tures of the dev	ice.					
Bits 7:2 F	Reserved. Do not	write a 1 to thes	se bits.							
Bits 1 F	orce Receive Clock									
Bits 0 F	Reserved. Do not	ved. Do not write a 1 to this bit.								

Mnemonic			CLK_EN_ADR				Address	0x28			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	W	W	W	W	W	W	W	W			
Function	RSVD	RSVD RSVD RSVD RSVD RSVD RXF RSV									
This register p	provides the ability	to override som	e automatic feat	tures of the dev	ice.	•					
Bits 7:2	Reserved. Do not	Reserved. Do not write a 1 to these bits.									
Bits 1	Force Receive Clo	prce Receive Clock Enable. Typical application will set this bit during initialization.									
Bits 0	Reserved. Do not	write a 1 to this	bit.								

Mnemonic		RX	_ABORT_ADR		Address	0x29					
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	W	W	W	W	W	W	W	W			
Function	RSVD	RSVD	ABORT EN	RSVD	RSVD	RSVD	RSVD	RSVD			
This register p	rovides the ability	to override som	ne automatic feat	tures of the dev	vice.	•					
Bits 7:6	Reserved. Do not	write a 1 to the	se bits.								
Bits 5	Receive Abort En	eceive Abort Enable.									
Bits 4:0	Reserved. Do not	eserved. Do not write a 1 to these bits.									

Mnemonic		AUTO_CA	L_TIME_ADR				Address	0x32			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	1	1			
Read/Write	W	W	W	W	W	W	W	W			
Function	AUTO_CAL_TIME_MAX										
This register prov	vides the ability t	to over-ride som	ne automatic fea	atures of the de	vice.						
Bits 7:0 Au											



Mnemonic		AUTO_CAL_	OFFSET_ADR				Address	0x35		
Bit	7	6	5	4	3	2	1	0		
Default	0	0	0	0	0	0	0	0		
Read/Write	W	W	W	W	W	W	W	W		
Function	AUTO_CAL_OFFSET_MINUS_4									
This register prov Bits 7:0 Au	vides the ability ito Cal Time Ma									

Mnemonic		ANALO	G_CTRL_ADR				Address	0x39			
Bit	7	6	5	4	3	2	1	0			
Default	0	0	0	0	0	0	0	0			
Read/Write	W	W	W	W	W	W	W	W			
Function	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	ALL SLOW			
This register p	rovides the ability	to over-ride son	ne automatic fea	atures of the de	vice.						
Bits 7:1	Reserved. Do not	Reserved. Do not write a 1 to these bits.									
		Slow. When set, the synth settling time for all channels is the same as for slow channels. It is recommended that firmware this bit when using GFSK data rate mode.									



Register Files

Files are written to or read from using non-incrementing burst read or write transactions. In most cases reading a file may be destructive; the file must be completely read, otherwise the contents may be altered.

Mnemonic	TX_BUFFER_ADR	Address	0x20	
Length	16 Bytes	R/W	W	
Default	0xXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX			
The transmit buffer is a FIFO. Writing to this file adds a byte to the packet being sent. Writing more bytes to this file than the packet length in				

TX_LENGTH_ADR will have no effect, and these bytes will be lost after successful packet transmission. It is **NOT** possible to load two 8-byte packets into this register, and then transmit them sequentially by enabling the TX GO bit twice; this would have the effect of sending the first eight bytes twice.

Mnemonic	RX_BUFFER_ADR	Address	0x21
Length	16 Bytes	R/W	R
Default	0xXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX		

The receive buffer is a FIFO. Received bytes may be read from this file register at any time that it is not empty, but when reading from this file register before a packet has been completely received care must be taken to ensure that error packets (for example with bad CRC16) are handled correctly.

When the receive buffer is configured to be overwritten by new packets (the alternative is for new packets to be discarded if the receive buffer is not empty), similar care must be taken to verify after the packet has been read from the buffer that no part of it was overwritten by a newly received packet while this file register is being read.

When the VLD EN bit in RX_CFG_ADR is set, the bytes in this file register alternate—the first byte read is data, the second byte is a valid flag for each bit in the first byte, the third byte is data, the fourth byte valid flag, and so on. In SDR and DDR modes the valid flag for a bit is set if the correlation coefficient for the bit exceeded the correlator threshold, and is cleared if it did not. In 8DR mode, the MSB of a valid flag byte indicates whether or not the correlation coefficient of the corresponding received symbol exceeded the threshold. The seven LSBs contain the number of erroneous chips received for the data.

Mnemonic	SOP_CODE_ADR	Address	0x22
Length	8 Bytes	R/W	R/W
Default	0x17FF9E213690C782		
these four bytes r are 64-chip code auto-correlation a file and used for When reading thi	thip SOP_CODE_ADR codes, only the first four bytes of the must be followed by four bytes of 'dummy' data. However, a swith good auto-correlation and cross-correlation properties and cross-correlation properties when used as 32-chip cor- both 32-chip and 64-chip SOP symbols. is file, all eight bytes must be read; if fewer than eight bytes	a class of codes known as 'multiplicative codes' may be ties where the least significant 32 chips themselves ha des. In this case the same eight-byte value may be load	used; there ve good ded into this
by the number of Recommended S	f bytes read. This applies to writes, as well.		
0x91CCF8E2910			
0x0FA239AD0FA			
0x2AB18FD22AB	3064EF		
0x507C26DD507	7CCD66		
0x44F616AD44	F6E15C		
0x46AE31B646A	AECC5A		
0x3CDC829E3CI	C78A1		
0x7418656F741	198EB9		
0x49C1DF62490	COB1DF		
0x72141A7F721	14E597		
Do not access or	modify this register during Transmit or Receive.		



Mnemonic	DATA_CODE_ADR	Address	0x23
Length	16 Bytes	R/W	R/W
Default	0x02F9939702FA5CE3012BF1DB0132BE6F		

This file is ignored when using the device in 1-Mbps GFSK mode. In 64-SDR mode, only the first eight bytes are used; in order to complete the file write process, these eight bytes must be followed by eight bytes of 'dummy' data. In 32-SDR mode, only four bytes are used, and in 32-DDR mode only eight bytes are used. In 64-DDR and 8DR modes, all sixteen bytes are used. Certain sixteen-byte sequences have been calculated that provide excellent auto-correlation and cross-correlation properties, and it is recommended that such sequences be used; the default value of this register is one such sequence. In typical applications, all devices use the same DATA_CODE_ADR codes, and devices and systems are addressed by using different SOP_CODE_ADR codes; in such cases it may never be necessary to change the contents of this register from the default value.

When reading this file, all sixteen bytes must be read; if fewer than sixteen bytes are read from the file, the contents of the file will have been rotated by the number of bytes read. This applies to writes, as well.

Typical applications should use the default code.

Do not access or modify this register during Transmit or Receive.

Mnemonic	PREAMBLE_ADR	Address	0x24		
Length	3 Bytes	R/W	R/W		
Default	0x333302				
Byte 1 – The number of repetitions of the preamble sequence that are to be transmitted. The preamble may be disabled by writing 0x00 to this byte.					

Byte 2 - Least significant eight chips of the preamble sequence

Byte 3– Most significant eight chips of the preamble sequence

If using 64-SDR to communicate with CYWUSB69xx devices, set number of repetitions to four for optimum performance

When reading this file, all three bytes must be read; if fewer than three bytes are read from the file, the contents of the file will have been rotated by the number of bytes read. This applies to writes, as well.

Do not access or modify this register during Transmit or Receive.

Mnemonic	MFG_ID_ADR	Address	0x25
Length	6 Bytes	R	R
Default	NA		
Byte 1 – 4 bits ve	rsion + 2 bits vendor ID + high 2 bits of Year yte 6: Manufacturing ID for the device.		

To minimize \sim 190 μ A of current consumption (default), execute a 'dummy' single-byte SPI write to this address with a zero data stage after the contents have been read. Non-zero to enable reading of fuses. Zero to disable reading fuses.

Absolute Maximum Ratings

Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied0°C to +70°C Supply Voltage on any power supply pin relative to V_{SS} -0.3V to +3.9V

DC Voltage to Logic Inputs^[8]-0.3V to V_{IO} +0.3V

DC Voltage applied to Outputs in High-Z State .. –0.3V to $\rm V_{IO}$ +0.3V

Static Discharge Voltage (Digital) ^[9]	>2000V
Static Discharge Voltage (RF) ^[9]	1100V
Latch-up Current	+200 mA, -200 mA
Ground Voltage	0V
F _{OSC} (Crystal Frequency)	12 MHz ±30 ppm

Notes

8. It is permissible to connect voltages above V_{IO} to inputs through a series resistor limiting input current to 1 mA. AC timing not guaranteed.

9. Human Body Model (HBM).



DC Characteristics (T = 25°C)

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
Radio Functio	on Operating Voltages	•				
V _{BAT}	Battery Voltage	0–70°C	1.8		3.6	V
V _{IO}	V _{IO} Voltage		1.8		3.6	V
V _{CC}	V _{CC} Voltage	0–70°C	2.4		3.6	V
MCU Function	Operating Voltages	1				
V _{DD_MICRO1}	Operating Voltage	No USB activity, CPU speed \leq 12 MHz	4.0		5.25	V
V _{DD_MICRO2}	Operating Voltage	USB activity, CPU speed < 12 MHz. Flash programming	4.35		5.25	V
V _{LVD}	Low-voltage Detect Trip Voltage (8 programmable trip points)		2.68		4.87	V
Device Currer Function Curre	nt (For total current consumption in different and MCU Function Current)	nt modes, for example Radio, active	e, MCU, sle	ep, etc.	, add Ra	dio
I _{DD} (GFSK) ^[10]	Average I _{DD} , 1 Mbps, slow channel	PA = 5, 2-way, 4 bytes/10 ms		10.87		mA
I _{DD} (32-8DR) ^{[10}	[]] Average I _{DD} , 250 kbps, fast channel	PA = 5, 2-way, 4 bytes/10 ms		11.2		mA
I _{SB}	Sleep Mode I _{DD}	Radio function and MCU function in Sleep mode, V _{REG} in Keep Alive.		40.1		μA
Radio Functio	Den Current (V _{DD_Micro} = 5.0V, V _{REG} enable	ed, MCU sleep)				
IDLE I _{CC}	Radio Off, XTAL Active	XOUT disabled		2.1		mA
I _{synth}	I _{CC} during Synth Start			9.8		mA
TX I _{CC}	I _{CC} during Transmit	PA = 5 (–5 dBm)		22.4		mA
TX I _{CC}	I _{CC} during Transmit	PA = 6 (0 dBm)		27.7		mA
TX I _{CC}	I _{CC} during Transmit	PA = 7 (+4 dBm)		36.6		mA
RX I _{CC}	I _{CC} during Receive	LNA off, ATT on		20.2		mA
RX I _{CC}	I _{CC} during Receive	LNA on, ATT off		23.4		mA
MCU Function	Current (V _{DD_Micro} = 5.0V, V _{REG} disable	d)	1			
IDD_MICRO1	V _{DD_MICRO} Operating Supply Current	No GPIO loading, 6 MHz		10		mA
I _{SB1}	Standby Current	Internal and External Oscillators, Bandgap, Flash, CPU Clock, Timer Clock, USB Clock all disabled		4	10	μA
USB Interface						
V _{ON}	Static Output High	15K \pm 5% Ohm to V _{SS}	2.8		3.6	V
V _{OFF}	Static Output Low	R _{UP} is enabled			0.3	V
V _{DI}	Differential Input Sensitivity		0.2			V
V _{CM}	Differential Input Common Mode Range		0.8		2.5	V
V _{SE}	Single Ended Receiver Threshold		0.8		2	V
C _{IN}	Transceiver Capacitance				20	pF
I _{IO}	Hi-Z State Data Line Leakage	0V < V _{IN} < 3.3V	-10		10	μΑ
	on GPIO Interface	•				. <u> </u>
V _{OH1}	Output High Voltage Condition 1	At I _{OH} = -100.0 μA	V _{IO} – 0.1	V _{IO}		V
V _{OH2}	Output High Voltage Condition 2	At $I_{OH} = -2.0 \text{ mA}$	V _{IO} – 0.4	V _{IO}		V

Notes

^{10.} Includes current drawn while starting crystal, starting synthesizer, transmitting packet (including SOP and CRC16), changing to receive mode, and receiving ACK handshake. Device is in sleep except during this transaction.



DC Characteristics (T = 25°C) (continued)

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
V _{OL}	Output Low Voltage	At I _{OL} = 2.0 mA		0	0.4	V
V _{IH}	Input High Voltage		0.76V _{IO}		V _{IO}	V
V _{IL}	Input Low Voltage		0		0.24V _{IO}	V
I _{IL}	Input Leakage Current	$0 < V_{IN} < V_{IO}$	-1	0.26	+1	μA
C _{IN}	Pin Input Capacitance	except XTAL, RF _N , RF _P , RF _{BIAS}		3.5	10	pF
MCU Function	n GPIO Interface					
R _{UP}	Pull-up Resistance		4		12	KΩ
V _{ICR}	Input Threshold Voltage Low, CMOS mode	Low to High edge	40%		65%	V _{CC}
V _{ICF}	Input Threshold Voltage Low, CMOS mode	High to Low edge	30%		55%	V _{CC}
V _{HC}	Input Hysteresis Voltage, CMOS Mode	High to Low edge	3%		10%	V _{CC}
V _{ILTTL}	Input Low Voltage, TTL Mode	I/O-pin Supply = 2.9–3.6V			0.8	V
V _{IHTTL}	Input High Voltage, TTL Mode	I/O-pin Supply = 4.0–5.5V	2.0			V
V _{OL1}	Output Low Voltage, High Drive ^[11]	I _{OL1} = 50 mA			0.8	V
V _{OL2}	Output Low Voltage, High Drive ^[11]	I _{OL1} = 25 mA			0.4	V
V _{OL3}	Output Low Voltage, Low Drive ^[11]	I _{OL2} = 8 mA			0.4	V
V _{OH}	Output High Voltage ^[11]	I _{OH} = 2 mA	$V_{CC} - 0.5$			V
3.3V Regulate	br					
I _{VREG}	Max Regulator Output Current	V _{CC} ≥ 4.35V			125	mA
I _{KA}	Keep Alive Current	When regulator is disabled with 'keep alive' enable			20	μA
V _{REG1}	V _{REG} Output Voltage	V _{CC} ≥ 4.35V, 0 < temp < 40°C, 25 mA ≤ I _{VREG} ≤ 125 mA	3.0		3.6	V
V _{REG2}	V _{REG} Output Voltage	$V_{CC} \ge 4.35V$, 0 < temp < 40°C, 1 mA $\le I_{VREG} \le 25$ mA	3.15		3.45	V
V _{KA}	Keep Alive Voltage	Keep Alive bit set in VREGCR	2.35		3.9	V

RF Characteristics

Table 84.Radio Parameters

Parameter Description	Conditions	Min.	Тур.	Max.	Unit	
RF Frequency Range	Subject to regulations.	2.400		2.497	GHz	
Receiver (T = 25°C, V _{CC} = 3.0V, f _{OSC} = 12.000 MHz, BER <	Receiver (T = 25°C, V _{CC} = 3.0V, f _{OSC} = 12.000 MHz, BER < 10 ⁻³)					
Sensitivity 125 kbps 64-8DR	BER 1E-3		-97		dBm	
Sensitivity 250 kbps 32-8DR	BER 1E-3		-93		dBm	
Sensitivity	CER 1E-3	-80	-87		dBm	
Sensitivity GFSK	BER 1E-3, ALL SLOW = 1		-84		dBm	
LNA gain			22.8		dB	
ATT gain			-31.7		dB	
Maximum Received Signal	LNA On	-15	-6		dBm	
RSSI value for PWR _{in} –60 dBm	LNA On		21		Count	
RSSI slope			1.9		dB/Count	

Note 11. Except for pins P1.0, P1.1 in GPIO mode.



Table 84.Radio Parameters (continued)

Parameter Description	Conditions	Min.	Тур.	Max.	Unit
Interference Performance (CER 1E-3)					
Co-channel Interference rejection Carrier-to-Interference (C/I)	C = -60 dBm,		9		dB
Adjacent (±1 MHz) channel selectivity C/I 1 MHz	C = -60 dBm		3		dB
Adjacent (±2 MHz) channel selectivity C/I 2 MHz	C = -60 dBm		-30		dB
Adjacent (\geq 3 MHz) channel selectivity C/I \geq 3 MHz	C = -67 dBm		-38		dB
Out-of-Band Blocking 30 MHz–12.75 MHz ^[12]	C =67 dBm		-30		dBm
Intermodulation	$C = -64 \text{ dBm}, \Delta f = 5,10 \text{ MHz}$		-36		dBm
Receive Spurious Emission	· ·				
800 MHz	100-kHz ResBW		-79		dBm
1.6 GHz	100-kHz ResBW		-71		dBm
3.2 GHz	100-kHz ResBW		-65		dBm
Transmitter (T = 25°C, V _{CC} = 3.0V, f _{OSC} = 12.000 MHz)	•				
Maximum RF Transmit Power	PA = 7	+2	4	+6	dBm
Maximum RF Transmit Power	PA = 6	-2	0	+2	dBm
Maximum RF Transmit Power	PA = 5	-7	-5	-3	dBm
Maximum RF Transmit Power	PA = 0		-35		dBm
RF Power Control Range			39		dB
RF Power Range Control Step Size	seven steps, monotonic		5.6		dB
Frequency Deviation Min	PN Code Pattern 10101010		270		kHz
Frequency Deviation Max	PN Code Pattern 11110000		323		kHz
Error Vector Magnitude (FSK error)	>0 dBm		10		%rms
Occupied Bandwidth	–6 dBc, 100-kHz ResBW	500	876		kHz
Transmit Spurious Emission (PA = 7)	-				
In-band Spurious Second Channel Power (±2 MHz)			-38		dBm
In-band Spurious Third Channel Power (>3 MHz)			-44		dBm
Non-Harmonically Related Spurs (8.000 GHz)			-38		dBm
Non-Harmonically Related Spurs (1.6 GHz)			-34		dBm
Non-Harmonically Related Spurs (3.2 GHz)			-47		dBm
Harmonic Spurs (Second Harmonic)			-43		dBm
Harmonic Spurs (Third Harmonic)			-48		dBm
Fourth and Greater Harmonics			-59		dBm
Power Management (Crystal PN# eCERA GF-1200008)	•				
Crystal start to 10 ppm			0.7	1.3	ms
Crystal start to IRQ	XSIRQ EN = 1		0.6		ms
Synth Settle	Slow channels			270	μs
Synth Settle	Medium channels			180	μs
Synth Settle	Fast channels	1		100	μs
Link turn-around time	GFSK			30	μs
Link turn-around time	250 kbps			62	μs
Link turn-around time	125 kbps			94	μs
Link turn-around time	<125 kbps			31	μs



Table 84.Radio Parameters (continued)

Parameter Description	Conditions	Min.	Тур.	Max.	Unit
Note					

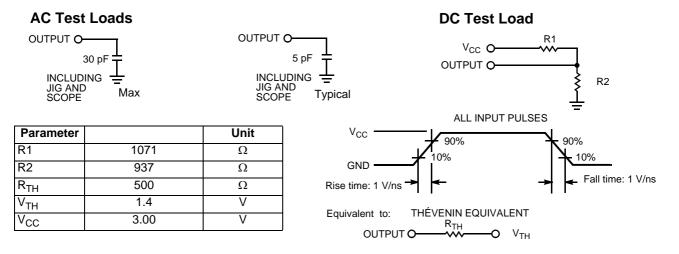
12. Exceptions	F/3 & 5C/3.

13. When using an external switching regulator to power the radio, the switching frequency should be set very far from the IF frequency of 1 MHz.

	< 60 ppm Crystal to Crystal all modes except 64-DDR		40	bytes
Max. packet length	< 60 ppm Crystal to Crystal 64-DDR		16	bytes

AC Test Loads and Waveforms for Digital Pins

Figure 20. AC Test Loads and Waveforms for Digital Pins



AC Characteristics

Parameter	Description	Conditions	Min.	Typical	Max.	Unit
3.3V Regula	ator			1	1	
V _{ORIP}	Output Ripple Voltage		45		55	%
USB Driver		•			•	
T _{R1}	Transition Rise Time	C _{LOAD} = 200 pF	75			ns
T _{R2}	Transition Rise Time	$C_{LOAD} = 600 \text{ pF}$			300	ns
T _{F1}	Transition Fall Time	C _{LOAD} = 200 pF	75			ns
T _{F2}	Transition Fall Time	$C_{LOAD} = 600 \text{ pF}$			300	ns
T _R	Rise/Fall Time Matching		80		125	%
V _{CRS}	Output Signal Crossover Voltage		1.3		2.0	V
USB Data T	Timing	•			•	
T _{DRATE}	Low-speed Data Rate	Ave. Bit Rate (1.5 Mbps ± 1.5%)	1.4775		1.5225	Mbps
T _{DJR1}	Receiver Data Jitter Tolerance	To next transition	-75		75	ns
T _{DJR2}	Receiver Data Jitter Tolerance	To pair transition	-45		45	ns
T _{DEOP}	Differential to EOP Transition Skew		-40		100	ns
T _{EOPR1}	EOP Width at Receiver	Rejects as EOP			330	ns
T _{EOPR2}	EOP Width at Receiver	Accept as EOP	675			ns
T _{EOPT}	Source EOP Width		1.25		1.5	μS



AC Characteristics (continued)

Parameter	Description	Conditions	Min.	Typical	Max.	Unit
T _{UDJ1}	Differential Driver Jitter	To next transition	-95		95	ns
T _{UDJ2} Differential Driver Jitter		To pair transition	-95		95	ns
T _{LST}	Width of SE0 during Diff. Transition				210	ns
Non-USB N	Mode Driver Characteristics					
T _{FPS2}	SDATA/SCK Transition Fall Time		50		300	ns
SPI Timing		· · ·				
Т _{SMCK}	SPI Master Clock Rate	F _{CPUCLK} /6			2	MHz
Т _{SSCK}	SPI Slave Clock Rate				2.2	MHz
Т _{SCKH}	SPI Clock High Time	High for $CPOL = 0$, Low for $CPOL = 1$	125			ns
T _{SCKL}	SPI Clock Low Time	Low for CPOL = 0, High for CPOL = 1	125			ns
T _{MDO}	Master Data Output Time ^[14]	SCK to data valid	-25		50	ns
T _{MDO1}	Master Data Output Time, First bit with CPHA = 0	Time before leading SCK edge	100			ns
T _{MSU}	Master Input Data Set-up time		50			ns
T _{MHD}	Master Input Data Hold time		50			ns
T _{SSU}	Slave Input Data Set-up Time		50			ns
T _{SHD}	Slave Input Data Hold Time		50			ns
T _{SDO}	Slave Data Output Time	SCK to data valid			100	ns
T _{SDO1}	Slave Data Output Time, First bit with CPHA = 0	Time after SS LOW to data valid			100	ns
T _{SSS}	Slave Select Set-up Time	Before first SCK edge	150			ns
T _{SSH}	Slave Select Hold Time	After last SCK edge	150			ns

Figure 21. Clock Timing

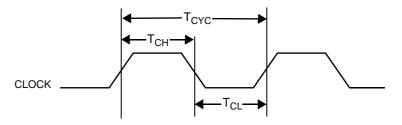
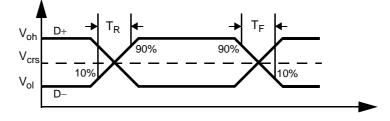


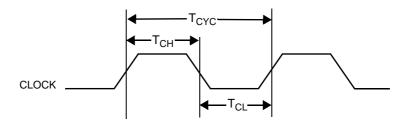
Figure 22. USB Data Signal Timing



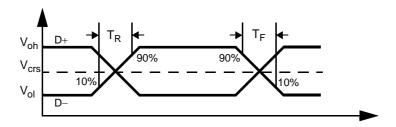
Notes 14. In Master mode first bit is available 0.5 SPICLK cycle before Master clock edge available on the SCLK pin.

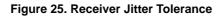


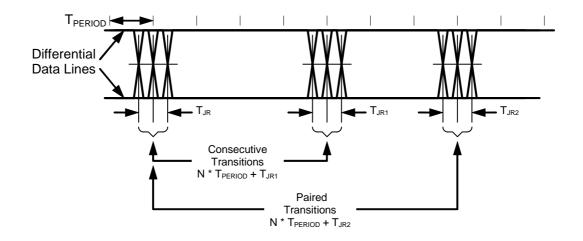
Figure 23. Clock Timing













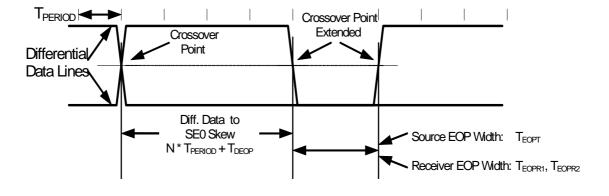
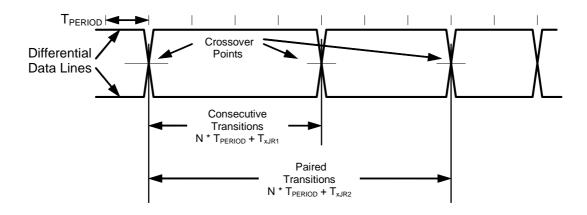


Figure 26. Differential to EOP Transition Skew and EOP Width







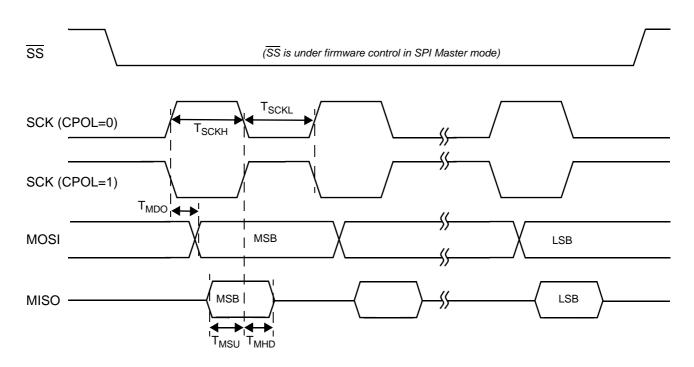
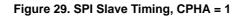
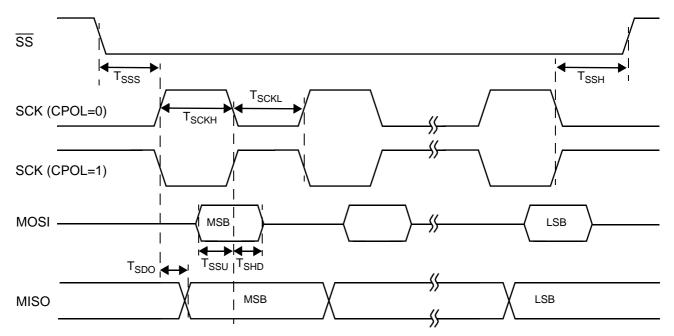
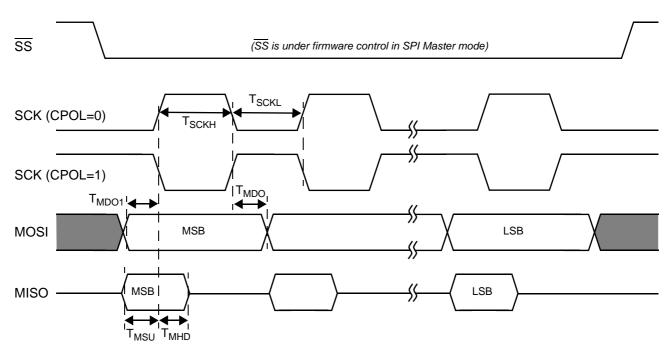


Figure 28. SPI Master Timing, CPHA = 1

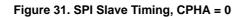












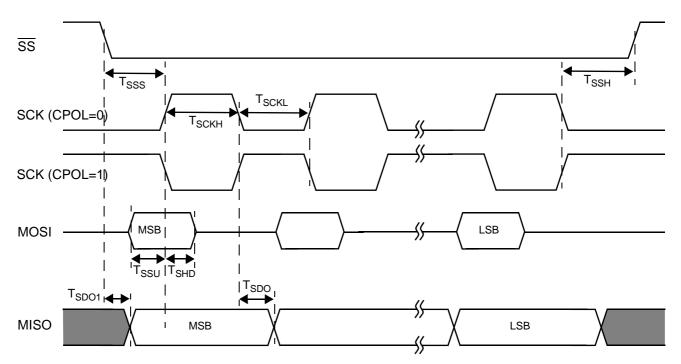


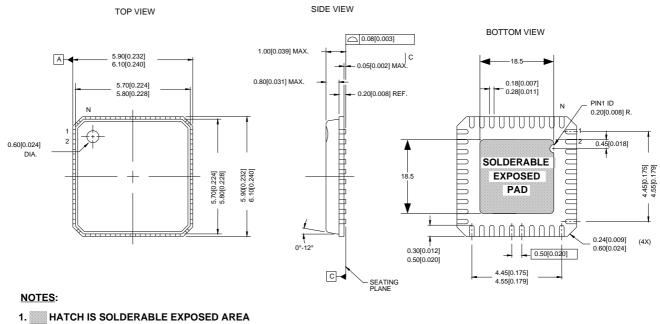


Table 85.Ordering Information

Package	Ordering Part Number	
40-pin Lead-Free QFN 6x6 mm	CYRF69213-40 LFXC	

Package Diagram

Figure 32. 40-pin Lead-Free QFN 6x6 mm



2. REFERENCE JEDEC#: MO-220

3. PACKAGE WEIGHT: 0.086g

4. ALL DIMENSIONS ARE IN MM [MIN/MAX]

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Document History Page

		001-07552 Issue Date	Orig. of Change	nmable Radio on Chip Low Power Description of Change
**	436355	See ECN	OYR	New advance data sheet.
*A	501280	See ECN	OYR	Preliminary data sheet.
*В	631538	See ECN	BOO	Final datasheet. Updated DC Characteristics table with characterization data. Minor text changes Removed all residual references to external crystal oscillator and GPIO4 Voltage regulator line/load regulation documented GPIO capacitance and timing diagram included Sleep and Wake up sequence documented. EP1MODE/EP2MODE register issue discussed Updated radio function register descriptions Changed L/D pin description Changed RST Capacitor from 0.1uF to 0.47uF